

User Guide

EVGA Z270 Stinger

Specs and Initial Installation

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Before You Begin...

EVGA welcomes you to the next generation of Intel performance: the Z270 STINGER! The Z270 platform supports the newest Kaby Lake-S processors and is backwards-compatible with existing Socket-1151 Skylake processors. EVGA Z270 motherboards further refine high-performance with multiple options for all the latest SSD options with support for U.2, M.2 and PCI-E drives and is Intel® Optane™ Memory Ready – a revolutionary higher-density memory interface, based on 3D Xpoint Technology, delivers a new generation of SSDs designed to obliterate loading times for gamers. However, the Z270 platform also supports all the features you’ve come to expect from EVGA, including up to 32GBs of Dual-channel DDR4 memory at a maximum memory speed of up to 3600MHz+ (OC), Gigabit-NIC support, USB 3.0 and USB 3.1 Type-A and Type-C support, Intel HD Graphics, an updated UEFI\BIOS GUI, PWM fan control to fit everyone’s needs. The Z270 STINGER is built with a 10-layer PCB, featuring a CPU socket with 150% higher Gold content powered by an Advanced 5+1-phase Digital VRM (5 Phase VCore, 1 Phase Memory PWM), providing industry-leading stability for all your applications.

Furthermore, this board is designed not ONLY for overclockers, but also for SFF gamers with a x16slot for blazing-fast video, integrated Intel WiFi, an Intel i219 NIC, M.2 type M, U.2, and much more!

Lastly, a motherboard is only as good as its BIOS, and the EVGA Z270 STINGER features an updated UEFI\BIOS GUI with a focus on overclocking and functionality in a lean, straight-forward package. You won’t need to be an expert to configure your motherboard, but if you are, you’ll find features unavailable anywhere else. Combining the best of current technology with the latest innovations, EVGA is further refining motherboard performance!

Parts NOT in the Kit

This kit contains all the hardware necessary to install and connect your new EVGA Z270 STINGER Motherboard. However, it does NOT contain the following items, which must be purchased separately in order to make the system fully-functional and install an Operating System:

- ❑ **Intel Socket 1151 Processor**
- ❑ **DDR4 System Memory**
- ❑ **CPU Cooling Device**
- ❑ **PCI Express Graphics Card**
- ❑ **Power Supply**
- ❑ **Hard Drive or SSD**
- ❑ **Keyboard / Mouse**
- ❑ **Monitor**
- ❑ **(Optional) Optical Drive**

EVGA assumes you have purchased all the necessary parts needed to allow for proper system functionality. For a full list of supported CPUs on this motherboard, please visit www.evga.com/support/motherboard

Intentions of the Kit

When replacing a different model motherboard in a PC case, you may need to reinstall your operating system, even though the current HDD/SSD may already have one installed. Keep in mind, however, you may sometimes also need to reinstall your OS after a RMA even if your motherboard remains the same due to issues that occurred prior to replacing the motherboard.

Motherboard

Motherboard Specifications

- ❑ **Size:**
 - m-ITX form-factor of 6.7 inches x 6.7 inches (170.18x170.18mm)
- ❑ **Microprocessor support:**
 - Intel Socket 1151 Processor
- ❑ **Operating Systems:**
 - Supports Windows 10 / 8* / 7*
 - (*Dependant upon CPU support for Windows. Kaby Lake-S CPUs
 - **ONLY** support Windows 10. Skylake CPUs support Windows 10/8/7)
- ❑ **Contains Intel Z270 chipset**
- ❑ **System Memory support:**
 - Supports Dual channel DDR4 up to 3600MHz+ (OC).
 - Supports up to 32GB of DDR4 memory.
- ❑ **USB 2.0 Ports:**
 - 2x from Intel Z270 PCH – 2x internal via 1 FP headers
 - Supports hot plug
 - Supports wake-up from S3 mode
 - Supports USB 2.0 protocol up to a 480 Mbps transmission rate
- ❑ **USB 3.0 Ports:**
 - 8x from Intel Z270 PCH – 6x external, 2x internal via 1 FP header
 - Supports transfer speeds up to 5Gbps
 - Backwards compatible USB 2.0 and USB 1.1 support
- ❑ **USB 3.1 Ports:**
 - 2x from Intel Z270 PCH – 2x external, 1x Type C, 1x Type A
 - Supports transfer speeds up to 10Gbps
 - Backwards compatible USB 3.0, USB 2.0 and USB 1.1 support
 - *Type C will require a Type A adapter for backwards compatibility

- ❑ **SATA Ports:**
 - Intel Z270 PCH Controller
 - 4x SATA 3/6G (600 MB/s) data transfer rate
 - Support for RAID 0, RAID 1, RAID 5, AND RAID 10
 - Supports hot plug
- ❑ **Onboard LAN:**
 - 1x Intel i219v Gigabit (10/100/1000) Ethernet
- ❑ **Onboard WiFi:**
 - 1x AzureWave AW-CB210NF-P WiFi with BT4.1
- ❑ **Onboard Audio:**
 - Realtek Audio (ALC1150)
 - Supports 8-channel (7.1) audio
 - Supports Optical Output
- ❑ **PCI-E 3.0 Support:**
 - Low power consumption and power management features
- ❑ **Power Functions:**
 - Supports ACPI (Advanced Configuration and Power Interface)
 - Supports S0 (normal), S3 (suspend to RAM), S4 (Suspend to disk - depends on OS), and S5 (soft - off)
- ❑ **PCI-Express Expansion Slots:**
 - 1x PCI-E x16 slot
- ❑ **Additional Expansion Slots:**
 - 1x M.2 Key-M 80mm slot (on the back of the board) from PCH
 - 1x M.2 Key-E slot from PCH
 - 1x U.2 slot
- ❑ **Integrated Video Out:**
 - 1x DP 1.2
 - 1x HDMI 1.4
 - Both driven by Intel HD Video integrated in the CPU

□ **Fan Headers:**

1x 4-pin PWM controlled

2x 4-pin DC\PWM headers

- Each fan header can be selected in BIOS to share PWM profiles, or be controlled by DC.

**ALL FAN HEADERS HAVE A MAXIMUM POWER
LIMIT OF 1 AMP @ 12 VOLTS (12 WATTS)
EXCEEDING THIS LIMIT WILL CAUSE
IRREPARABLE DAMAGE TO THE BOARD.**

Unpacking and Parts Descriptions

The following accessories are included with the EVGA Z270 STINGER Motherboard:



The EVGA Z270 Stinger Motherboard

This motherboard contains the Intel Z270 chipset.



I/O Shield

Installs in the system case to block radio frequency transmissions, protect internal components from dust, foreign objects, and aids in proper airflow within the chassis.



2x SATA 3G/6G Data Cables

Used to support the SATA protocol and each one connects a single drive to the motherboard.



Labels and Decals

The included stickers and decals for EVGA Products*



Case Badge

EVGA enthusiast Case Badge*



Installation DVD

Contains drivers and software needed to setup the motherboard.



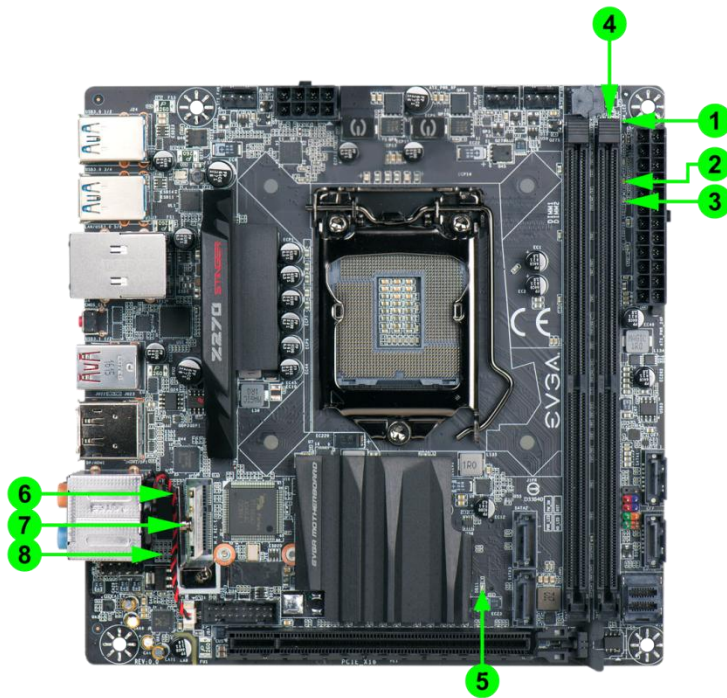
User Manual

The user manual you are reading right now!

* Decals, labels and case badges MAY vary over time, and the images used are merely reflective of the decal/label/badge designs typically included.

Intel Z270 STINGER Motherboard LED reference

The EVGA Z270 STINGER Motherboard has several LEDs indicating power, connectivity, and activity. Below is the location of the LEDs and their function.



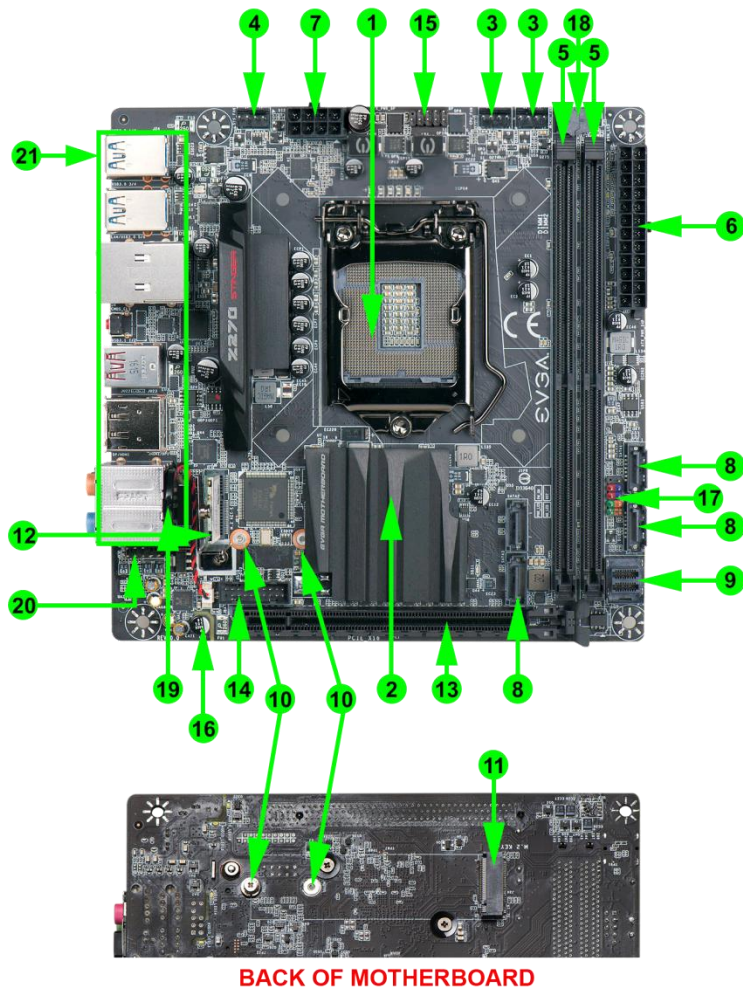
LED Legend		
1. Removable BIOS LED	4. VSM	7. M.2 Key-E Activity (WiFi)
2. 5VSB	5. M.2 Key-M Activity	8. Backlit/Shielded Audio Trace
3. VCC	6. M.2 Key-E Activity (Bluetooth)	9. Backlit/Shielded Audio Trace (BACK)

1. Removable BIOS LED
 - a. RED: BIOS chip is detected and active
 - b. This BIOS chip can be removed and replaced while the motherboard is powered off. Please contact EVGA Support for any concerns with the BIOS chip, and never remove the chip while the PC is powered on.
2. 5VSB
 - a. WHITE: Voltage detected (Does not mean PSU is outputting in-spec, only that this specific voltage is detected)
3. VCC
 - a. RED: Voltage detected (Does not mean PSU is outputting in-spec, only that this specific voltage is detected)
4. VSM
 - a. YELLOW: Voltage detected (Does not mean PSU is outputting in-spec, only that this specific voltage is detected)
5. M.2 Key-M Activity
 - a. RED: M.2 detection/activity.
 - i. Some devices do not have full activity detection support; for example, the LED will turn on when a SM951 drive is attached and blink while accessing. However, a XP941 drive does not support that function.
 - ii. Rather than being solid ON, some devices when detected/active will blink, this is specific to some devices.
 - b. OFF: No device attached.
6. M.2 Key-E Activity (Bluetooth)
 - a. RED: Bluetooth activity.
 - b. OFF: No device attached.
7. M.2 Key-E (WiFi)
 - a. RED: WiFi activity.
 - i. Rather than being solid ON, some devices when detected/active will blink, this is specific to some devices.
 - b. OFF: No device attached.
8. Audio Trace
 - a. WHITE: This LED backlights the isolated Audio traces. When the LED is on, it merely shows the PC is on and the light is not disabled in BIOS. The lights may be enabled/disabled in BIOS under the option “Audio Backlight”.

Intel Z270 STINGER Motherboard Component Legend

The EVGA Z270 STINGER Motherboard with the Intel Z270 and PCH Chipset. Figure 1 shows the motherboard and Figure 2 shows the back panel connectors

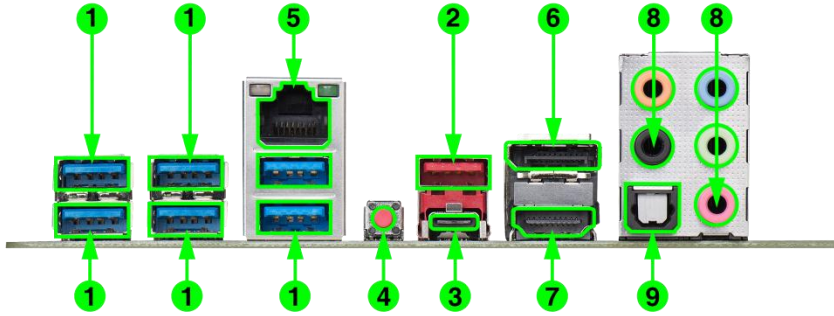
FIGURE 1. Z270 STINGER Motherboard Layout



Component Legend		
1. CPU Socket 1151	8. Intel SATA 3/6G	15. USB 2.0 Headers
2. Intel Z270 PCH (Southbridge)	9. U.2 Port	16. Backlit Audio Traces
3. PWM Fan Header (1amp)	10. M.2 Mount Holes	17. Front Panel Connectors
4. DC/PWM Header (1amp)	11. M.2 Socket 3 Key-M 80mm	18. Removable BIOS Chip
5. DDR4 Memory DIMM Slots 1+2	12. M.2 Socket 1 Key-E	19. CMOS Battery
6. 24-pin ATX power connector	13. PCI-E Slot x16	20. Front Panel Audio Connector
7. 8-pin EPS Connector	14. USB 3.0 Headers	21. Rear Panel Connectors (Figure 2)

**For a FULL description of the above legend, please see Page 16.

Figure 2. Chassis Rear Panel Connectors



I/O Hub Legend		
1. USB 3.0	4. BIOS/CMOS Reset	7. HDMI 1.4
2. USB 3.1 Type-A	5. Intel I 219 NIC	8. Analog Audio Jacks
3. USB 3.1 Type-C	6. Display Port 1.2	9. Optical Out



Speed/Link LED Status	Description
Orange	1000 Mbps data rate
Green	100 Mbps data rate
Off	10 Mbps data rate

Activity LED Status	Description
Off	No data transmission
Blinking (Green)	Data transmission

3.5mm Audio Jack Legend				
Analog Audio Port Breakdown	2/2.1 Channel	4.0/4.1 Channel	5.1 (6 Channel)	7.1 (8 Channel)
Blue	Line in	Line In	Line in	* Rear Speaker Out
Green	Front Speaker Out/ Front Speaker + Sub	Front Speaker Out/ Front Speaker + Sub	Front Speaker Out	Front Speaker Out
Pink	Mic In	Mic In	Mic In	Mic In
Black		Side Speaker Out	Side Speaker Out	Side Speaker Out
Orange			Center/Sub Out	Center/Sub Out

* Only used in 7.1 and is changed via Realtek Software from within Windows.

Component Legend Descriptions

1. CPU Socket 1151

This is the interface for the Central Processing Unit (CPU), and supports Pentium, Core i3, Core i5, and Core i7 models compatible with the Intel 1151 Socket and Skylake or Kaby Lake-S architecture.

2. Intel Z270 PCH (Southbridge)

The Platform Controller Hub (PCH) handles the role that was previously held by the South Bridge. The PCH has 4 PCI-E Gen 3 lanes and allocates bandwidth to smaller PCI-E slots, M.2, USB, audio, etc. In simplified terms, the PCH works as a hub for peripherals that are less bandwidth-intensive.

3. PWM Fan Headers

4-pin fan headers that control the fan speed based on a configurable curve or static percentage. PWM (Pulse-Width Modulation) works by pulsing power to the fan at a constant rate and sending the RPM signal to the fan's controller via a Sense cable, rather than adjusting fan speed by increasing and decreasing voltage. This method is preferable because it eliminates voltage-based fan stall points. Please see Page 85 for more in-depth PWM breakdown and PWM controls within BIOS/UEFI.

4. DC/PWM Fan Headers

These headers are DC controlled, which means fan speed is based on decreasing voltage to the fan, starting at a default of 100%/12V. When using DC, a fan's minimum speed will vary depending on the motor because most fan motors require a set amount of voltage before stalling.

Alternatively, you may enable PWM Mode in the BIOS for each fan connected, and it will pass-through the RPM information to a PWM fan.

5. DDR4 Memory Slots

The memory slots support up to two 288-pin DDR4 DIMMs in Dual-Channel mode. Dual-Channel mode will be enabled only upon using two sticks of supported memory, according to the installation guide above. 32GB of RAM is supported in a 2x16GB configuration; 32GB modules are *NOT* officially-supported. At the time of this manual's release, this motherboard officially-supports up to 3600MHz speeds; however, these speeds cannot be guaranteed as Intel® only certifies the speed of the memory controller up to 2133MHz for Skylake and 2400MHz for Kaby Lake-S.

6. 24-pin ATX power connector

The main power for the motherboard is located on the right side of the board and perpendicular to the PCB; this is also described as a “Vertical” connector (See Page 37 for more specifics to the connector itself, and associated wiring/pinouts). The 24-pin connector IS directional and the connector needs the tab on the socket to line up with the release clip located on the 24-pin connector from the power supply. This connector pulls the bulk of the power for all components; other connectors, such as EPS, PCI-E (video card AND motherboard sides), have been added to reduce the load and increase longevity due to wiring and trace limitations.

7. 8-pin EPS Connector

The EPS is dedicated power for the CPU (See Page 38 for more specifics to the connector itself, and associated wiring/pinouts). Carefully choose the correct power cable by consulting with the installation manual for your power supply. This connector is designed only to work with an EPS or CPU cable. System builders may make the mistake of plugging in a PCI-E 8-pin or 6+2-pin connector, which will prevent the board from POSTing and possibly short or damage the board; although the cables appear similar, they are wired differently and attaching a PCI-E cable to an EPS connector may cause damage to the motherboard.

8. Intel SATA 3/6G Ports

The Intel Z270 PCH has a 6-port SATA 3/6G controller (See Page 44 for specifics on the connectors). This controller is backwards-compatible with SATA and SATA 2 devices, and supports SSDs, HDDs and various types of optical devices (CDROM, DVDROM, BD-ROM, etc). The controller also supports NCQ, TRIM, hot swap capability (provided the proper HDD/SSD bays/racks are installed), and RAID levels 0/1/5/10.

9. U.2 Port

U.2, originally known as SFF-8639, is the next generation of SATA Express. U.2 uses the same logic as SATA Express, but with twice the available bandwidth, and a smaller cable connector. U.2 brings out the best of both worlds of SATA Express and M.2; U.2 has the same max bandwidth available as M.2 by using four PCI-E Gen3 lanes, but in a 2.5in. SSD form-factor, similar to SATA Express. U.2 provides a solution to potential heating problems that may be present in some M.2 solutions.

10. M.2 Mount Holes

This component is noted because the M.2 Key-M is located on the bottom of the motherboard, which is not visible from the top of the board. The upper component image shows the mount location from the front, while the lower image shows the holes from the bottom. This component is listed here to remind the user what these holes are used for after the board is installed.

11. M.2 Socket 3 Key-M 80mm

M.2 is a SSD standard, which uses up to four PCI-E lanes and utilizes Gen3 speeds. Most popularly paired with NVMe SSDs, this standard offers substantially faster transfer speeds and seek time than SATA interface standards. All M.2 devices are designed to connect via a card-bus style connector and be bolted into place and powered by the connector, rather than by a dedicated data cable and power cable. This socket will support Key-M devices of 80mm, 60mm, and 42mm length.

12. M.2 Socket 1 Key-E 32mm

M.2 Key-E is largely used for WiFi and Bluetooth cards. Key-E and Key-M connectors are different, meaning that devices are not interchangeable between sockets.

13. PCI-E Slot x16/x8

PCI-E x16/x8 slots are primarily for video cards. These full-length slots will provide 8 or 16 lanes of bandwidth to a full-size card, and are backwards-compatible with x8, x4, and x1-length cards.

Skylake and Kaby Lake-S Socket 1151 processors have 16 PCI-E lanes available for routing.

The 16 PCI-E lanes are pulled from the CPU.

14. USB 3.0 Header

The USB3.0 headers are used to connect additional USB interface plugs to the motherboard; these headers are most often used to connect the motherboard to the chassis to enable the USB3.0 ports on the chassis. These will function the same as the USB3 ports found on the motherboard's hardwired I/O hub, but these can be used to attach to front panel USB, auxiliary ports that mount in the card slots, and also some devices that directly connect to the header.

USB 3.0 standard is 900ma @ 5V for unpowered devices. If your USB device requires more power than this, it is recommended to attach a powered USB Hub.

USB 3.1 Type-A (found on the I/O Hub) shares the power limit of USB 3.0 at 900ma @ 5V. Whereas USB 3.1 Type-C (also found on the IO Hub) has a power limit of 3000ma (3A) @ 5V.

15. USB 2.0 Header

The USB2.0 header is used to connect additional USB interface plugs to the motherboard; these headers are most often used to connect the motherboard to the chassis to enable the USB2.0 ports on the chassis. These will function the same as the USB2 ports found on the motherboard's hardwired I/O hub, but these can be used to attach to front panel USB, auxiliary ports that mount in the card slots, and also some devices that directly connect to the header.

USB 2.0 standard is 500ma @ 5V per port (header total is 1000ma) for unpowered devices. If your USB device requires more power than this, it is recommended to attach a powered USB Hub.

16. Backlit Audio Traces

Isolating audio traces reduces or eliminates electrical noise from the onboard audio when running multiple devices at a very high frequency. The combination of CPU and graphics card frequencies and/or SLI can cause static, channel crosstalk, or other audio anomalies. Each channel's traces are isolated from other sources of electrical noise on the board, which improves sound clarity. From there the traces are backlit to show the isolation path.

17. Front Panel Connectors

The Front panel connectors are the four main chassis connections. These include the Power Switch, Power LED, Reset Switch, and HDD LED. The Power and Reset switches are both designed to use "Momentary Switches," rather than "Latching Switches," which means the connection between the two posts needs to be made just briefly for it to work, as opposed to being held in place. This is why the Power and Reset switches can be triggered with a screw driver by simultaneously touching the + and - posts.

Power LED will power on with the system, indicating the system is on and can blink with CPU activity.

HDD LED will blink during access to the SATA ports; this is not activated for M.2 SSDs.

18. Removable BIOS Chip

The ability to remove and replace the BIOS chip without requiring special tools is a key feature on many of our boards, by adding a level of protection against BIOS failures, bad BIOS flashes, BIOS corruption, etc. This feature also allows EVGA to work with end-users if something happens to render the BIOS chip unusable or a BIOS update is needed for CPU compatibility; rather than replacing the whole board, Customer Support can send a pre-flashed BIOS chip to get you up and running without requiring the end-user to send in the motherboard. Please see the walkthrough on Page 114 for further information.

19. CMOS Battery

The CMOS battery backup provides uninterruptable power to the BIOS/UEFI to keep all of the settings; otherwise, each boot would behave like you just reset the BIOS. These batteries typically last several years and rarely need to be replaced.

20. Front Panel Audio Connector

This is a motherboard header, which is used to plug in the audio cable originating from most PC chassis to allow audio to be recorded from or played through the audio connectors on the chassis. This header has a connector that looks similar to USB2 and will use the standard “HD Audio” jack. Some systems may have two headers: one labeled HD Audio, and one labeled AC’97 – this header is **not** compatible with AC’97

21. Rear Panel Connectors (Figure 2)

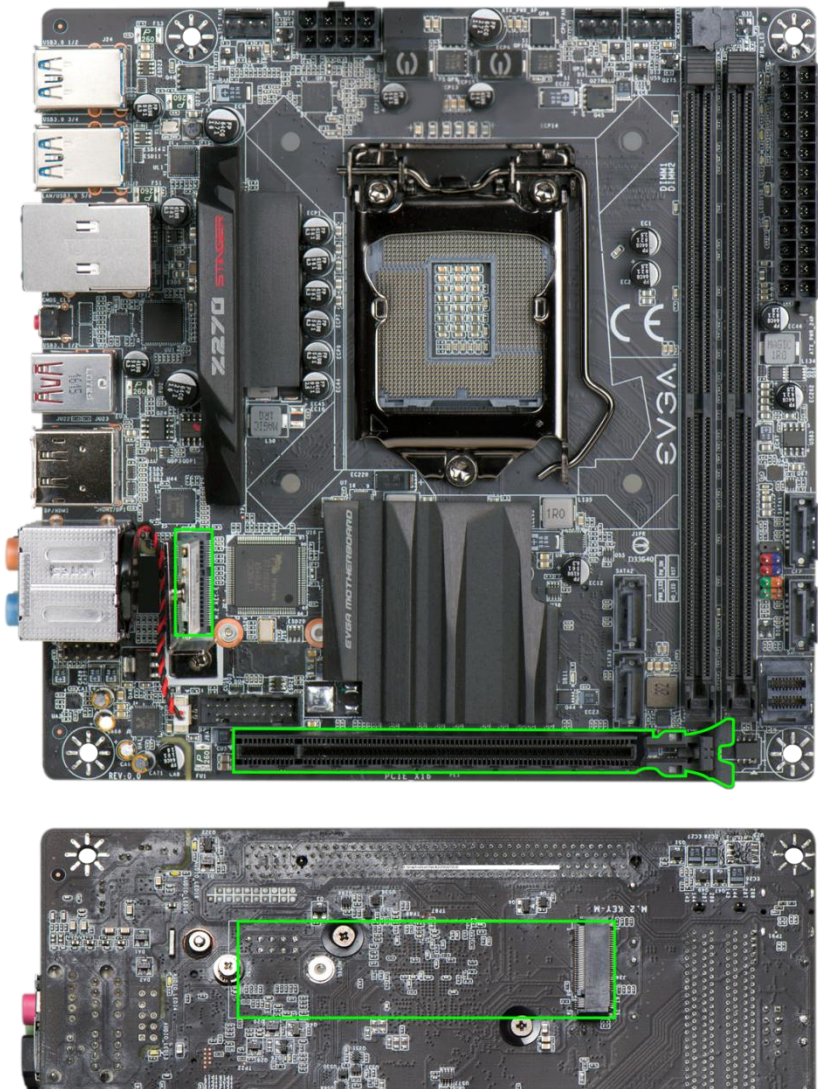
This is the section referred to as the I/O Hub. This panel contains the hardwired USB, Sound, and Ethernet connections. Please see Page 15 for a component level breakdown.

* There are two numeric references for PCI-Express: one is mechanical, which is the actual slot-length footprint, and the second is electrical, which is a reference of how many PCI-E lanes are routed to the slot.

As PCI Express is designed to be a universal architecture, you can install x1 cards, such as sound cards or USB controllers into a x16 slot. Many types of cards can use different amounts of PCI-E lanes, while some applications use only certain parts of a card, such as compute apps that allow a card to run off of a single PCI-E lane. This is why there are x16 mechanical slots with a x1 electrical PCI-E lane. Using the entire length of a PCI-E slot is unnecessary, nor does it cause an adverse effect to use a shorter form-factor bus card in a slot that physically can hold a larger form-factor bus card.

Card Slots

The Z270 STINGER features 1 x16 PCI-E slots, 1 Socket 3 Key-M M.2 80mm (backwards compatible with Key-M 60mm) placed on the back of the motherboard, and 1 Socket 1 Key-E M.2 on a vertical riser.



PCI-E Slot Breakdown

PCI-E Lane Distribution (All Socket 1151 processors are 16 lanes.)

- ❑ PE1 – x16 (Gen3, x16 lanes from CPU)

M.2 and U.2 Slot Breakdown

M.2 Lane Distribution

- ❑ M.2 Key M (80mm, back) – x4 from PCH
 - M.2 Enable/Disable is set within the BIOS
 - M.2 Key M does not share resources with other components
 - ❑ M.2 Key E (32mm) – x1 from PCH
 - M.2 Enable/Disable is set within the BIOS
 - M.2 Key E does not share resources with other components
 - ❑ U.2
 - U.2 Enable/Disable is set within the BIOS
 - U.2 does not share resources with other components
- This motherboard does NOT have any lane replication via PLX; all lanes are native and derived from CPU or PCH. This also allows for improved backwards compatibility for Gen 2 devices.

Preparing the Motherboard

Installing the CPU

Be very careful when handling the CPU. Hold the processor only by the edges and do not touch the bottom of the processor.

Note: Use extreme caution when working with the CPU to not damage any pins in the CPU socket on the motherboard!

Use the following procedure to install the CPU onto the motherboard:

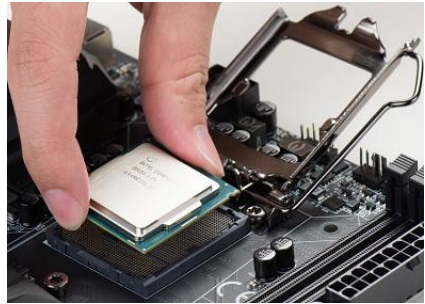
1. Remove the plastic protective socket cover by pulling it straight up. Be sure not to damage any of the pins inside the socket.
2. Unhook the socket lever by pushing down and away from the socket.
3. Pull the socket lever back and the load plate will lift.
4. Open the load plate and make sure not to damage any of the pins inside the socket.



Note: After removing the CPU socket cover, it is recommended to store it in case you ever need to transport your motherboard. If you ever remove the CPU, it is highly recommended to reinstall the socket cover.

5. Align the notches on the CPU to the notches in the socket.
6. Lower the processor straight down into the socket.

Note: Make sure the CPU is fully seated and level in the socket.



7. Lower the load plate so it is resting on the CPU.
8. Carefully lock the lever back into place.



Installing the CPU Cooling Device

There are many different cooling devices that can be used with this motherboard. Follow the instructions that come with your cooling assembly.

Installing System Memory (DIMMs)

Your Z270 Stinger has two (2) 288-pin slots for DDR4 memory. These slots support 4GB, 8GB and 16GB DDR4 DIMMs. There must be at least one memory slot populated for the board to boot and operate.

The Intel Z270 chipset supports dual-channel DDR4 memory, a maximum of 32GB and up to 3600MHz+ (OC). You will likely always have 2 DIMMs installed, as most kits are pairs, however for troubleshooting, test slot 2 first. See chart below and right:

Use the following procedure to install memory DIMMs. Note that there is an off-center gap near the center of the DIMM slots. This matches the gap on a DDR4 DIMM to ensure the memory is installed properly, and to prevent the incorrect installation of memory.

1. Unlock a DIMM slot by pressing the top-side module clips outward.
2. Align the memory module to the DIMM slot, and insert the module perpendicular to the DIMM slot, pressing straight down to seat the module. The plastic clips at top side of the DIMM slot automatically lock the DIMM into the connector.



RAM slot fill order		
	Slot 1	Slot 2
1 DIMM		X
2 DIMM	X	X

Note: The memory controller on most Skylake and Kaby Lake-S CPUs runs at a default frequency of 2133/2400MHz. Achieving memory speeds above 2400MHz+ may require manual setting of the memory timings, frequency and voltages and/or overclocking of the CPU.

Refer to the memory manufacturer specifications for the recommended memory timings. For overclocking support you can visit our forums:

<http://forums.evga.com/>

Installing the I/O Shield

The motherboard kit comes with an I/O shield that is used to block internal components from dust and foreign objects, while also promoting correct airflow within the chassis.

Before installing the motherboard, install the I/O shield from the inside of the chassis. Press the I/O shield into place and make sure it fits securely.

Installing the Motherboard

Installing the motherboard into a system case depends on several factors: whether you are replacing an existing motherboard, whether you are building a new PC, and the type of chassis that will house your PC components. You must first determine if it would be easier to secure the motherboard to the chassis or if it would be easier to install other components prior to this step. It is normally easier to secure the motherboard first.

Note: Be sure that the CPU fan assembly has enough clearance for the system case covers to lock into place and for expansion cards. Also, make sure the CPU Fan assembly is aligned with the vents on the covers; this is to allow the airflow to properly exhaust from the chassis. The CPU Fan assembly orientation will depend on the system case being used.

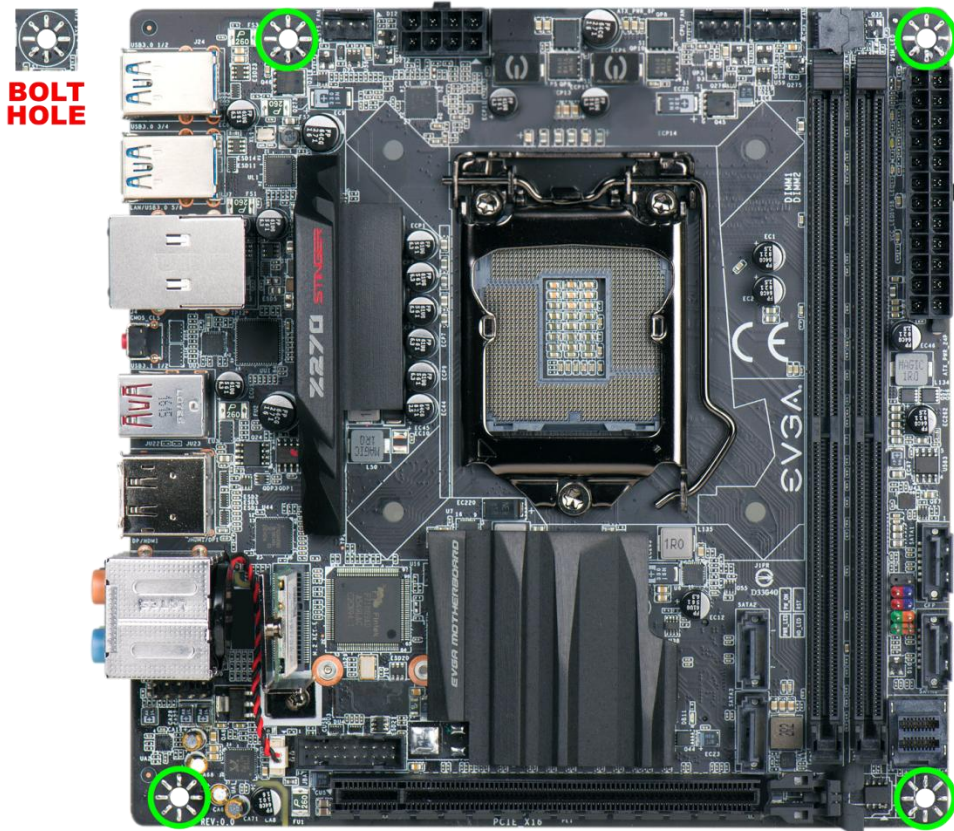
Securing the Motherboard into a System Case

Most system cases require installation of standoffs into the chassis to allow the motherboard to be mounted to the chassis and prevent short circuits. If there are studs that do not align with a mounting hole on the motherboard, it is recommended that you remove that standoff to prevent the possibility of a short circuit; also ensure that all needed standoffs are fully tightened before attaching the motherboard to the chassis. Please review the installation manual included with your chassis for the proper installation of the motherboard standoffs.

1. Carefully place the motherboard onto the standoffs located inside the chassis.
2. Align the mounting holes with the standoffs.
3. Align the connectors to the I/O shield.
4. Ensure that the fan assembly is aligned with the chassis vents according to the fan assembly instruction.
5. Secure the motherboard with four (4) screws (See next page for mount hole location). Ensure that each screw is lined up with and screwing into the corresponding standoff under the board. Double-check alignment to make sure nothing gets cross-threaded.

Tip: If you have difficulty with getting some of the screws fastened, especially near the I/O hub, first try to loosely fasten all other screws on the motherboard, but don't completely tighten the screws. This may help to hold the board in place, allowing you to thread and fasten the remaining screws. Once all screws are properly threaded, remember to go back and tighten the rest of the screws.

6. See the picture below for a zoomed-in view of a hole to place over a standoff, as well as the locations of standoff holes for the Z270 STINGER.

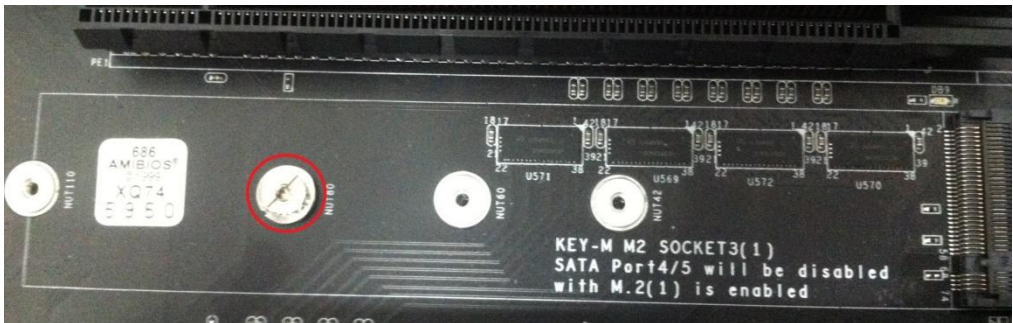


1. All safe locations to secure the board to a standoff are circled above in red.
2. Keep in mind that when the screws are installed, but not fully tightened, the motherboard should have 1-2mm of movement; this can help with mounting cards or tight-fits with other components.
3. Once the board is properly aligned, be sure to fully-tighten the board to the chassis before proceeding
4. On the STINGER platform, if you intend to use M.2 Key M install M.2 PRIOR to installing the motherboard to the case.

Installing M.2 devices

Securing a M.2 device to the motherboard requires a few extra steps compared to other current drive or slot-based connectors. M.2 devices used on this motherboard, Socket 3 (for SSDs) and Socket 1 (for WiFi/Bluetooth), will be installed and attached the same way. Below are images from an installation of a SSD on a Socket 3 Key-M.

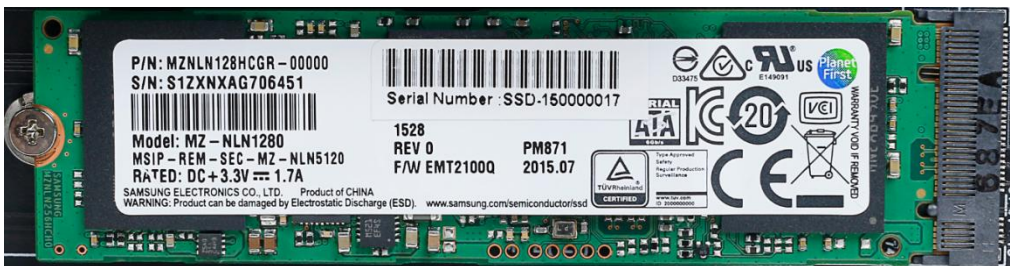
1. Remove the screw that comes pre-attached to the M.2's retention standoff; this will be used to keep the device in place.



2. Insert the M.2 device in at a slight angle, at approximately 45 degrees to the board. This will allow the contacts (colloquially called “Gold Fingers”) to seat completely into the slot. If the device is fully seated, you should be able to release it and the device will rest at an angle of about 30 degrees on its own, as shown in the picture below.



3. Gently push the M.2 device down on the raised end. There will be some tension - this is normal - then use the screw you removed in Step 2 to secure the device. Below, you can see that the contacts will be nearly invisible when the device is properly seated and the copper mounting semi-circle is partially visible around the screw.



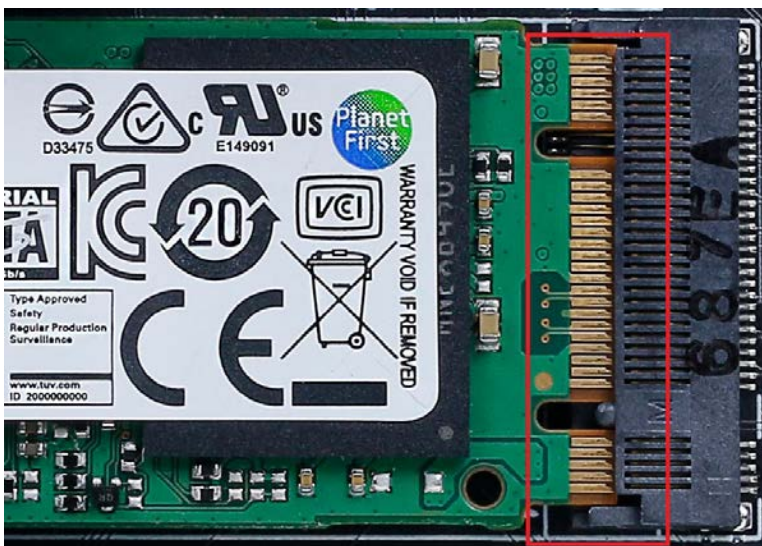
Incorrect installation Example:

***NOTE* This is one of the most common examples of an incorrect installation of a M.2 device. Do not intentionally attempt this, or complete your installation with this example. Doing so could cause damage to the device or the M.2 port.**

Using the image below, notice how the gold fingers fail to fully seat in the M.2 slot. This often occurs if the drive was pushed into the slot from a nearly parallel starting position, rather than an angle, causing the M.2 device to not seat fully. As a result, this may cause a drive detection failure by the BIOS, the drive will be detected with the description in gibberish (e.g. characters in the name, such as @, #, \$, %, *, etc.) and/or notifications that the drive has corrupt data stored on it.

Moreover, if the device's connection looks like this, then screwing down the device will likely be a VERY tight fit, if even possible, which is another sign that the device is not seated properly.

In conclusion, if the install device looks similar to the image below, please remove and reseat it using the instructions above. **DO NOT POWER THE SYSTEM ON IF THE CONNECTOR RESEMBLES THIS PICTURE.**



For further M.2 setup instructions please see Page 48.

Tested CPU and Memory

CPU	Core Count	Frequency	PCI-E Lanes
KabyLake-S			
Core [™] i7 7700K	4 Cores + HT	4.20 GHz	16
Core [™] i7 7700	4 Cores + HT	4.00 GHz	16
Core [™] i5 7600K	4 Cores	3.80 GHz	16
Core [™] i5 7600	4 Cores	3.50 GHz	16
SkyLake			
Core [™] i7 6700K	4 Cores + HT	4.20 GHz	16
Core [™] i5 6600K	4 Cores	3.90 GHz	16
Core [™] i5 6400	4 Cores	3.30 GHz	16
Core [™] i3 6300	2 Cores + HT	3.80 GHz	16
Core [™] i3 6300T	2 Cores + HT	3.30 GHz	16
Core [™] i3 6100	2 Cores + HT	3.70 GHz	16
Core [™] i3 6100T	2 Cores + HT	3.20 GHz	16
G4520	2 Cores	3.60 GHz	16
G4500	2 Cores	3.50 GHz	16
G4500T	2 Cores	3.00 GHz	16
G4400T	2 Cores	2.9 GHz	16
G3920	2 Cores	2.90 GHz	16
G3900T	2 Cores	2.60 GHz	16

Vendor	Part Number	Size	Frequency	Slot	Timing	Voltage
Crucial	CT8G4DFD8213.16FA1	8G	2133	1-2	15-15-15-36	1.2V
G.SKILL	F4-2133C15Q-16GRR	4G	2133	1-2	15-15-15-36	1.2V
G.SKILL	F4-2133C15Q-32GRR	8G	2133	1-2	15-15-15-36	1.2V
Crucial	CT4G4DFS8213.8FA1	4G	2133	1-2	15-15-15-36	1.2V
CORSAIR	CMV8GX4M1A2133C15	8G	2133	1-2	15-15-15-36	1.2V
CORSAIR	CMK32GX4M4A2133C13	8G	2133	1-2	13-15-15-28	1.2V
CORSAIR	CMK16GX4M4A2133C13	4G	2133	1-2	13-15-15-28	1.2V
CORSAIR	CMK64GX4M8A2133C13	8G	2133	1-2	13-15-15-28	1.2V

Vendor	Part Number	Size	Frequency	Slot	Timing	Voltage
G.SKILL	F4-2133C15D-8GRR	4G	2133	1-2	15-15-15-35	1.2V
Kingston	HX421C14FBK4/16	4G	2133	1-2	14-14-14-35	1.2V
Kingston	HX421C13PBK4/16	4G	2133	1-2	13-13-13-36	1.2V
CORSAIR	CMK32GX4M2A2400C14	16G	2133	1-2	15-15-15-36	1.2V
Crucial	BLS4G4D24DFS.8FAR	4G	2400	1-2	16-16-16-40	1.2V
G.SKILL	F4-2400C15Q-16GRR	4G	2400	1-2	15-15-15-35	1.2V
G.SKILL	F4-2400C15Q-32GRR	8G	2400	1-2	15-15-15-35	1.2V
Crucial	BLS8G4D24DFS.16FAR	8G	2400	1-2	16-16-16-39	1.2V
CORSAIR	CMK16GX4M4A2400C14	4G	2400	1-2	14-16-16-31	1.2V
CORSAIR	CMD16GX4M4A2400C14	4G	2400	1-2	14-16-16-31	1.2V
CORSAIR	CMD32GX4M4A2400C14	8G	2400	1-2	14-16-16-31	1.2V
G.SKILL	F4-2400C15Q-64GRK	16G	2400	1-2	15-15-15-35	1.2V
G.SKILL	F4-2400C14Q-16GRK	4G	2400	1-2	14-14-14-34	1.2V
Mushkin	Blackline 997199F	8G	2400	1-2	15-15-15-35	1.2V
G.SKILL	F4-2400C15D-8GRR	4G	2400	1-2	15-15-15-35	1.2V
G.SKILL	F4-2666C15Q-16GRR	4G	2666	1-2	15-15-15-35	1.2V
G.SKILL	F4-2666C15Q-32GRR	8G	2666	1-2	15-15-15-35	1.2V
CORSAIR	CMD32GX4M4A2666C16	8G	2666	1-2	16-18-18-35	1.2V
CORSAIR	CMD16GX4M4A2666C15	4G	2666	1-2	15-17-17-35	1.2V
CORSAIR	CMD16GX4M4A2666C16	4G	2666	1-2	16-18-18-35	1.2V
CORSAIR	CMK16GX4M4A2666C16	4G	2666	1-2	16-18-18-35	1.2V
CORSAIR	CMK32GX4M4A2666C16R	8G	2666	1-2	16-18-18-35	1.2V
CORSAIR	CMD32GX4M4A2666C15	8G	2666	1-2	15-17-17-35	1.2V
CORSAIR	CMK16GX4M4A2666C15	4G	2666	1-2	15-17-17-35	1.2V
Kingston	HX426C15K4/16	4G	2666	1-2	15-17-17-35	1.2V
Kingston	HX426C15FBK4/32	8G	2666	1-2	15-17-17-35	1.2V
CORSAIR	CMD16GX4M4A2800C16	4G	2800	1-2	16-18-18-36	1.2V
CORSAIR	CMK16GX4M4A2800C16	4G	2800	1-2	16-18-18-36	1.2V
G.SKILL	F4-2800C16Q-16GRR	4G	2800	1-2	16-16-16-36	1.2V
G.SKILL	F4-2800C15Q-32GVR	8G	2800	1-2	15-15-15-35	1.25V
CORSAIR	CMD16GX4M4B3000C15	4G	3000	1-2	15-17-17-35	1.35V
G.SKILL	F4-3000C15Q-16GRR	4G	3000	1-2	15-15-15-35	1.35V

Vendor	Part Number	Size	Frequency	Slot	Timing	Voltage
Kingston	HX430C15PBK4/16	4G	3000	1-2	15-16-16-39	1.35V
CORSAIR	CMK16GX4M4B3000C15	4G	3000	1-2	15-17-17-35	1.35V
G.SKILL	F4-3000C15Q-32GVR	8G	3000	1-2	15-15-15-35	1.35V
G.SKILL	F4-3200C16Q-16GRKD	4G	3200	1-2	16-16-16-36	1.35V
Kingston	HX432C16PBK4/16	4G	3200	1-2	16-16-16-39	1.35V
CORSAIR	CMD16GX4M4B3200C16	4G	3200	1-2	16-18-18-36	1.35V
G.SKILL	F4-3200C16Q-32GVK	8G	3200	1-2	16-16-16-36	1.35V
Kingston	HX432C15PBK2/8	4G	3200	1-2	15-17-17-39	1.35V
G.SKILL	F4-3200C14Q2-64GTZ	8G	3200	1-2	14-14-14-34	1.35V
G.SKILL	F4-3200C14Q-64GVK	16G	3200	1-2	14-14-14-34	1.35V
G.SKILL	F4-3600C17C-16GVK	4G	3600	1-2	17-18-18-38	1.35V
G.SKILL	F4-3600C17Q-32GVK	8G	3600	1-2	17-18-18-38	1.35V

Tested U.2

U.2 (SSD):			
Brand	Part Number	Size	Interface
Intel	750 SSDPE2MW400G4	400GB	U.2 NVME w\Cable
Intel	750 SSDPE2MW400G4	400GB	U.2 NVME w\Cable

Tested M.2 Key-M

M.2 Key M (SSD) :			
Brand	Part Number	Size	Interface
Samsung	MZ-HPU128T/004 128G	128GB	M.2
Samsung	MZ-HPV1280 SM951	128GB	M.2
Intel	SSDSCKHW120A4	120GB	M.2
Transcend	TS128GMTS800	128GB	M.2
Samsung	MZ-HPU128T/004	128GB	M.2
Kingston	SHPM2280P2H/240	240GB	M.2 + PCIE Adapter Card
Samsung	MZ-VKV512 NVM Express	512GB	M.2
Intel	SSDSCKKW120H6	120GB	M.2
Intel	SSDSCKKW240H6	240GB	M.2
Intel	6000P SERIES SSDPEKKF256G7	256GB	M.2 + PCIE Adapter Card
Intel	6000P SERIES SSDPEKKF512G7	512GB	M.2 + PCIE Adapter Card

Tested M.2 Key-E

M.2 Key E (WiFi):		
Brand	Part Number	Wifi Support
Intel	7265NGW	BT 4.0, 802.11ac
Azure Wave	AW-NB165NF	BT 4.0, WLAN B, G, N

Connecting Cables

Important caveat: the images below do **NOT necessarily represent the physical orientation of the specific header on *your* motherboard. Rather, these are physical representations designed to give you a basic physical footprint of the component **AND** the cable pinouts for the ports.**

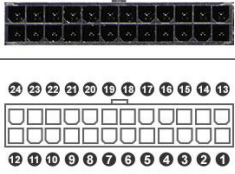
The locations of these ports can be found in the Component Legend on Page 13-14.

This section takes you through all the necessary connections on the motherboard. This will include:

- ❑ Power Connections
 - 24pin ATX power (**PW1**)
 - EPS 8-pin 12V power
- ❑ Internal Headers
 - Front Panel connectors (Power/Reset/LEDs)
 - Fan Headers (PWM for CPU and DC for case fans)
 - USB 2.0 Header
 - USB 3.0 Header
 - Audio Header
 - SATA
 - U.2
- ❑ Rear I/O Panel

24pin ATX Power (ATX_PWR_24P)

24-pin Main Power

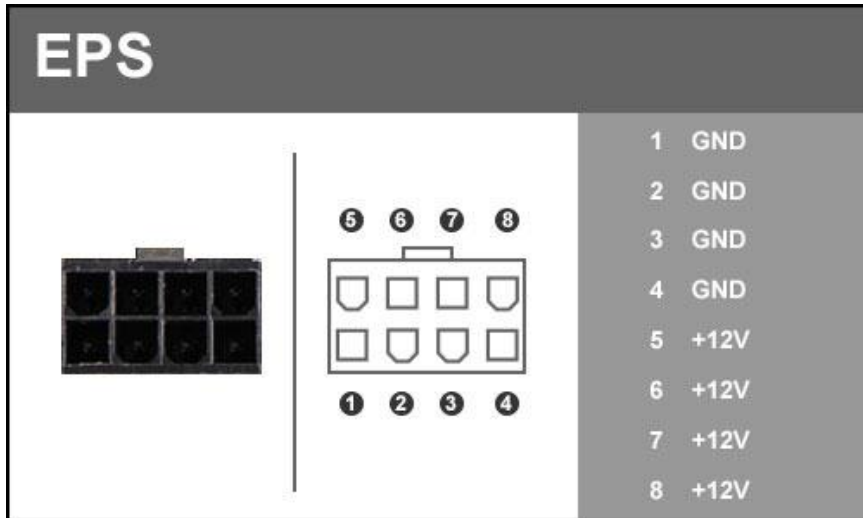


A diagram of the 24-pin ATX power connector. The top row shows 12 pins with voltage levels: 1 (+3.3V), 2 (+3.3V), 3 (GND), 4 (+5V), 5 (GND), 6 (+5V), 7 (GND), 8 (PWROK), 9 (+5V_AUX), 10 (+12V), 11 (+12V), 12 (+3.3V). The bottom row shows 12 pins with voltage levels: 13 (3.3V), 14 (-12V), 15 (GND), 16 (PS_ON), 17 (GND), 18 (GND), 19 (GND), 20 (RSVD), 21 (+5V), 22 (+5V), 23 (+5V), 24 (GND). The pins are arranged in two rows of 12 pins each.

1 +3.3V	7 GND	13 3.3V	19 GND
2 +3.3V	8 PWROK	14 -12V	20 RSVD
3 GND	9 +5V_AUX	15 GND	21 +5V
4 +5V	10 +12V	16 PS_ON	22 +5V
5 GND	11 +12V	17 GND	23 +5V
6 +5V	12 +3.3V	18 GND	24 GND

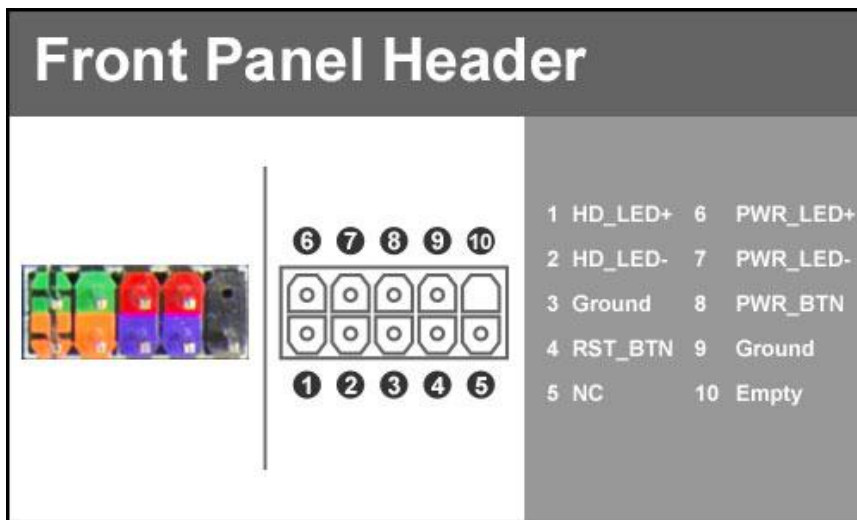
ATX_PWR_24p is the main power supply connector located along the lower-right edge of the board. Make sure that the power supply cable and pins are properly aligned with the connector on the motherboard. Firmly plug the power supply cable into the connector and make sure it is secure. The 24-pin Power Connector may be standard or right-angled depending on your motherboard model.

EPS 8-pin 12V Power (PWR 8P)



EPS PWR 8P, the 8-pin ATX 12V power connection(s), is used to provide power to the CPU. Align the pins to the connector and press firmly until seated. The secondary EPS, if present, is optional for improved overclocking. Please remember to make sure that the tab on the EPS socket is aligned with the release clip on the cable. **NOTE:** If the tab and release clip are on opposite sides, yet the power connector fits, then you are using a PCI-E 8-pin cable, which **WILL** damage the board if powered on. Please review installation instructions from your power supply manufacturer to verify which connectors may be used for the CPU power.

Front Panel Header



The front panel header on this motherboard is used to connect the following four cables:

- ❑ **PWRLED**

Attach the front panel power LED cable to these two pins of the connector. The Power LED indicates the system's status. When the system is powered on, the LED will be on.
- ❑ **PWRSW**

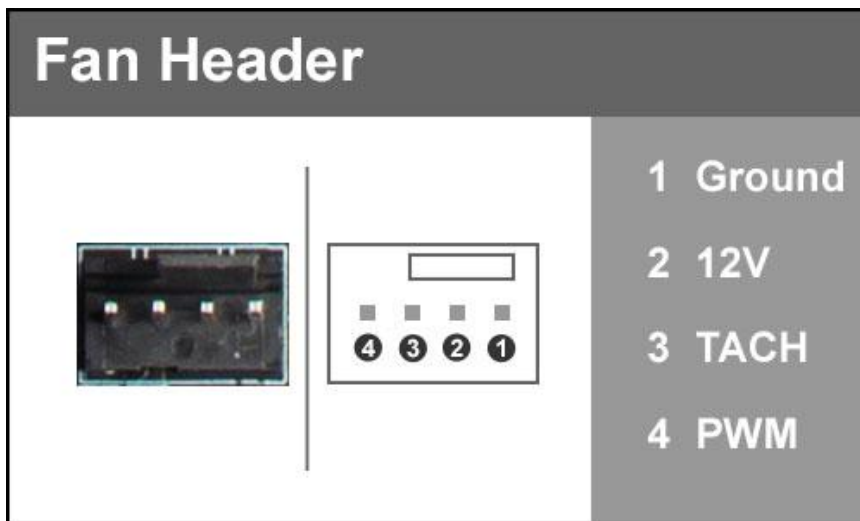
Attach the power button cable from the case to these two pins. Pressing the power button on the front panel turns the system on and off rather than using the onboard button.
- ❑ **HD_LED**

Attach the hard disk drive indicator LED cable to these two pins. The HDD indicator LED indicates the activity status of the hard disks.
- ❑ **RESET**

Attach the Reset switch cable from the front panel of the case to these two pins.

Note: Some system cases may not have all four cables. Be sure to match the name on the connectors to the corresponding pins.

Fan Header

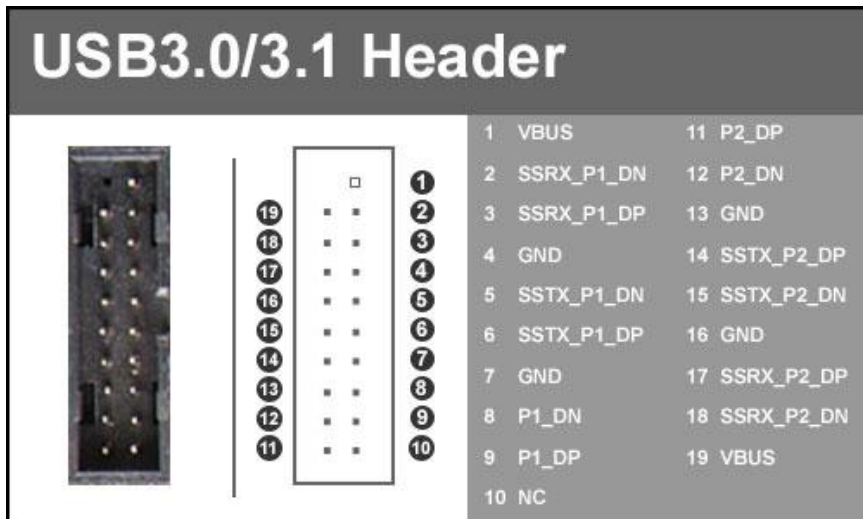


This motherboard line only has 4-pin fan headers, which are backwards compatible with 3-pin fan connectors. Fans may be controlled by PWM or DC controls. The headers have an absolute safe power limit of 1 Amp @ 12 Volts (12 Watts). These headers are for your CPU heatsink and chassis cooling fans.

USB Headers

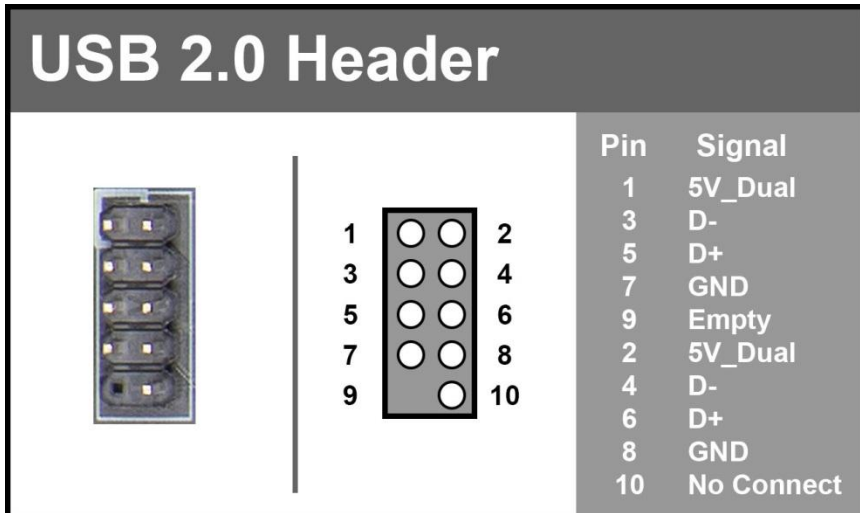
This motherboard contains USB 3.1 and 3.0 ports that are exposed on the rear panel of the chassis.

The motherboard contains 2x 19-pin internal header connectors onboard that can be used to connect an optional external bracket containing up to four (4) USB 3.0 ports.



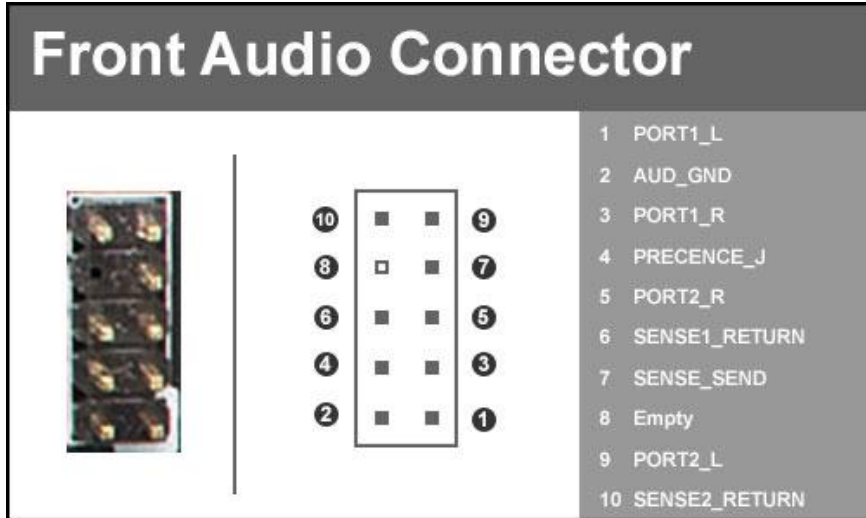
- ❑ Secure the bracket to either the front or rear panel of your chassis (not all chassis are equipped with the front panel option).
- ❑ Connect the end(s) of the cables to the USB 3.0 or 3.1 headers on the motherboard.

The motherboard contains 1x 9-pin internal header connectors onboard that can be used to connect an optional external bracket containing up to four (4) USB 2.0 ports.



- ❑ Secure the bracket to either the front or rear panel of your chassis (not all chassis are equipped with the front panel option).
- ❑ Connect the end(s) of the cables to the USB 2.0 headers on the motherboard.

Front Panel Audio Header

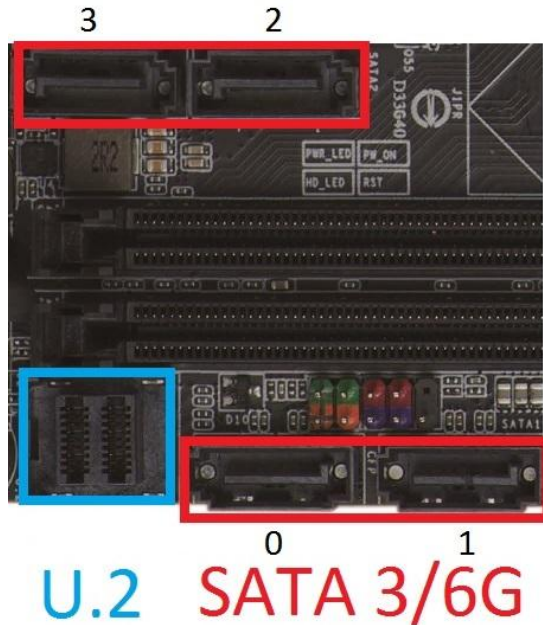


Front panel audio connectors support different audio standards and can provide two kinds of audio output choices: HD Audio, or AC'97 to accommodate older cases that still use AC'97 rather than HD. The Z270 STINGER only has a HD Audio front panel connector.

This header is also for 2 channel headphones or 2.1 speakers, and a Mic.

Drive Headers (SATA/ U.2)

SATA3/6G is the current standard for HDD/SSD/Optical interface. These cables are the data interconnect for the motherboard. Your HDD/SSD/Optical interface will still require a separate power connection from your power supply.



SATA ports on this platform natively support full AHCI and RAID functions. AHCI is enabled by default; however the controller can be put into RAID mode in the BIOS. RAID mode supports RAID levels 0, 1, 5, and 10 and supports all AHCI functionality. All SATA ports are boxed above in RED.

U.2 is a new storage standard and is enabled or disabled in BIOS; and has the advantage of the performance of a M.2 SSD and the ease of installation of a 2.5inch SSD.

See Page 50 for RAID levels supported and explanations for how they work.

Clear CMOS Button

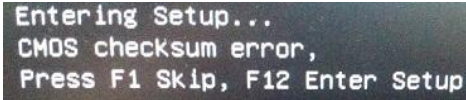
The motherboard uses CMOS RAM to store set parameters. The CMOS may be cleared by pressing the Clear CMOS button on the motherboard PCB or on the external I/O Panel.



External Clear CMOS Button

First Boot

When you power the system on for the first time (or after a BIOS update/reset) it may take a little longer than expected, and follow with a pause and message on the screen reading “BIOS Checksum error, Press F2 to continue or F12 to enter the BIOS.” This is completely normal.



```
Entering Setup...
CMOS checksum error,
Press F1 Skip, F12 Enter Setup
```

Depending on when the motherboard was purchased, compared to when it was released, there may be a BIOS update for it. If you have internet access on another PC and an USB Thumb Drive, it is highly recommended to download the current BIOS and flash the newer BIOS before attempting anything else.

If there is an updated BIOS, download and extract it onto a thumb drive formatted for FAT32, go to the Boot section, under “BIOS Firmware Update” select “Select BIOS File” and it will allow you to navigate to where your ROM file was stored, and press Enter to update.

****IMPORTANT NOTE. DO NOT CUT POWER OR REBOOT THE SYSTEM DURING A BIOS UPDATE; YOU WILL LIKELY RENDER THAT SPECIFIC BIOS UNBOOTABLE****

If you did update the BIOS, you will be greeted with the same screen as before stating that there is a Checksum error. Please press “Delete” to go into the BIOS/UEFI.

The Z270 chipset is designed for UEFI mode and Windows 8.1/10 natively. However, you can run in Legacy mode, if need be. Typically, there is very little setup needed on these boards.

To setup the Memory, use the arrow keys or your mouse to select the “Memory” setting, select the “Memory Profiles” pulldown and select XMP Profile 1. This will automatically set some basic memory information, such as speed, latency and voltage. You may set the memory speed manually, if you’d prefer, but the XMP will generally get the memory running at the memory manufacturer’s specification with little to no effort.

Next, click “Boot” from the menu list at the top. “Boot Option #1” should show the device that you intend to install your operating system. If the device does not show up in this menu, and is a standard SSD/HDD plugged into a SATA port, proceed down to “UEFI Hard Disk Drive BBS Priorities” at the bottom. In this menu, the top item will be “1st Boot” and will have a pulldown menu on the right. Click on the pulldown menu and select the intended drive; this will make the drive appear on the previous menu. If the drive doesn’t show at this point, please check the troubleshooting section on Page 117.

If you plan on using the M.2/U.2/SATA Express as a boot device, click on or navigate to the “Advanced” menu, select “Onboard Device Configuration” and enable the desired port.

Once this is done, press F10 to save and exit, plug in your operating system installation medium (likely a thumb drive) and Windows 10 should be able to boot to M.2 / U.2 / SATA Express without issue.

Note Some device manufacturers require specific drivers for HDDs or SSDs (such as M.2) before Windows can detect the drive for installation. Please make sure to consult the manufacturer’s instructions for your HDD or SSD before attempting to install Windows to determine if additional drivers are needed.

M.2 SSD, PCI-e SSD, and NVMe SSD Installation steps

M.2 is a card bus that can use multiple connector types to connect many types of devices, such as WiFi or SSDs, in a very small and power efficient package that is also very fast. M.2 devices can be connected to a M.2 card slot on the motherboard or through PCI-E on a M.2 to PCI-E adapter. There are also PCI-E native drives of this nature, such as the Intel 750. NVMe stands for Non-Volatile Memory Express, and is a high-performance standard for M.2/PCI-E SSDs. Most NVMe drives will require their own device drivers during the Operating System installation to be used as a boot drive, whether in M.2 or PCI-E form.

M.2/PCI-E share resources with other components on the motherboard, which may limit some hardware combinations. **PLEASE SEE CHART ON PAGE 22 FOR A DETAILED BREAKDOWN OF SHARED RESOURCES.**

M.2 Physical Installation

1. Please see Page 29 for M.2 physical installation instructions.

PCI-E Physical Installation

1. Install the SSD into any available PCI-E slot with at least x4 Lanes available (Gen3 Lanes are preferred for better speed, but Gen2 Lanes will still outperform the top end of SATA SSDs).
 - a. Please refer to Page 22 under PCI-E Lane Breakdown for lane specifics, as the PCI-E slot must be at least x4 electrically.
2. Attach the SSD's mounting bracket to the back of the case.
3. Native PCI-E drives will not normally require a separate power or data cable attached; all power and data transfers are done through the PCI-E slot.

BIOS Setup and Windows Installation for M.2 and PCI-E NVMe SSDs

1. Remember, NVMe is a new standard and older operating systems do not have native support. Many NVMe drives require certain steps to make the drive bootable, even with current operating systems.

PLEASE FULLY READ THE INSTRUCTIONS THAT COME WITH YOUR M.2 or PCI-E NVMe SSD BEFORE INSTALLATION.

2. After reviewing your SSD's instructions and its respective Physical installation instructions above, power on the PC and enter the BIOS/UEFI by pressing the F2 key repeatedly.
3. Once in BIOS/UEFI, navigate to the "BOOT" section. Then go down to the "CSM Configuration" heading and press enter, or click on it with your mouse.
 - a. For Windows 10 / 8.1: Set "Launch Storage OpROM Policy" to "UEFI". Then set "Launch CSM" to "Disable".
 - b. For Windows 7: Windows 7 does ****NOT**** have native support for NVMe, and limited UEFI support. In Windows 7, "Launch CSM" has to remain enabled, but set "Launch Storage OpROM Policy" to "UEFI".
4. Press F10 to save and exit the BIOS/UEFI.
5. Press Del on reboot to reenter BIOS/UEFI.
 - a. If you are using a SSD-attached via PCI-E, proceed to Step 6.
 - b. If you are using the motherboard's M.2 slot, proceed to Step 8.
6. If you are using a SSD connected via PCI-E (e.g. an Intel 750) or through an adapter that connects a M.2 SSD to PCI-E, go to "Advanced – PCI-E Configuration" and verify that the device shows on the slot you have it installed.
 - a. Verify the lane count and PCI-E Generation. It should state "x4 Gen3".
7. Next check the Dashboard on the upper right. The populated slot, lanes used, and PCI-E Generation should all match the information found in the previous step.
 - a. Proceed to Step 9 when done.
8. If you are using a SSD connected to the motherboard's M.2 slot, re-enter the BIOS/UEFI and go to "Advanced – Onboard Device Configuration," and set "M.2 Socket3" to "Enable."
9. Go to the "Boot" Section, set "Boot Mode Select" to UEFI, and set first boot device to "Hard Disk:Windows Boot Manager".
10. Press F10 to save and exit. Insert/Connect your Operating System install media and reboot.
11. Begin the Windows installation. During the drive selection step, you may need to load additional drivers that are provided by the SSD's manufacturer, which would be covered in the SSD manual. If these steps are not followed you will likely be unable to install the Operating System to the SSD and make it bootable.

Internal RAID Controller

This section introduces RAID, RAID levels, and the basics of the controller integrated into the PCH. It covers the basics of what RAID does, how RAID works, and why you may or may not want to use RAID.

This section is GREATLY simplified; those who have experience with RAID - especially from the server side - will find this a VERY rudimentary simplification of a process that is quite complex on the back-end. The descriptions of the RAID levels are not based on the back-end logic from the controllers, but rather just a breakdown as a visual reference to understand the basics.

For the sake of explanation in this section, every drive representation here is assumed to be 1 Terabyte (for ease of math); also the reference of P-Drive is “Physical” drive, and L-Drive is referencing “Logical” drives; physical drives are the physical drive you installed, whereas the logical drive is what Windows sees in Disk Management. This is a necessary distinction because RAID is a form of drive virtualization; taking several physical drives and making one logical drive out of them. You can add a minimum of two drives up to a maximum of six drives depending on the configuration (for this controller specifically) and the operating system will see only one logical device.

RAID LEVELS

ALL RAID LEVELS: All RAID levels will lose some capacity through the process of making the array. A small amount of disk space is used, in part, to maintain connections to data across drives, but the quality and size of drives used can impact the amount.

A general rule of thumb for final array capacity is this: Take the number of drives, the array type, and individual drive capacity (for this RAID breakdown all drives are 1TB) and multiply it out as shown below for the specific RAID type you intend to use:

RAID0 = (Number of Drives) * (Drive capacity)

RAID1 = Capacity of one drive, as all data is copied on both drives

RAID5 = (Number of drives – one drive) * (Drive capacity)

RAID10 = (Half the number of drives) * (Drive capacity)

To account for capacity lost both due to maintaining the array as well as what is lost during the formatting process, multiply the product by .85 and you should see a volume close to this number once the array is partitioned. This will vary based on type of drive,

its quality, and many other factors; but the number should give you a ballpark estimate on what to expect as a final capacity once formatted.

Please see below for examples of what to expect when you build an array of each type. Each RAID type will use diagrams to illustrate functional and non-functional forms of each RAID; all green items indicate a drive that is functional, and red indicates a drive that has failed.

BEFORE BUILDING AN ARRAY, BE SURE YOUR SSDs OR HDDs ARE THE SAME MAKE, MODEL, AND CAPACITY. MIXING DRIVES CAN CAUSE ANYTHING FROM ODD PERFORMANCE ISSUES, ARRAYS DE-SYNCING, LARGE SCALE DATA CORRUPTION, AND/OR UNRECOVERABLE ARRAY FAILURE. MAKE SURE THAT YOUR INTENDED HDD SUPPORTS RAID; IF NOT, THE DRIVE MAY CAUSE CONSTANT DESYNCRONIZATION ISSUES DUE TO DATA TTL TIMERS NOT SENDING AN “ALL IS WELL” SIGNAL WITHIN THE EXPECTED TIMEFRAME, WHICH WILL SEND THE CONTROLLER THE MESSAGE THAT THE DRIVE HAS FAILED OR DISCONNECTED.

If you are unsure about any of the bolded section above, please contact the drive manufacturer’s customer service to make sure the device is supported for RAID. If the drive is not, the controller cannot work around it and make it function as intended.

RAID0: This type of array is often referred to as “Striping” or a “Striped Array.” RAID0 takes a data set and spreads it equally across two (2) or more drives. The logic behind this array is that reading a single file, for example, will be much faster if the file is spread across two (2) or more drives and read from both drives simultaneously; thus reducing the time each drive spends in the read process by at least 50% rather than being read from one source. The file is then reassembled once the data hits RAM. This is similar, in theory, to how multi-channel memory or SLI works: load balancing for storage.

Because RAID0 is only designed to distribute the data being written across multiple devices to improve performance there is ****NO FAULT TOLERANCE****, meaning if

one drive fails, the array fails. It MAY be possible to recover the data but that usually requires a data recovery service, which is not guaranteed and is usually very expensive.

RAID0 is typically only limited by the controller; however, you will get severely diminishing performance returns after 4 drives. If you go above 4 drives, you will also see more capacity loss after creating the array.

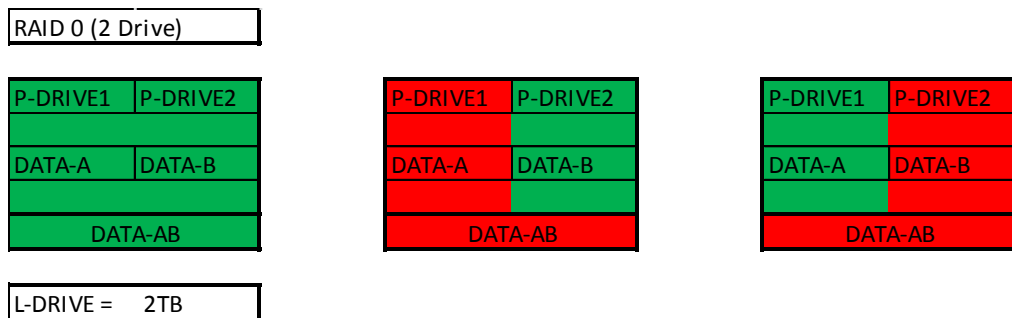
The Good-

- it can greatly increase the read/write speed of drives
- The most storage capacity-friendly use of drive space compared to other array types.

The Bad

- RAID0 has no redundancy, which makes it very volatile, if you lose even 1 drive, you lose everything.
- If you use this method, make sure to back up often.

Below is the breakdown of RAID0's function and the breakdown of a drive failure in this type of array. Wherever you see the section labelled "DATA" at the bottom turn **red**, this indicates an array failure.



As RAID0 has no fault tolerance, even a single drive failure compromises the array and renders the array Failed and unrecoverable.

The array depictions below show how this issue scales to larger arrays. In fact, due to the lack of fault tolerance, the potential failure rate actually increases because of the addition of more drives that can physically fail.

RAID 0 (4 Drive)

P-DRIVE1	P-DRIVE2	P-DRIVE3	P-DRIVE4
DATA-A	DATA-B	DATA-C	DATA-D
DATA-ABCD			

P-DRIVE1	P-DRIVE2	P-DRIVE3	P-DRIVE4
DATA-A	DATA-B	DATA-C	DATA-D
DATA-ABCD			

P-DRIVE1	P-DRIVE2	P-DRIVE3	P-DRIVE4
DATA-A	DATA-B	DATA-C	DATA-D
DATA-ABCD			

P-DRIVE1	P-DRIVE2	P-DRIVE3	P-DRIVE4
DATA-A	DATA-B	DATA-C	DATA-D
DATA-ABCD			

P-DRIVE1	P-DRIVE2	P-DRIVE3	P-DRIVE4
DATA-A	DATA-B	DATA-C	DATA-D
DATA-ABCD			

L-DRIVE = 4TB

RAID1: This type of array is referred to as “Mirroring” or a “Mirrored Array.”

RAID1 uses two (2) physical drives and writes ALL data to both drives simultaneously providing a 1 to 1 mirror, giving you 100% redundancy live. So as data is being written, if a drive fails you are still up and running. In most cases, when a failure occurs you will experience a stutter in performance and a small but noticeable slow down. Next, you’ll likely see a popup warning from IRST alerting you that a drive has failed or is disconnected, and your array’s status has been changed to “Degraded”.

RAID1 (at least on these PCH driven controllers) are limited to 2 drives. Also being that this is a mirror, you will use 50% of your capacity in redundancy.

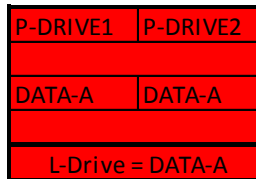
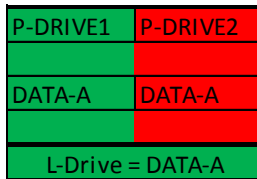
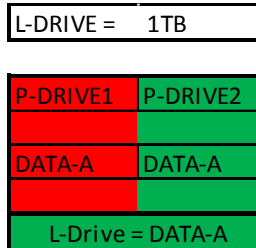
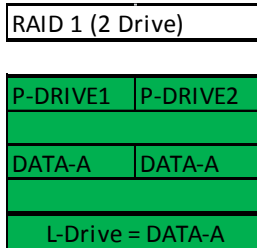
The Good-

- RAID1 allows you to suffer a catastrophic failure of 1 drive with no ill effects to the data being stored.
- Because data is stored on 2 drives at once, read speeds typically increase a little, but not to the speed of RAID5 and, certainly, not to the speed of RAID 0.

The Bad-

- RAID1 is not a storage capacity-friendly array, because the capacity will be limited to 1 drive.
 - Due to the capacity available on modern drive solutions, this issue may not be as significant as it once was.
- Write speed will be a bit lower than a single drive.

In the charts below, you can see the effect of fault tolerance when using a mirror array: because all data has a direct 1-to-1 duplicate on the mirrored drive, you can suffer a catastrophic failure of a drive and still retain your data. For a RAID1 array to lose its data, both drives must fail.



RAID5: RAID5 is a stripe with Fault Tolerance, which attempts to bridge the gap between speed and redundancy. This level will always reserve a capacity equivalent to one drive for fault tolerance, regardless of the overall capacity. This means that if you use four 1TB drives to create your RAID5, you will only have the capacity of three 1TB drives; likewise, if you use five 1TB drives to create your array, you will only have the capacity of four 1TB drives. RAID5 requires a minimum of three drives, and the maximum is set by the RAID controller; this level works well when using between four to six drives, but sees diminishing returns beyond six.

Similar to RAID1, or any other current type of array with fault tolerance, a RAID5 array is still usable even while it is experiencing a missing or failed drive resulting in the array functioning in a degraded state. Performance will suffer in a degraded state until the missing drive is replaced and the software rebuild process is completed. During the rebuild process, performance will be severely degraded and can take several hours, depending on the size of the array and percentage of capacity used.

The Good-

- Most space efficient array-type that also has fault tolerance.
- Initial array builds quickly
- Read/write speed is very good; faster than RAID1 but slower than RAID0

The Bad-

- Rebuilding an array can take a long time on an integrated PCH controller, especially when using a very large array with multiple drives or capacity.
 - For this reason, RAID5 is sometimes more beneficial on a dedicated RAID controller.
- If more than one drive fails at once (not likely, but still possible) you will suffer a total loss of data; the array will behave like a RAID0 losing a drive.
- RAID5 is close to outliving its usefulness because it was created, in part, to create large size arrays with fault tolerance. Due to the capacity available on modern drives, other RAID solutions are now better and with fewer downsides.

RAID5 protects data rotating parity (there are several terms coined by different RAID manufacturers over the years for RAID5 and they all mean roughly the same thing), which means taking small portions of data, duplicating them and putting them onto different drives. When a drive that has failed is replaced, its data is recreated by the remaining drives in the array, which will require a very high volume of small data segments copied back over to the replacement drive while also maintaining the array's index of data. Once the rebuild is complete, current data can be read from the new drive and new data can be written to it.

The RAID5 diagram below is a bit more complicated than the others, due to the nature of how data is distributed. In the diagram you will see that there is one more Physical drive than there is data set. This method of data distribution shows that as long as you have three (3) copies of each data set (Data-A, Data-B, and DATA-C), the array will be functional and capable of rebuilding when you add in replacement drive in. And while this is not mathematically correct for HOW the data distribution works, it is a good visualization to understand the basics of how it works.

RAID 5 (4 Drive)

P-DRIVE1	P-DRIVE2	P-DRIVE3	P-DRIVE4
DATA-A	DATA-B	DATA-C	DATA-A
DATA-B	DATA-C	DATA-A	DATA-B
DATA-C	DATA-A	DATA-B	DATA-C
L-Drive = DATA-ABC			

P-DRIVE1	P-DRIVE2	P-DRIVE3	P-DRIVE4
DATA-A	DATA-B	DATA-C	DATA-A
DATA-B	DATA-C	DATA-A	DATA-B
DATA-C	DATA-A	DATA-B	DATA-C
L-Drive = DATA-ABC			

L-DRIVE = 3TB

P-DRIVE1	P-DRIVE2	P-DRIVE3	P-DRIVE4
DATA-A	DATA-B	DATA-C	DATA-A
DATA-B	DATA-C	DATA-A	DATA-B
DATA-C	DATA-A	DATA-B	DATA-C
L-Drive = DATA-ABC			

P-DRIVE1	P-DRIVE2	P-DRIVE3	P-DRIVE4
DATA-A	DATA-B	DATA-C	DATA-A
DATA-B	DATA-C	DATA-A	DATA-B
DATA-C	DATA-A	DATA-B	DATA-C
L-Drive = DATA-ABC			

P-DRIVE1	P-DRIVE2	P-DRIVE3	P-DRIVE4
DATA-A	DATA-B	DATA-C	DATA-A
DATA-B	DATA-C	DATA-A	DATA-B
DATA-C	DATA-A	DATA-B	DATA-C
DATA-ABC			

P-DRIVE1	P-DRIVE2	P-DRIVE3	P-DRIVE4
DATA-A	DATA-B	DATA-C	DATA-A
DATA-B	DATA-C	DATA-A	DATA-B
DATA-C	DATA-A	DATA-B	DATA-C
L-Drive = DATA-ABC			

RAID10: RAID10 is the only level of nested RAID currently supported by the integrated PCH controller. Nested RAID is the process where a controller makes multiple RAID arrays, treating each of them as their own device and applies them to ANOTHER RAID level. This type of virtualization allows you to have an array where each node has its own level of redundancy.

In the instance of RAID10, it is two (2) or more Mirrored arrays (RAID1s) that are striped together (RAID0). In effect, this is RAID0 where every physical drive (now logical drive due to nested RAID functions) in the array is internally redundant via a mirror. This means you can lose a drive and the data set is still present; when the drive is replaced, it is replicated by the data internal to that node.

RAID10 is highly scalable. RAID10 always scales in two (2) drive increments, starting with a minimum of four (4) drives. This motherboard series supports a four (4) drive or a six (6) drive RAID10 array. Lastly, RAID10 is a mirrored array, which means it shares the same 50% drive capacity, as all data has a 1:1 copy.

The Good-

- Excellent Fault Tolerance
- Good rebuild times
 - Vastly superior rebuild times compared to the previous 0+1 methodology of nested RAID.
- Overall performance is good; comparable or slightly faster than RAID5.

The Bad-

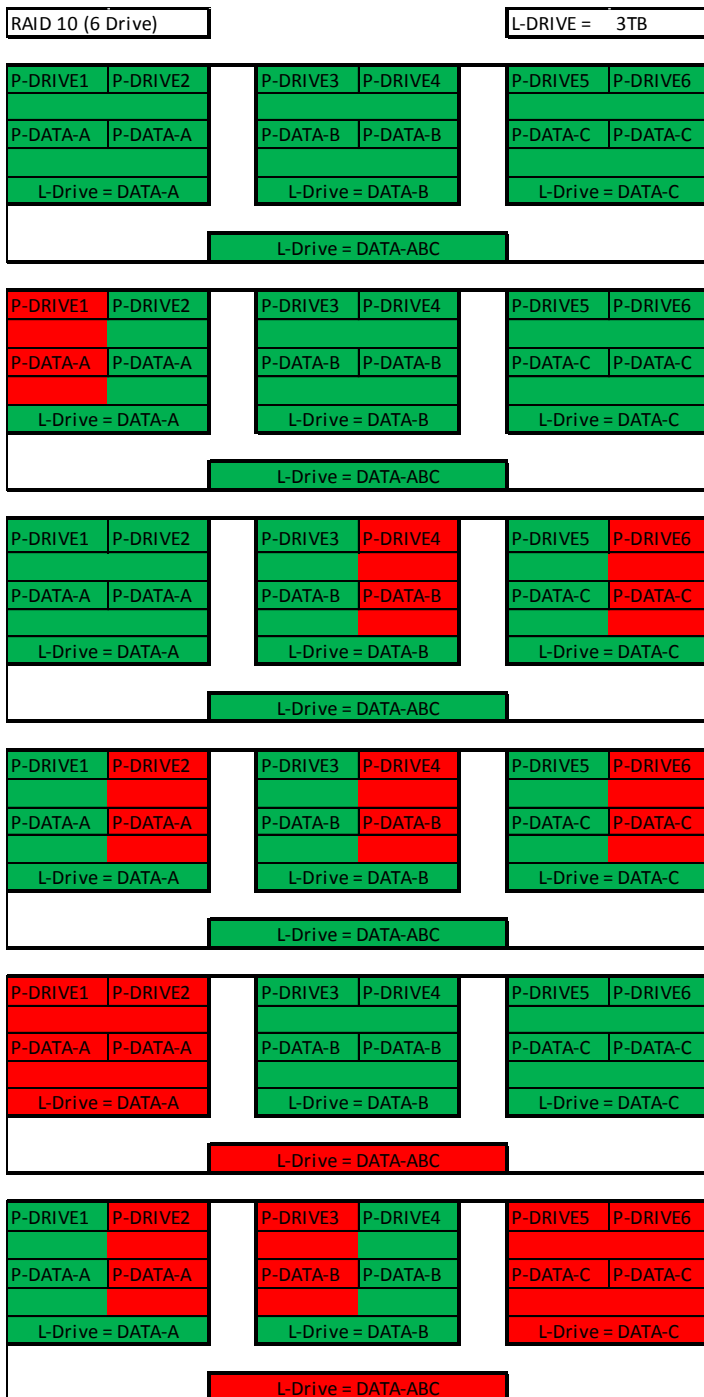
- Low space efficiency.
 - With the capacity of modern drives, this will likely be less of a consideration than in previous years.

The fault tolerance works a bit differently in RAID10 than in others because the array has nodes with internal redundancy. In other words, although a four drive array can lose two drives and remain operational, it greatly depends on WHICH two drives fail. If both drives from the same node fail, then half of the data is gone and the array has failed. However, every node, regardless of the number of total nodes, can suffer one internal failure with no adverse effects.



While the Z270 STINGER controller will support a four or six drive RAID10 array, RAID10 can scale indefinitely provided the controller supports more drives. Every pair of drives adds an additional mirrored node, which increases the theoretical number of failures the array can suffer before a loss of data occurs. However, an array can still fail due to both drives on a node failing.

In the case of a drive failure, the array controller will notify you. When you replace a failed drive in the RAID10, rebuilding the array is mostly seamless. For example, look at the array on the second row to the right. P-Drive1 failed, but P-Drive2 is still working and uses the same data. The array will pull data from P-Drive2 during the rebuild, so the array can be used normally while P-Drive2 copies ALL of its data back to the drive replacing P-Drive1. The rebuild process will only rebuild 1TB worth of data because only one node failed. There will be a performance hit during the rebuild process, which can be further delayed if VERY data intensive applications are used, but overall performance of the array will still be more than fast enough to run effectively during the rebuild. RAID10 rebuilds much more quickly than its predecessor RAID0+1.



RAID0+1: RAID0+1 is a form of nested RAID that was widely used on previous generation boards. Although the Z270 series motherboards do not use this type of array, it is listed here to show the improvements made by RAID10, and to clear up a common misperception that RAID0+1 and RAID10 are the same.

A RAID0+1 array is created from two (2) stripe sets that are mirrored together. Similar to RAID10, RAID 0+1 requires a minimum of four drives, and is highly scalable in two drive increments. Again, because RAID0+1 is a mirrored array, it shares the same 50% drive capacity, meaning that four 1TB drives in RAID0+1 will result in a 2TB array.

Where 0+1 differs from 10 is in how the drives are split, and the data distributed. While RAID10 is created using two or more mirror sets striped together, RAID0+1 is two striped sets mirrored together. When scaling with additional drives (in multiples of two), RAID10 adds the drives as another mirrored set to the striped array, whereas RAID0+1 splits the drives between the two stripes to maintain the mirror. To the end-user, the final result appears very similar; however, the significant differences lie in fault tolerance and recovery.

In a RAID0+1, ANY drive failure results in half of the array becoming effectively failed. If one drive fails, that stripe fails, and the mirrored stripe takes over. When the failed drive is replaced, the entire capacity of the mirrored array must be rewritten to the failed array, rather than one drive's worth of capacity (i.e. RAID10). This makes the RAID0+1 array more volatile than RAID10, despite being fault tolerant, and can also increase rebuild times at an exponential margin for large arrays.

Like RAID10, RAID0+1 can afford to lose up to half the number of drives in the array and still be protected; however, this is contingent on the failed units being all from the same stripe set. If one drive fails from both stripe sets at once, the entire array is lost.

The Good-

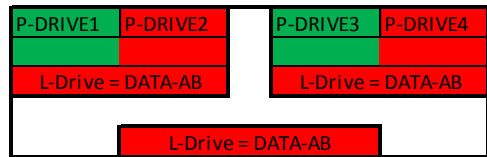
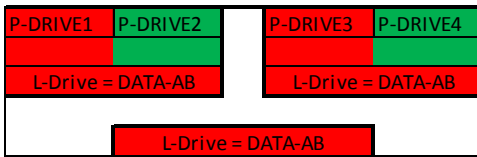
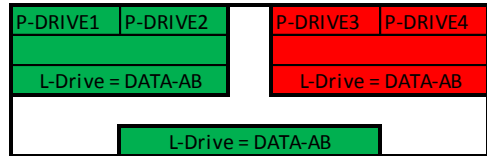
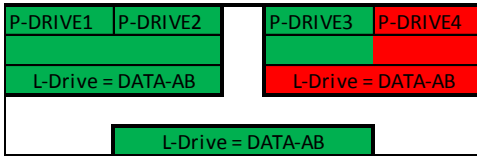
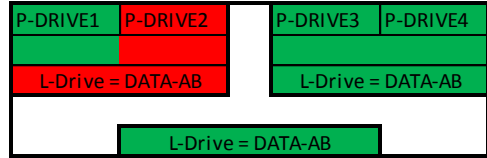
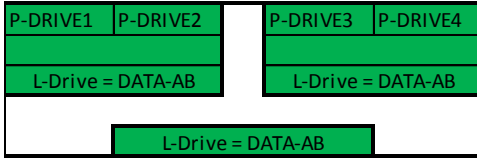
- Fastest of the standard nested RAID types
- Performance scales with drive count.

The Bad-

- Build times can be substantially longer than RAID10 due to the volume of data being moved, and is typically close to the rebuild times of RAID5.
- Low space efficiency, only 50% of total drive capacity is usable in the array.
- 1 drive failure drops a full stripe set.

RAID 0+1 (4 Drive)

L-DRIVE = 2TB



Motherboard controllers that support RAID0+1 (such as on older generation EVGA motherboards) will generally support 4 or 6 drive arrays of this type; other controllers can allow this array type to scale indefinitely. Each pair of drives adds to the drive count for the stripes and increases the theoretical volume of failures the array can suffer before a loss of data occurs. However, this type of array can fail due to any two drives on different stripes failing at once; this is RAID0+1's main drawback. Theoretically, at six drives and above, RAID0+1 should have slightly faster read/write speeds compared to RAID10 because the stripes are larger without the overhead of an internal mirror. This is because RAID10 increases both the number of mirror sets as the array scales upwards and the backend calculations needed to maintain the arrays, whereas RAID0+1 only increases stripe size.

As you can see, the difference between RAID0+1 and RAID10 is significant when looking at how data is stored. Although the drive volume scaling and the level of fault tolerance is the same, internalizing the redundancy can make a significant difference overall to the array.

In the examples to the right, you can see that when one drive fails the entire stripe set fails; for a RAID0+1, you would need to rewrite 3TB worth of data back onto the failed node when rebuilding, rather than 1TB for the same drive count on a RAID10.

RAID10 is the current standard on Intel PCH based RAID controllers, largely because the fault tolerance for it is a bit more forgiving and the rebuild speed is overall significantly faster than its RAID0+1 predecessor.



Which types of RAID can I use with my setup?

- 1 Drive – No RAID arrays are supported
- 2 Drives – RAID0 for speed (do regular backups) or RAID1 for data protection.
- 3 Drives – RAID0 for speed (do regular backups) or RAID5 for speed and protection.
- 4 Drives – RAID0 for speed (do regular backups), RAID5 for speed and protection, RAID10 for the best balance of Speed and protection.
- 5 Drives – RAID0 for speed (do regular backups), but it will start to show diminishing returns on performance; and RAID5 for speed and protection.

Also, you can run more than one array on your controller, so long as the total is under five (5) drives.

Configuring the Array

Attach all SATA devices you intend to use, and make sure power is attached. Power the system on. Press the “Delete” key repeatedly to enter BIOS. Once into BIOS you will need to enable the RAID function of the board.

Once into BIOS, click on (or navigate with your arrow keys) the “Advanced” tab at the top, and then on “SATA Configuration.”



In the “SATA Mode Selection” at the top, the default will be AHCI. Click on the arrow to the right side of AHCI or navigate to it with your keyboard and press “Enter” to open the pulldown menu. Select RAID from the list.

RAID mode not only includes the RAID controls, but also shares the same options/functions/commands as AHCI; you may continue using your AHCI devices normally when the SATA Configuration is set to RAID mode.

The SATA Information menu shows a list of all drives currently detected by the controller; make sure the list in your BIOS matches what you have plugged in. If it does not, reseal cables on the device(s) in question. If the issue persists, please check the troubleshooting section on Page 117.



Once RAID is enabled and all devices are detected, press F10 to save and exit. Upon reboot, repeatedly press “Delete” to reenter the BIOS. Once in the BIOS, go back to the “Advanced” tab where you’ll find a new item at the bottom of the list called “Intel® Rapid Storage Technology.”

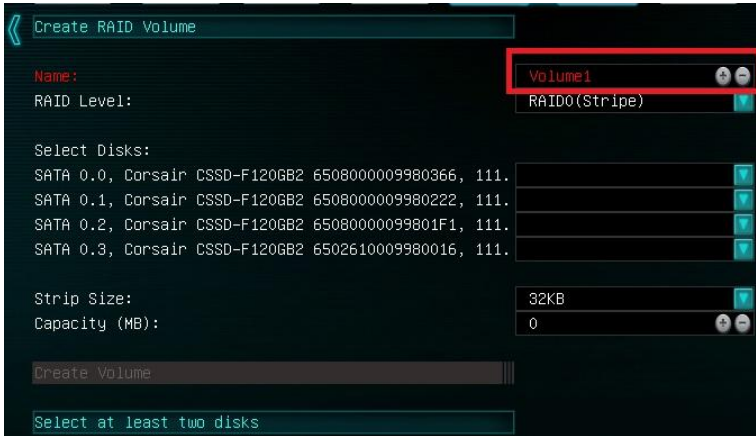
The Intel® Rapid Storage Technology utility in the BIOS replaces the Intel RAID manager that was previously launched outside of the BIOS in previous generation motherboards. Due to the current bootup process, speed of processors, and UEFI the previous method made accessing the Intel RAID manager nearly impossible. This is the same controller that was previously accessed by CTRL-I; now, it is fully accessible within the BIOS/UEFI.



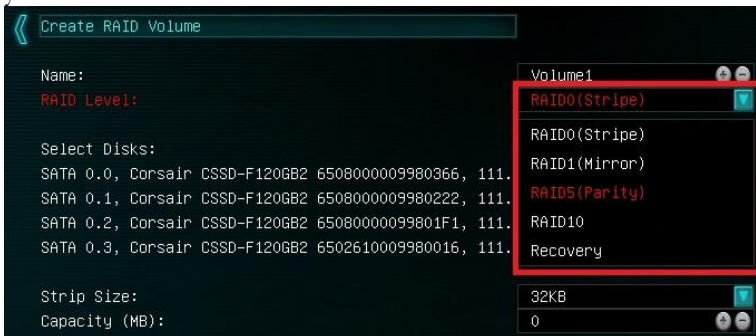
Once in the RAID controller, you will see a list of all detected drives and a “Create RAID Volume” button. To begin, click on “Create RAID Volume” or navigate to the button and hit “Enter.”



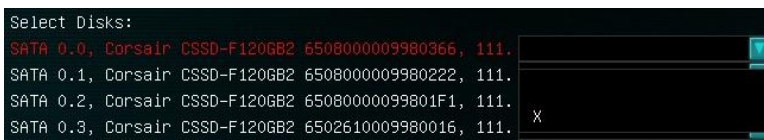
Choose a name for the volume. The controller allows up to 15 characters; you can use numbers and letters, but not special characters.



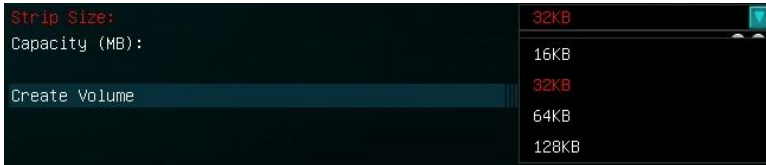
Next, select your intended array type. This can be done by either clicking on the down arrow and clicking on the RAID level you want, or pressing the enter key and using the down arrow to select the RAID level and pressing Enter again. Please see the top half of Page 62 for a quick reference on different RAID levels and RAID types based on your total number of drives.



Next select the drives you want to use for the array. Select the down arrow and the “X” for each drive you want to include in the array.



Strip size (also called “block size” in other controllers) can be selected manually at 16k, 32k, 64k, or 128k. The controller will determine the default strip size after looking at your drives and array type. Although there are some limited instances where this must be set manually, it is highly recommended to leave this at default.



The controller defaults the capacity to the maximum available space for the RAID. Leaving the capacity at default is recommended because reducing the size is not beneficial, except in limited cases.

To complete the setup process, please select “Create Volume” at the bottom of the page. Depending on the array type, drive type, and volume this can take a few seconds to a few minutes.



Once the array is completed you will see the text shown on the next page, or something similar based on the array type and drives used. At this point, the array is ready to use.



If your array will be your boot drive, the operating system will normally detect the array and see it as a single drive (this is expected), it *MAY* detect it as a RAID array; either way, the OS installation will show the size of the array, not a single drive, and allow you to install the OS to the array without any further steps. However, depending on the OS version, you may need to install RAID drivers for the RAID array to be detected.

If this is meant to be a secondary array, your next step is to partition and format the array within Windows. Please see Page 80 for setup in Windows 10.

Repairing an array within UEFI

This guide will show you how to repair a degraded array from within the UEFI. For testing purposes, a drive was intentionally removed from a RAID5 array and wiped to guarantee that the array rebuild behaved the same as if a new replacement drive was added to a degraded array.

If a drive fails and the array becomes degraded, you will typically see an alert in Windows, during the controller booting (Legacy mode only), or while checking the array status within UEFI. If a drive fails in an array with redundancy (a RAID5 array, in this case), the controller will report the array as “Degraded” (see pic below). This means that the array has a node down, the data is still intact, but your fault tolerance is reduced.



Highlight the degraded array with your mouse or navigate to it with your keyboard and select it to bring you into the array screen (see image on next page), which will show you your array status and any drives that are not currently configured in a RAID array. The

Non-RAID Physical Disks list will display any remaining drives on the controller, whether it is a random storage drive, a boot drive, or a replacement drive installed to replace a failed unit. For this example, you will see a degraded array and a “Non-RAID Physical Disk,” which we’ve attached to repair the degraded array.

The drive attached is an exact match to the other drives in our RAID 5; however, you can use a different drive if it is the same size and preferably same type/series, as well. ****ALL DATA ON THAT DRIVE WILL BE REMOVED AND WILL NOT BE RECOVERABLE WHEN ADDING IT INTO THE ARRAY**** The controller will also give you this information, but it cannot be overstated that using a drive with data on it will result in the total loss of all previous data in favor of the data on the array.

```

Intel(R) RST 14.6.0.2285 RAID Driver

RAID Volumes:
Volume1, RAID5(Parity), 335.4GB, Degraded

Non-RAID Physical Disks:
SATA 0.2, Corsair CSSD-F120GB2 65080000099801F1, 111.7GB
  
```

Select the degraded RAID volume, then select “Rebuild” on the following menu.

```

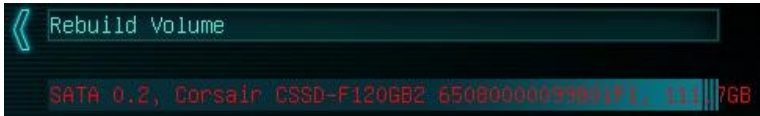
RAID VOLUME INFO

Volume Actions
Delete
Rebuild

Name: Volume1
RAID Level: RAID5(Parity)
Strip Size: 32KB
Size: 335.4GB
Status: Degraded
Bootable: Yes

RAID Member Disks:
SATA 0.0, Corsair CSSD-F120GB2 6508000009980366, 111.7GB
SATA 0.1, Corsair CSSD-F120GB2 6508000009980222, 111.7GB
SATA 0.3, Corsair CSSD-F120GB2 6502610009980016, 111.7GB
  
```

Next, you will see a list of all attached HDD/SSDs that can be used to rebuild the array. Select the disk, then click on it or press enter.



Once the process has started you will see the status change to “Rebuilding.”



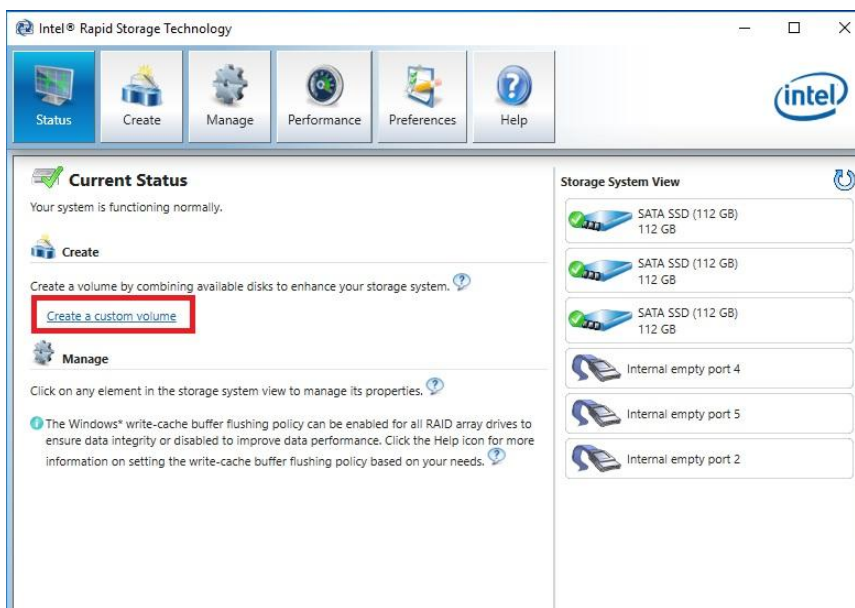
****Important Notice**:** The controller will not begin the rebuilding process until you have booted back into Windows; this queues the rebuild but does not start the process.

The rebuilding duration will vary. Fast drives in uncomplicated arrays with small amounts of data can rebuild very quickly. Large platter drive-based arrays, especially in RAID5, can take several hours to rebuild. The duration of the rebuild process will further increase based on the usage of both the array and the CPU during the process.

The rebuild process can be monitored from the “Intel Rapid Storage Technology” utility in Windows, which is effectively the software front-end for the Intel SATA controller. The rebuild status can be viewed in the “Manage” tab, located on the top of the IRST Window. Please see the image at the top of Page 76 to see an example of where to find the rebuilding % in the IRST.

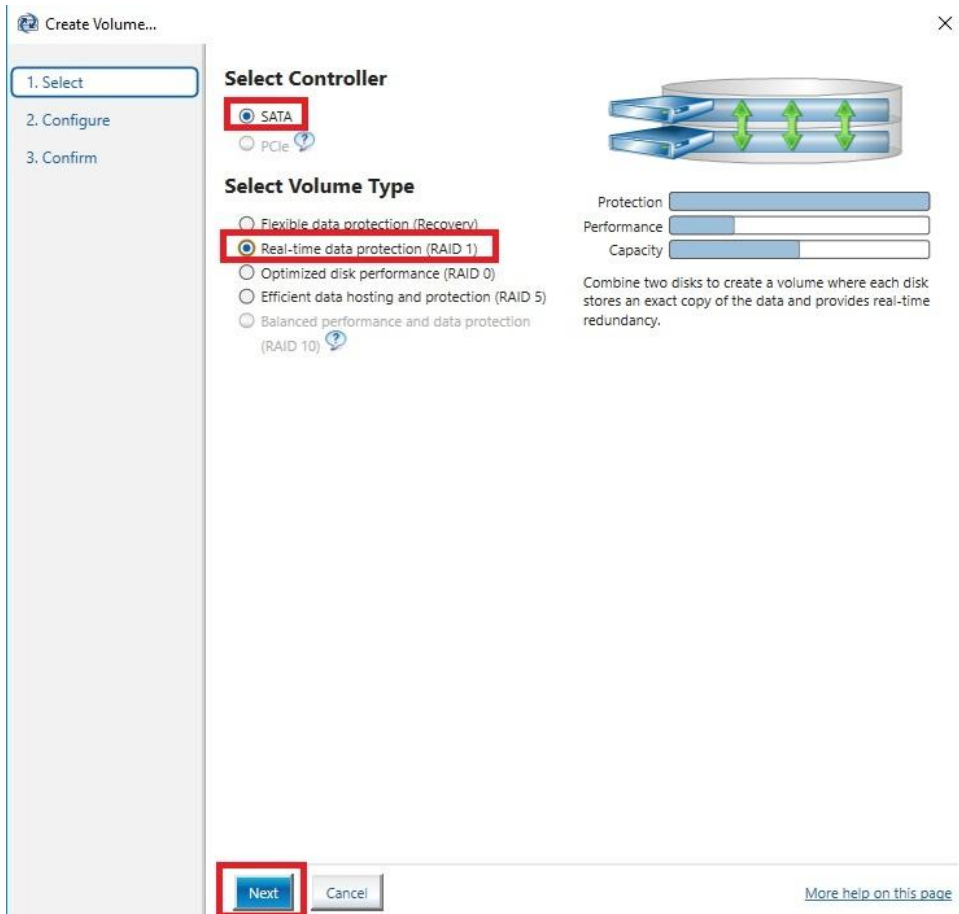
IRST (Intel Rapid Storage Technology)

The IRST is the software front-end for the Intel SATA controller. It is recommended to install the IRST drivers after installing the Intel Chipset Drivers – the main motherboard drivers. This guide walks you through not only the building, but also the repairing of an array from within Windows, since it may be more convenient to build new arrays within the OS rather than from within the UEFI. All forms of RAID that can be built in the UEFI are available in IRST; the IRST may be more convenient for some people due to a more detailed UI than the UEFI.



This guide will illustrate how to create a RAID1 array using the IRST. Using the screen above, we know that three (3) SSDs are currently attached to the controller and the other three (3) INTEL SATA ports are empty (this can vary board to board based on how many Intel SATA ports are present). If you plan to create another type of array, please ensure that you have the correct number of drives attached and shown on the status screen in IRST for your intended array before you start.

Referring to the above image, again, locate and click the hyperlink halfway down the window that says “Create a Custom Volume.” An array creation window will open:



SATA will be selected by default. PCI-E primarily refers to PCI-E / M.2 based NVMe drives; the same basic steps do apply to both, however. Select SATA, and “Real-time protection (RAID1).” Then, click Next at the bottom of the window.

RAID1 can only support two (2) drives. Left-click the open boxes from the list below to select your two preferred drives. You may also name the array anything you like. Although you have the option to define volume size, it is recommended to leave the array at 100%, which is the default.

Create Volume... X

1. Select
2. Configure
3. Confirm

Configure Volume

Name:

Select the array disks (minimum selection required):

- SATA SSD on Controller 0, Port 0 (112 GB)
- SATA SSD on Controller 0, Port 1 (112 GB)
- SATA SSD on Controller 0, Port 3 (112 GB)

Volume Size | **Advanced**

Volume Size 114,473 MB

Array allocation:

Proposed Configuration

Array_0000

Volume_0000
Type: RAID 1
112 GB

Back **Next** Cancel [More help on this page](#)

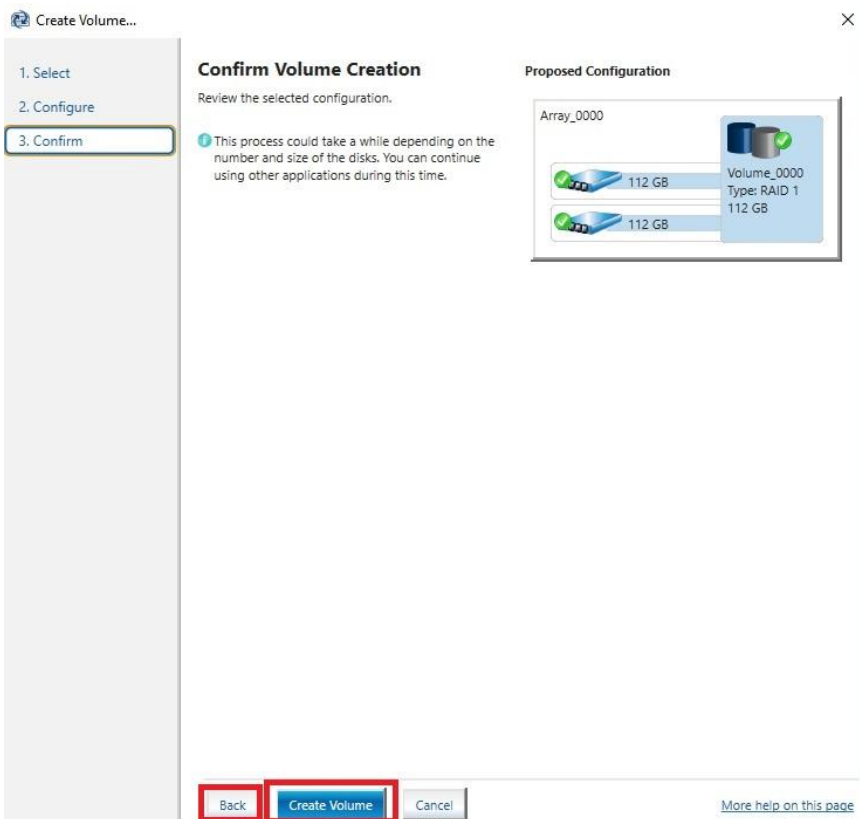
In the Advanced tab, you can select the option to “Initialize Volume,” which will occur after the array is created. If the array is not initialized now, it can be initialized later in “Disk Management.” See Page 80 for Disk Management instructions.

When done, click “Next” at the bottom.

The screenshot shows the 'Create Volume...' wizard in the 'Configure Volume' step. The interface is divided into three main sections: a left sidebar with step indicators, a central configuration area, and a right 'Proposed Configuration' preview.

- Left Sidebar:** Shows three steps: '1. Select', '2. Configure' (highlighted), and '3. Confirm'.
- Central Configuration Area:**
 - Name:** A text box containing 'Volume_0000'.
 - Select the array disks (minimum selection required):** A list of three options:
 - SATA SSD on Controller 0, Port 0 (112 GB)
 - SATA SSD on Controller 0, Port 1 (112 GB)
 - SATA SSD on Controller 0, Port 3 (112 GB)
 - Volume Size:** A section with two options:
 - Enable volume write-back cache
 - Initialize volume
- Proposed Configuration:** A diagram showing an 'Array_0000' consisting of two '112 GB' disks connected to a 'Volume_0000' with 'Type: RAID 1' and '112 GB'.

At the bottom of the wizard, there are three buttons: 'Back', 'Next' (highlighted with a red box), and 'Cancel'. A link for 'More help on this page' is located in the bottom right corner.



Review the summary provided on the confirmation screen. If you are unsure about any selections made, click the “Back” key and make your corrections. When ready, click “Create Volume” at the bottom. This typically takes between a few seconds to a couple minutes depending on the size and complexity of the volume. Once finished, you will see the message below. The array is now ready to be partitioned, formatted, and used.



Once you click the OK button on the RAID creation window you will be brought back to the main window, “Status” tab. If the option to initialize was selected, the initialization status will be shown below, circled in red.



If you select the “Manage” tab, you can see a bit more in-depth information on the array and additional options to manage or change the array.

Before the drive can be used, however, the drive must be partitioned, formatted, and assigned a drive letter. Please see Page 80 for instructions.



Repairing an array within IRST

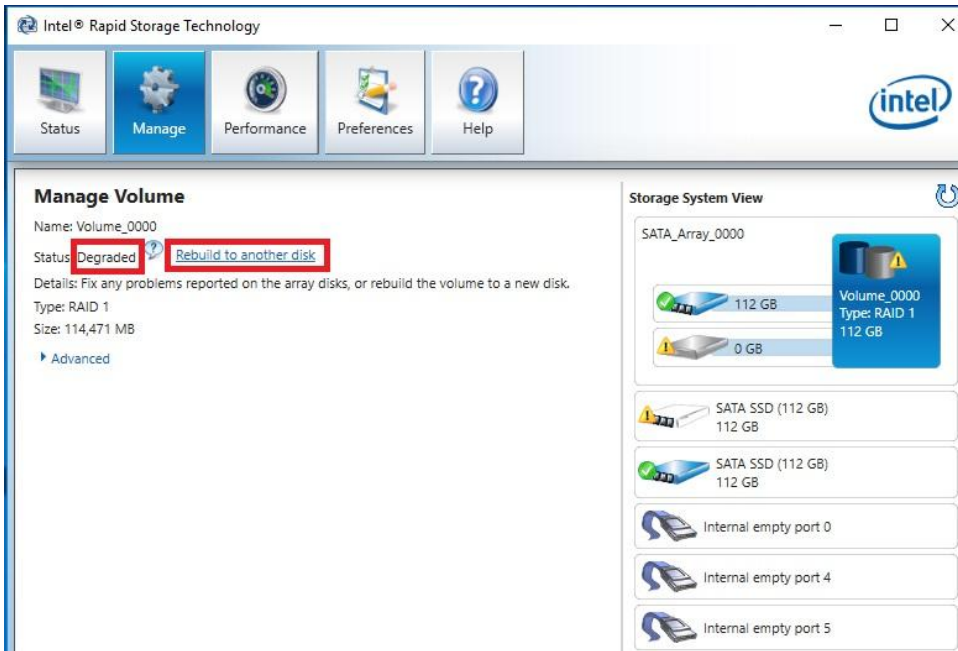
This section of the guide will illustrate how to repair a degraded array from within the IRST. For purposes of this guide, we are repairing a degraded RAID 1 array using a third drive plugged into the controller, but not currently in use.

Below, you can see a degraded array, and one of its drives reported as missing/failed. The data on the other drive is still intact, but the fault tolerance is offline due to the missing/failed drive. The IRST also shows several warnings, the "!" for "Status," a "!" for the portion of the array missing (showing the degradation of the logical drive), and the "!" for the physical drive, which also states 0GB – a further indicator of a faulty drive. You can repair the array from here or from the Manage tab at the top of IRST.

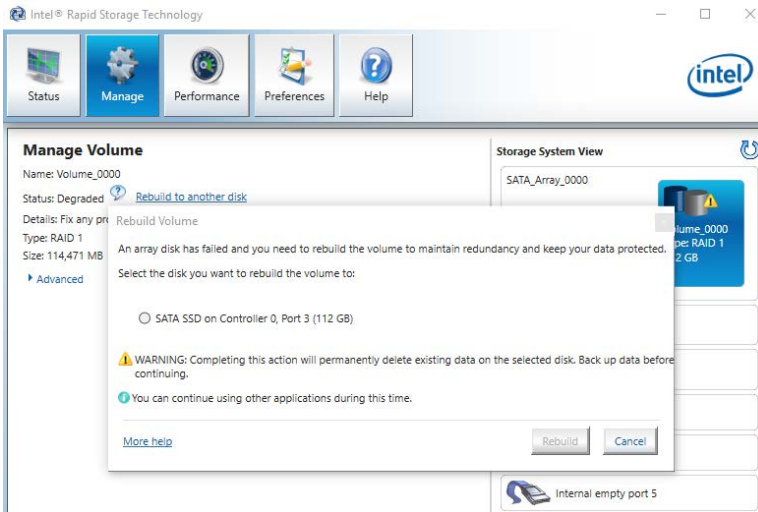
The screenshot displays the Intel Rapid Storage Technology (IRST) application window. The interface includes a navigation bar with tabs for Status, Manage, Performance, Preferences, and Help. The main content area is divided into two sections:

- Current Status:** A warning icon is present. The text states: "Your system is reporting one or more events, and data may be at risk. Refer to the details below for more information." Below this is a "Manage" section with a gear icon and a help icon. A note mentions the Windows write-cache buffer flushing policy. The primary status for "SATA_Array_0000" is "Volume_0000: Degraded" with a red box around it and a link "Rebuild to another disk". Details below indicate "Unknown disk on Controller 0, Port Unknown: Missing". At the bottom, it shows "SATA SSD on Controller 0, Port 2: Offline" with a "Clear metadata" link.
- Storage System View:** Shows the RAID configuration for "SATA_Array_0000". It includes a diagram of a RAID 1 array with two drives. One drive is highlighted with a red box and shows a warning icon and "0 GB". The other drive is highlighted with a red box and shows "112 GB". Below the diagram, a list of drives is shown: "SATA SSD (112 GB) 112 GB" (highlighted with a red box), "SATA SSD (112 GB) 112 GB", and three "Internal empty port" entries (0, 4, and 5).

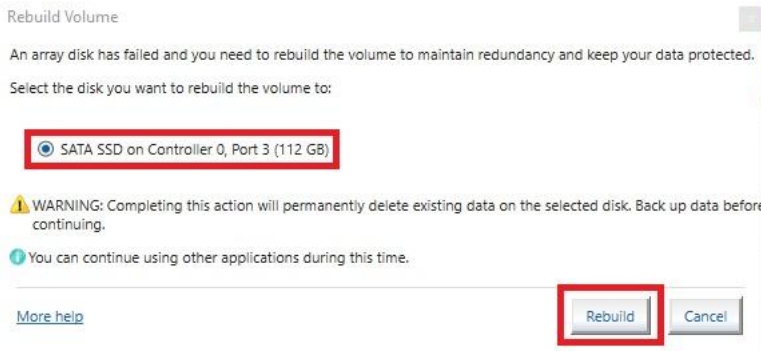
The “Manage” tab shows the array specifically, and not just the controller as a whole.

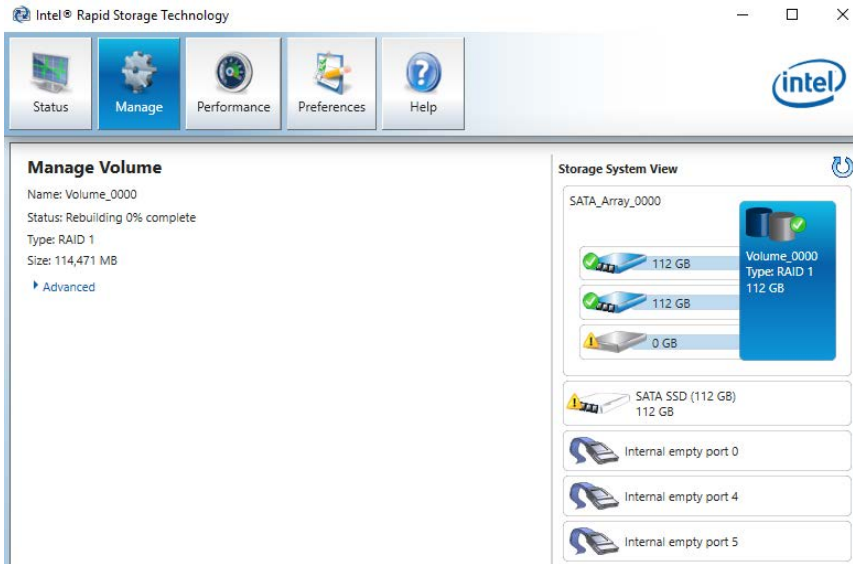


Next to “Status: Degraded,” left-click the hyperlink labeled “Rebuild to another disk.” This will bring a pop-up window over the IRST showing a list of attached drives that can be used for the repair (see pic on next page):

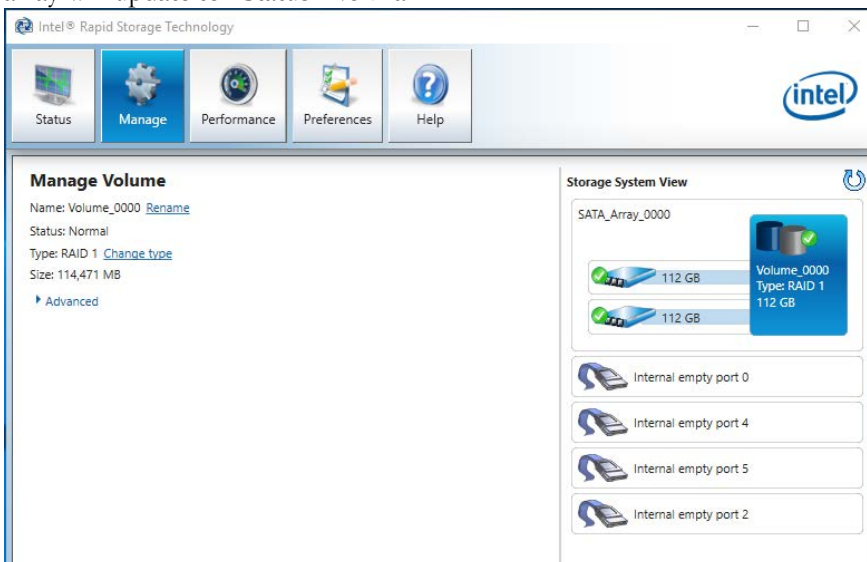


Select the drive you wish to use for the repair and click the “Rebuild” button.



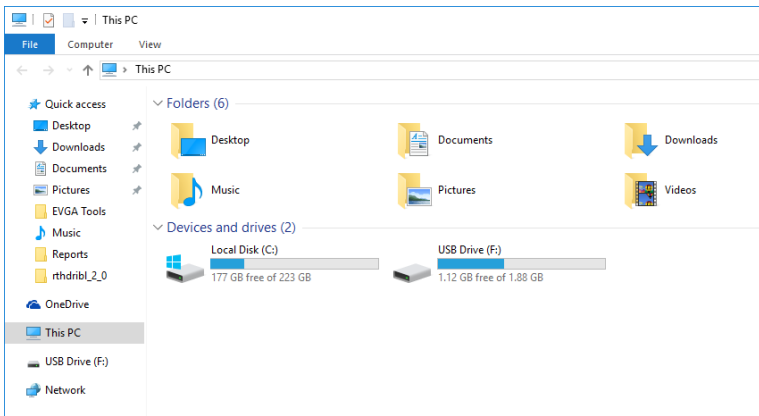


The rebuild process will begin. As with any RAID array with Fault Tolerance, the rebuilding time depends on several factors, such as array size, array type, CPU, etc. You will then see the Rebuild % status in the Manage tab. Once repairs are complete, the array will update to “Status: Normal.”



Partitioning and Formatting a drive

Once you have created your array, either from UEFI or from IRST, you will not initially see your array in “This PC.” This is expected, because even though you have created the array, you have not yet prepared the array to be used.



To begin, you’ll need to go into Disk Management.

Windows 8, 8.1, and 10: Right-click on the Windows Start button and select “Disk Management.”

Alternatively, press the Windows Key + X on your keyboard and select “Disk Management.”

Windows 7: Left-click the Start menu, right-click on “Computer” and select “Manage” from the drop-down.

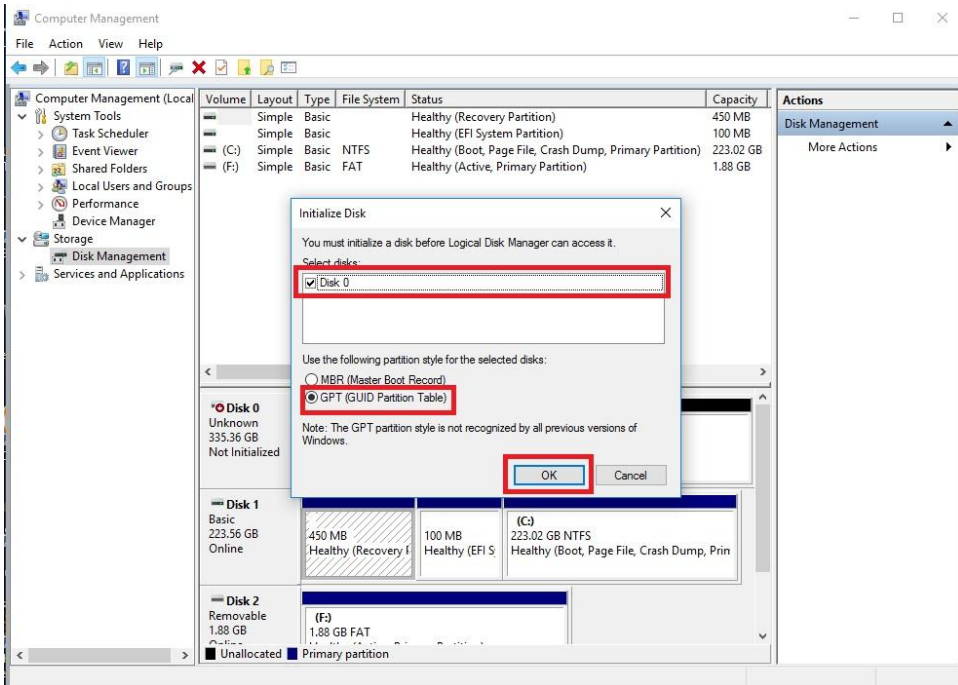
The Computer Management window will pop-up, and you’ll select Disk Management from the menu on the left, under Storage.



After “Disk Management” loads, you’ll see a pop-up to Initialize Disk if you’ve added a new drive or created a new array.

Generally, it’s recommended to select “GPT,” unless you need backwards compatibility with an old OS or PC. When you’ve made your choice, click “OK.”

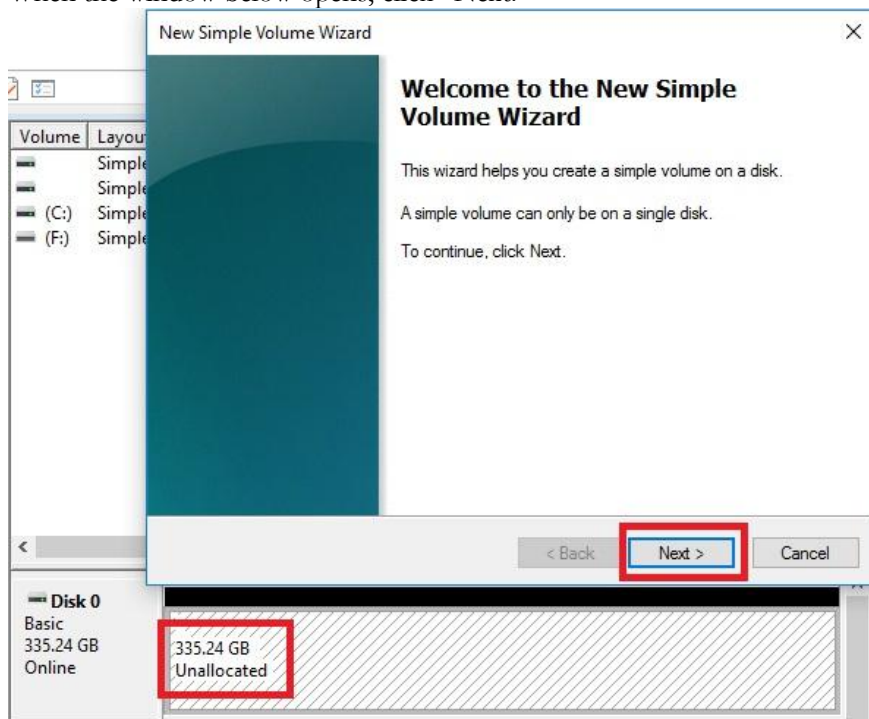
Note: If you previously initialized your array through IRST, you will skip this step and move on to the New Simple Volume Wizard in the next step.



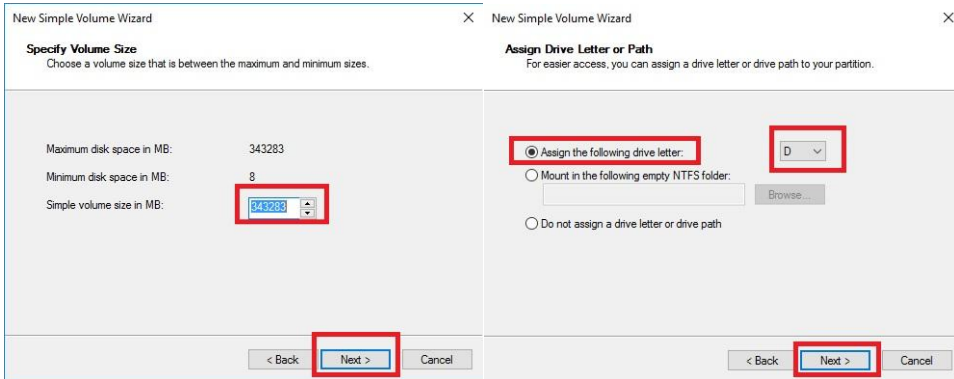
Before you can assign a drive letter to a drive or array, the initialized disk must be partitioned. If you are following this guide and just initialized your drive or array, the New Simple Volume Wizard will automatically pop-up.

If your drive or array is initialized, but not partitioned, the disk will appear in Disk Management as “Unallocated,” as shown in the image below. Right-click on the box containing “Unallocated” and select “New Simple Volume” (this text may vary slightly based on operating system). The New Simple Volume Wizard will pop-up.

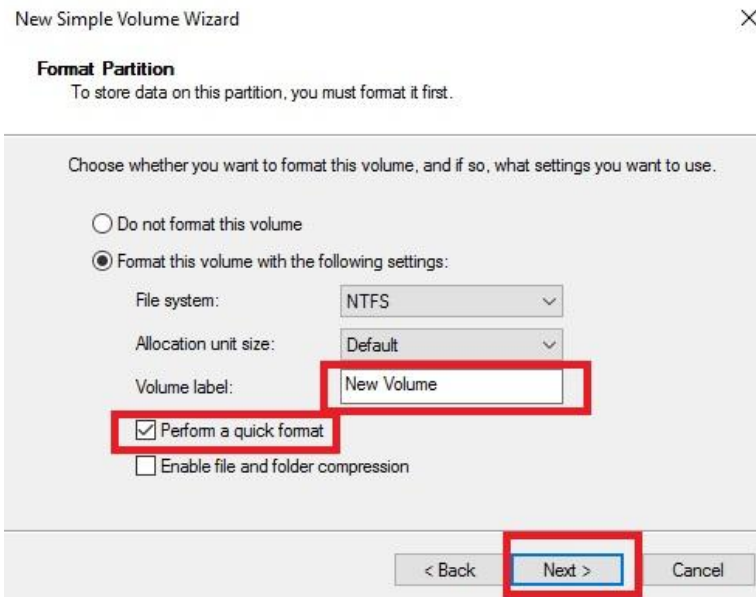
When the window below opens, click “Next.”



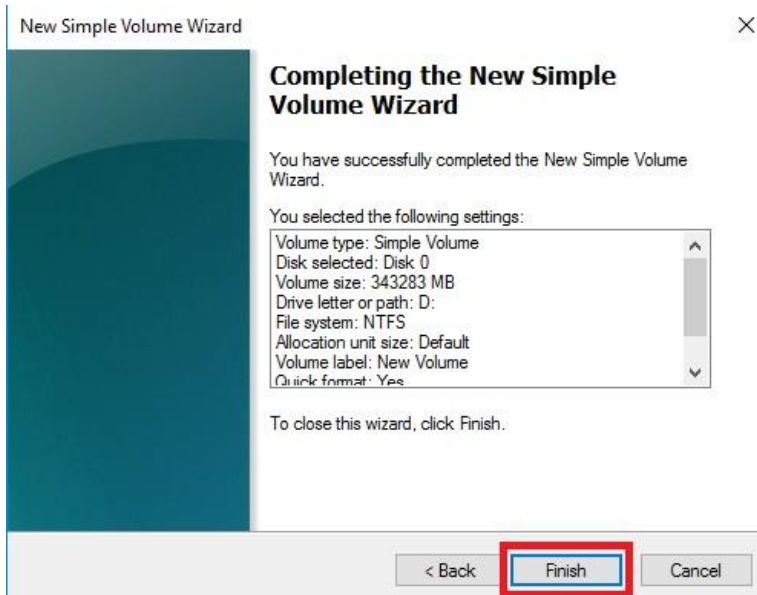
Leave the size at default to create a partition using the entire volume of disk space, then click “Next.” Select the drive letter you want to represent this drive, then click “Next.” Note: The drive letter does NOT have to be a consecutive letter with previous drive(s). Also, the wizard will not allow you to accidentally select the letter of a drive in use.



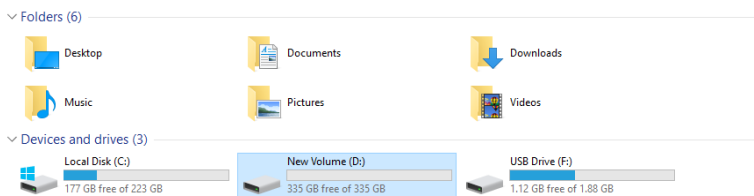
The next step is to format the partition. Select your File System; NTFS is default, and generally recommended for most large drives. Check the box for “Perform a quick Format.” You may rename the volume, or leave it at default. Click “Next” when ready.



After the quick format is completed, you will see the last Window of the wizard, a summary of the process, then click “Finish.” The drive is now usable.



To confirm, go back to File Explorer in Windows. Click on “This PC” and check the drives section. You should have a new empty drive there, with the letter you designated.



At this point the process of building an array and making it usable is completed.

Fan Header DC and PWM setup

This motherboard supports both 4-pin PWM fans and 3-pin voltage-controlled fans. All of the fans can be set to a static voltage manually. The upper two (2) fan headers (see Pages 13 and 14, component number 3) are PWM-controlled, whereas the remaining fans (see Pages 13 and 14, component number 4) are controlled by either DC (Direct Current) or PWM.



To configure the fans in BIOS/UEFI, first power on / restart the PC. During the POST sequence, press [Delete] repeatedly to get into the BIOS. Once in the BIOS, use the arrow keys or your mouse to navigate, whichever is easier, and make your way to the “Advanced” – “H/W Monitor Configuration” menu.



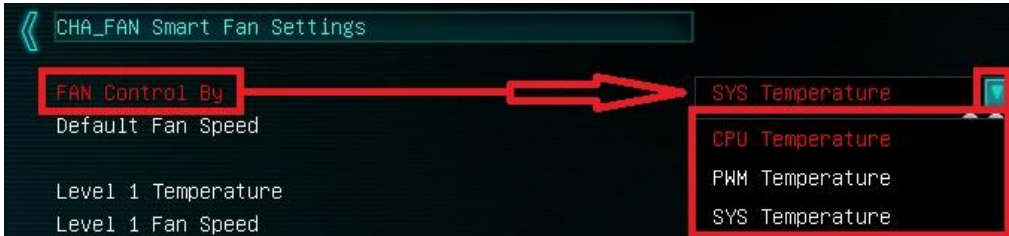
Once into the H/W Monitor section, you can see the temperature across the top. Below the monitor is the PWM fan: CPU_FAN. The PWM fan is set to “Smart,” which means the PWM controller is using a Smart curve for fan controls. The PWM fan can be set to a separate fan curve. To set a Smart curve, please see the guide starting at the top of the next page.

The +/- buttons next to Smart allow you to set your fans at a static speed percentage, instead of a curve. If you set the speed too low, however, the fan may stall; the stall speed will vary from fan to fan.

Below the fans, you will see the two (2) DC fans: SYS_FAN, and CHA_FAN. These fans can only be set to a static speed percentage. Again, if you set the speed too low, however, the fan may stall; the stall speed will vary from fan to fan.

The DC/PWM fan headers can be set to either DC Mode or PWM Mode, which can be selected by clicking on the pulldown menu. DC Mode will power the header using the static percentage set and the fan’s maximum speed. PWM Mode will power the header and communicate via PWM with a supported PWM fan. PWM mode is necessary if you are running a PWM fan powered by a different connector, such as a molex, SATA, or 3-pin header not on the motherboard. If you don’t select PWM mode in this scenario, the fan may run at 100%, or behave erratically, regardless of the static percentage you set above. If you have a PWM fan powered directly by the 4-pin header, then selecting PWM will control the fan via PWM signal NOT via reducing voltage, while it will run at a static speed based on the percentage selected, this also should reduce the low RPM stall point of the fan as it is receiving full voltage. A DC fan will run at its static percentage regardless of whether you set DC Mode or PWM Mode.

To set a Smart curve, select the “Smart Fan Settings” and enter the menu.



First, choose the temperature monitor the PWM controller will use to monitor for its temp information. It's recommended to tie the fan control to the CPU, which is predominantly the most important temperature in the system. The exception is when you are pushing memory overlocks HARD with 64GB of RAM installed, which may cause PWM temps to be a concern; in that case, tie the fan control to the PWM temp.

Once you've set the Fan Control reference point, you can set the Default fan speed. The fan speed will increase once the temperature reference point has heated up enough to hit the Level 1 Temperature. Once it hits the Level 1 Temperature the fan controls will override the Default speed setting based on the temperature at the time.



There are four tiers of temp control, with Level 4 fan speeds generally recommended to be set at Max. The example above uses a fairly aggressive fan curve, but you can set this as high or low as you wish. Make sure, however, to stay below 5-10C of the Max safe

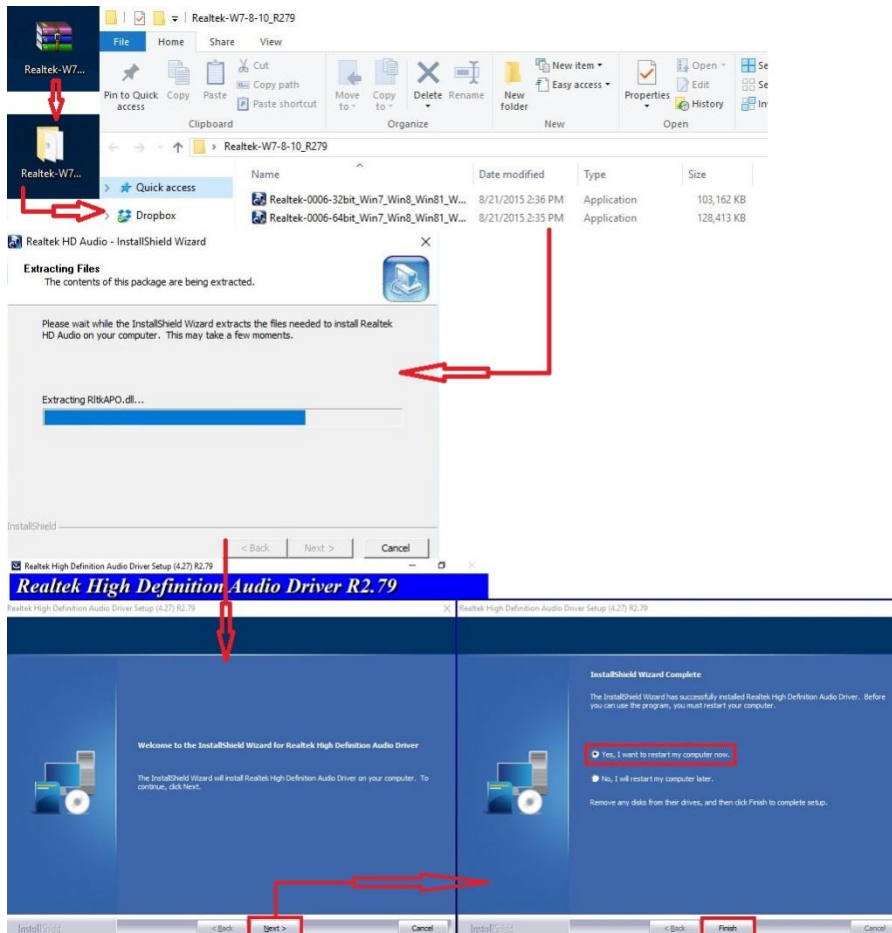
load temp for your specific processor, which can be found at Ark.Intel.com. All Smart Fan Settings have the same controls and can be setup the same way.

When monitoring temperatures vs. fan speed, you may notice a variance in ramp up/down temps; this is due to a function EVGA hardcodes into the BIOS called Hysteresis. Hysteresis builds in a buffer to control fan speed behavior. This feature prevents a constant ramp up/down from happening when your system sits exactly at the temp you set for SMART fan controls. For example, if your setting is at 30C and you hit 31C, the fan will ramp up and cool down to 29C, letting the fan slowdown, which lets the system heat back up to 31C again, repeating indefinitely and causes the system to sound like it's breathing. Hysteresis adds a 4C +/- buffer for CPU and PWM, and 2C +/- for SYS. This means that once a fan based on the CPU or PWM temp brings you down to 30C, it will not ramp back up until 34C, so you have a buffer. If you base the fan control on the SYS temp, you will only see 2C variance.

Realtek HD Audio Manager

The Z270 STINGER and Stinger both use a 7.1 Realtek ALC1150 audio controller. This section will cover installation of the controller (in Windows 10) and the basic configuration options that are available in the software.

To begin, use your installation DVD or download the current Realtek drivers from www.evga.com/support/download. Once the zip file is downloaded, right-click the file to extract it, and run the correct 32-bit or 64-bit executable for your operating system. Once launched, select “Next” on the extraction window, “Next” on the installation window, then select “Yes, I want to restart my computer now.” Click “Finish.”

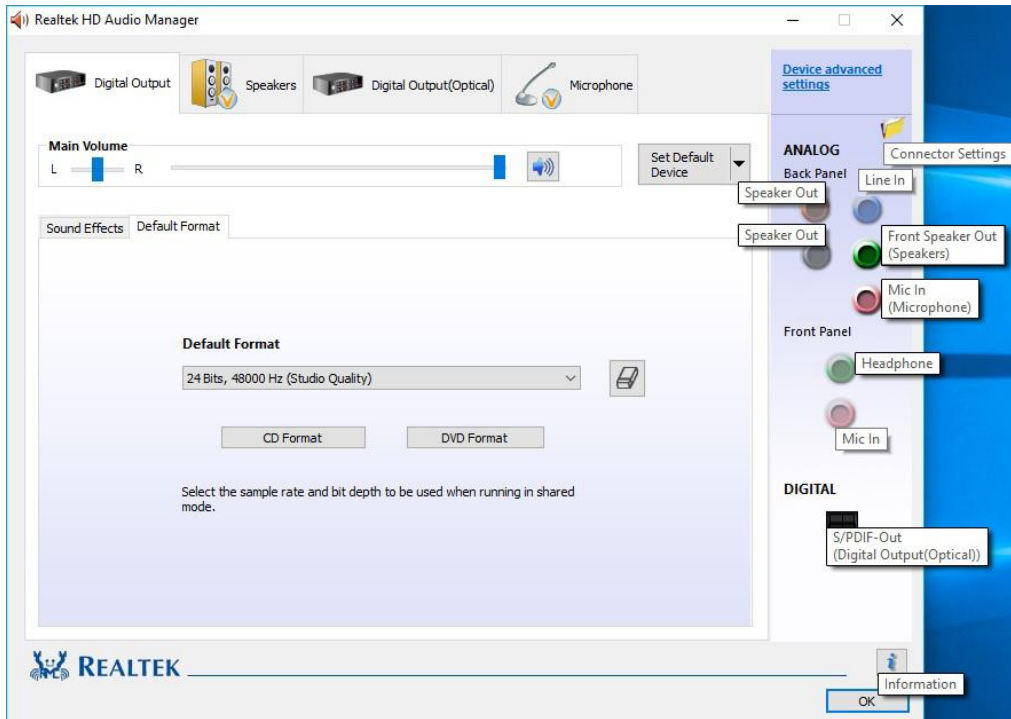


Once you have rebooted and re-entered Windows, there should be a new shortcut in the system tray with a red-orange speaker icon. When you mouse over it, the icon reads “Realtek HD Audio Manager.” When the menu opens, left-click on it, and left-click the similar red-orange speaker icon labeled “Sound Manager” to launch the Realtek software front-end.



The below images are all composites, showing the popup texts for multiple buttons/menus on screen at once to reduce the picture clutter; however, you will not see the same popups simultaneously in the Realtek HD Audio Manager.

Once the Sound Manager is open, you will be able to configure several aspects of the sound output. First on the main screen is a side-panel showing the devices physically-attached to the Realtek controller. See Page 15 for output jack legend.

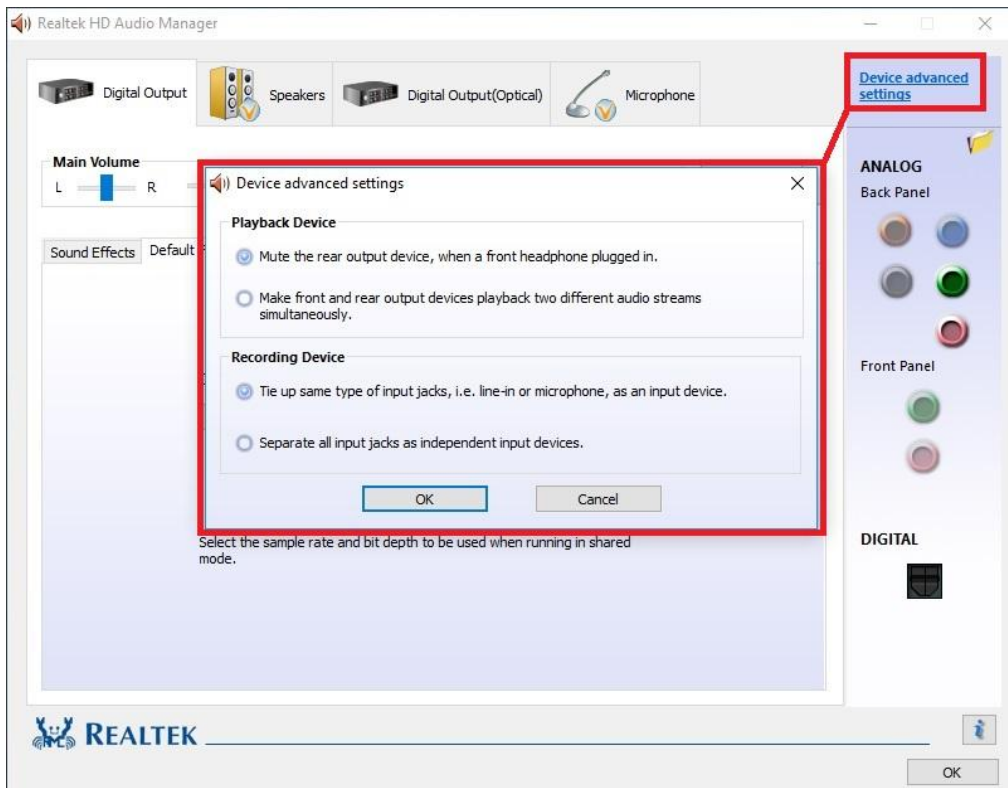


On the right margin, you can see the different ports labeled in the picture above. The top portion covers the five (5) analog ports on the I/O Hub. The two (2) labeled “Speaker Out” ports and “Line In” port all use a diffused color to show that a port is not currently connected; conversely, “Front Speaker Out (Speakers)” and “Mic In (Microphone)” use a solid color to show that the ports are currently connected. For locations and a picture of the ports please see Page 13 component number 21, and Page 15 for the I/O Hub component number 8.

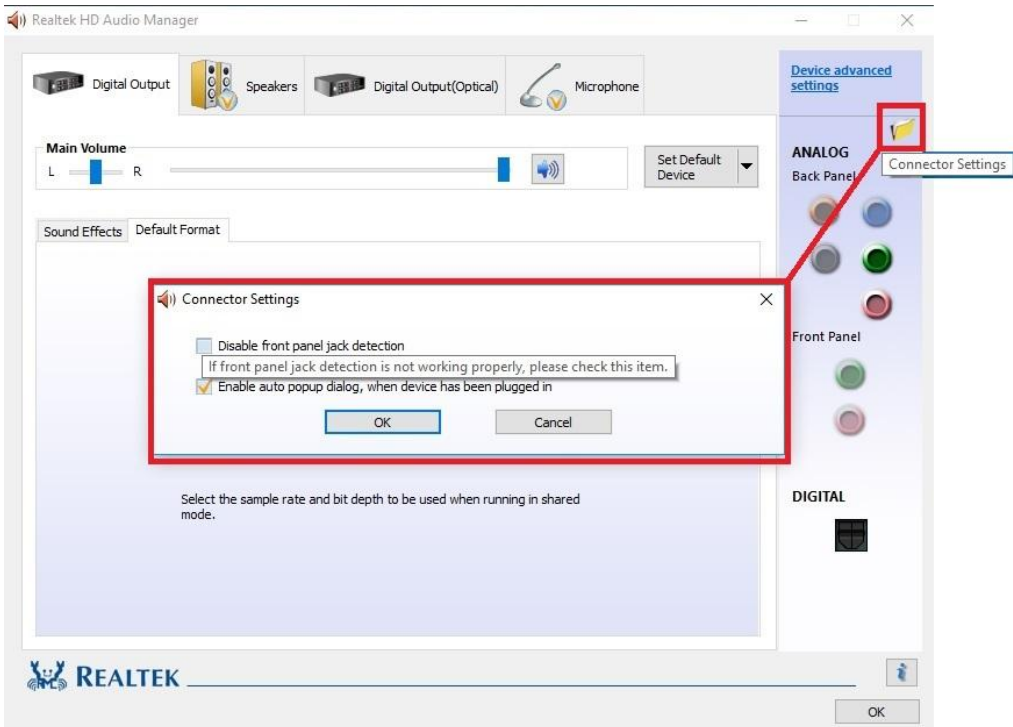
The center section of the side panel is for Front Panel Audio. Front Panel Audio ONLY supports 2.0/2.1 speakers, or headphones and a standard microphone. These are only usable if you are using a front panel connector, such as a 5 ¼ bay device with audio connectors or the front panel audio pre-attached to your chassis. The Front panel header can be found in the component legend on Page 13/14 component number 20, additional port information on Page 20, and a header pinout on Page 43.

The bottom section of the side panel is “DIGITAL.” This represents connections via optical S/PDIF, typically going to a receiver or TV. For locations and a picture of the port please see Page 13 component number 21, and Page 15 for the I/O Hub

component number 9. The optical out contains all audio data the controller can provide; however, only 2.0/2.1 is pre-encoded from the controller. Audio with a higher channel count through optical S/PDIF must be connected to a receiver that supports live encoding, or an equivalent technology.



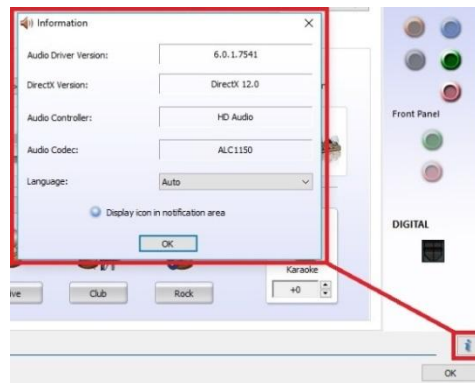
Also on the side panel is the “Device Advanced Settings” button. This will bring up a popup menu with options for playback and recording devices. Both options in Playback Device and Recording Device are mutually exclusive within their respective sections. The top options are default for both. Once you have made your selection, click “OK” at the bottom.



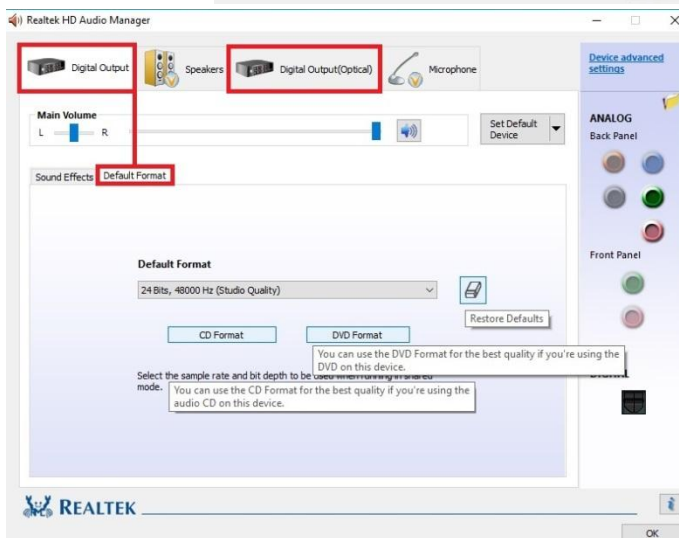
The icon of the file folder in the upper right is “Connector Settings.” This is the window for setting up port detection. The default setting in this Window allows the Manager to create a popup notification to let you know when you’ve plugged in a new device into a Realtek port(s) while Windows is running. The popup box will let you confirm which device you’ve plugged in (e.g. after plugging in a microphone cable, the popup box may incorrectly select “Line In,” which you should then change to Microphone). If you’d prefer to disable this notification, then deselect the “Enable auto popup dialog” option.

The “Disable front panel jack detection” option is mostly used for troubleshooting in cases where the Realtek Manager refuses to acknowledge speakers plugged into the rear ports, causing no sound to come out from your speakers. Should you run into that problem, checking the box for this option will often fix situations where audio will not play. If you plan on using your front panel audio connectors (e.g. the speaker/mic ports on a chassis), then do not disable the front panel jack detection. The disable box *ONLY* applies to the front panel, whereas the “Enable auto popup dialog...” covers ALL Realtek interfaces.

The “i” located at the bottom right of the Manager is an information button. Clicking on this will provide DirectX information, the CODEC and Language selection options.



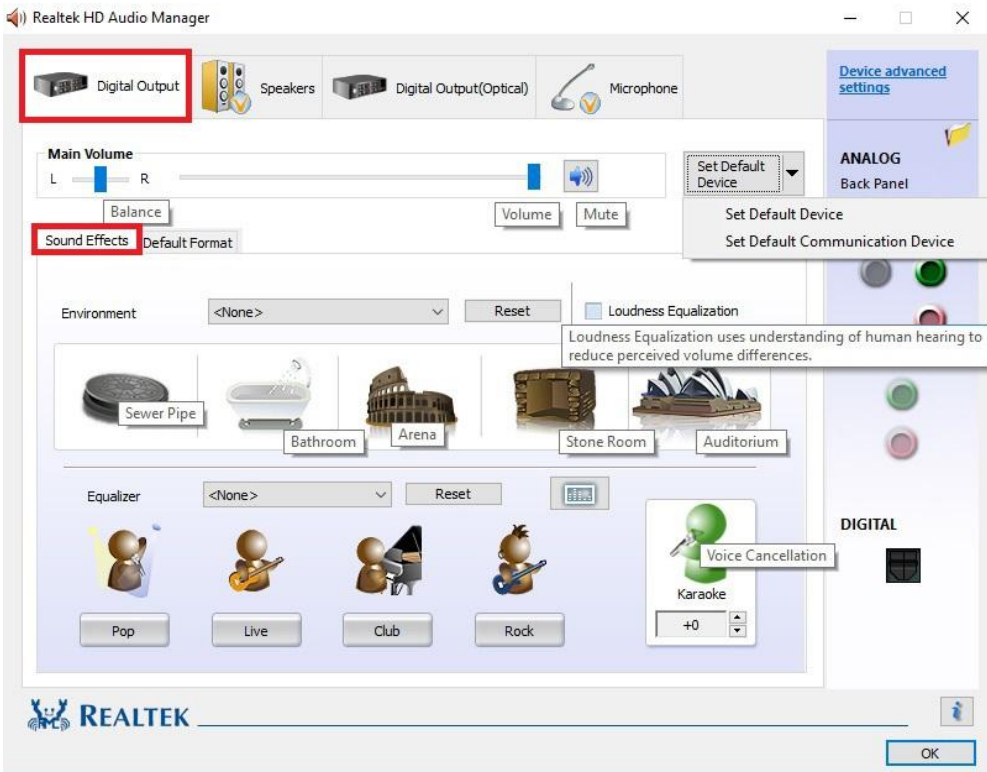
The main page defaults to the first audio device it detects; device response time to the controller can vary, so the order listed here may not be the order ALL components are detected. The Manager will generally only show devices detected by the motherboard. For purposes of this guide, speakers, a microphone, and a TOSLINK digital audio cable are connected.



As a result, the Manager detects the Digital Output first. You should also see a “Digital Output (Optical)” at the top. This shares all the same options as “Digital Output;” the difference is strictly connection type.

In the “Default Format” section, there are a couple basic selections of “CD Quality” and “DVD Quality,” which allow you to select optimized presets based on standards of how the media is recorded and written to a disk for those formats. Use the pulldown menu if you prefer to set the bit-rate and frequency yourself. All audio devices shown will have a Default Format section. Adjusting the frequency too low will heavily reduce audio quality, moving it too high can impact overall performance and cause other anomalies.

To the right of the pulldown is the Restore Defaults button, shown by an eraser icon, which will reset any changes made to the default of the controller.



If you switch over to the Sound Effects tab, you'll notice the "Main Volume" controls near the top. The slider directly under Main Volume adjusts the Balance of your speakers. It is generally recommended to leave the slider centered, since most audio is meant to run with the audio output centered; this setting is mostly to compensate for either off-center speaker configurations or individuals suffering from partial hearing loss.

To the right of Balance is "Volume;" this is the volume control for the Realtek software but also adjusts Windows main volume; this will also work similarly to a pre-amp if your speakers have a separate volume control that controls the volume after leaving the PC but before reaching the speakers. For this reason, many modern speaker systems use sequential volume controls working additively off each other.

To the right is the Mute button. This is tied-in with the Windows volume; clicking this button will Mute all audio output in Windows. Click again to restore audio.

The "Set Default Device" will allow you to set the Default Device or Communication Device without entering the Windows Playback menu; for non-default devices, this box

will drop down similar to the image above. For default devices, the box will be grayed-out if the device selected above (i.e. Speakers, Digital Output, etc.) is the default device.

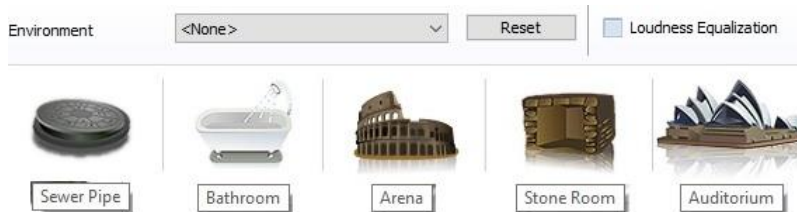
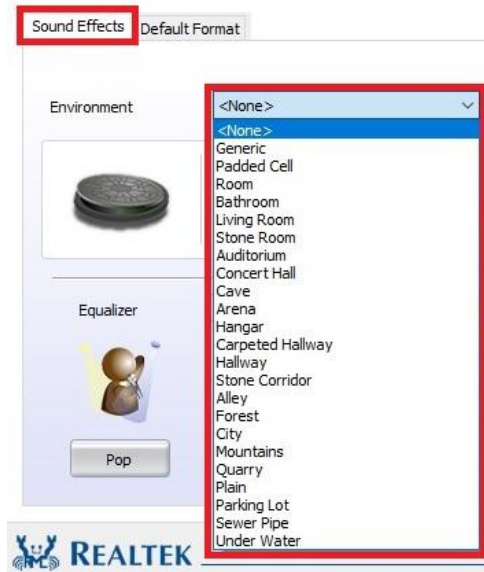
Below the Main Volume section is the “Sound Effects” and “Default Format” section. “Default Format” was previously covered on Page 94. Under “Sound Effects,” you’ll find Environment, Loudness, and Equalizer options.

Environment is defaulted to “None,” which means the sound will output how it was originally recorded.

This section allows the Realtek controller to simulate different acoustic environments before delivering it to the speakers so the sound will emulate an arena, an auditorium, or even a bathroom.

If you want a preset other than what is available on the main screen, click the pulldown box next to “Environment,” which defaults to <None> and contains a list of 24 total options.

You can revert the sound effects back to a default state anytime by clicking the "Reset" button.



To the right of the Reset button is the “Loudness Equalization” setting. This is effectively volume normalization, which is a setting designed to prevent drastic volume changes in music, movies, games, etc. from one audio source to the next, much like many TV’s utilize to prevent a sudden increase in volume when switching from one channel to the next. This is a good setting if you prefer to avoid volume going higher than you want; however, you may lose some audio quality, depending on the audio source. This is unchecked by default. There is no additional configuration; the setting is either enabled or disabled.

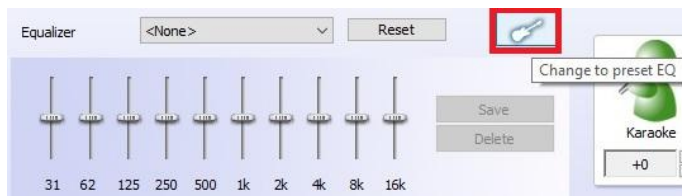
The last section in Sound Effects is the Equalizer. Much like the environment section, there are visual references for presets, a pulldown with 14 options, and a more traditional equalizer setup with a 10-band EQ as part of the software suite.

You can select any of the presets that will provide you with basic optimizations for your music preference. To see the entire list, click on the pulldown menu that reads <None> and a pulldown with all presets becomes available. Including “<None>,” there are 14 in total.

If you prefer to set your equalizer values manually, click on the equalizer icon to bring up the 10-band equalizer. This will bypass all presets and enable manual control.



From here, you can adjust the tone of the music by raising or lowering the slider on each frequency band.



You can make multiple presets of your own, which will appear in the pulldown after you have saved them. The presets each have their own benefits, but cannot take into account your audio equipment, room acoustics, or subjective audio preferences. Creating your own EQ profile allows you to further customize your audio to account for additional musical options, such as Thrash Metal, Country music, Opera, etc. to match your specific tastes.

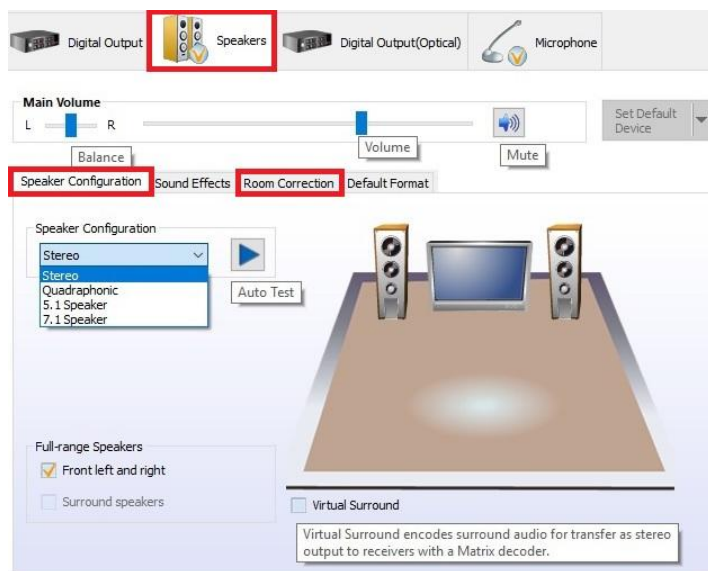
If you would prefer to not manage the EQ in full manual mode, you can click the guitar icon with the red box around it to bring you back to the equalizer presets menu.

The last section in Sound Effects is voice cancellation, also called Karaoke mode (this should not be confused with noise cancellation options in the Microphone menu). By left-clicking the icon, a red X will pop up, as shown in the image to the right. When the red X is present, the Realtek controller uses an algorithm to suppress vocal sounds from the audio source, while keeping instrumental sounds, much like a karaoke machine.



Underneath Karaoke is a menu for changing the key of the music playing. Raising the value (up to +4) will raise the pitch of the music and voice, while lowering the value (down to -4) will lower the pitch of the music and voice. This setting is designed to add a fun effect to your audio; it generally should not be used as a means to “fix” audio.

The next device section is “Speakers,” which is where you can configure all of the output options while using the analog connectors on the back.

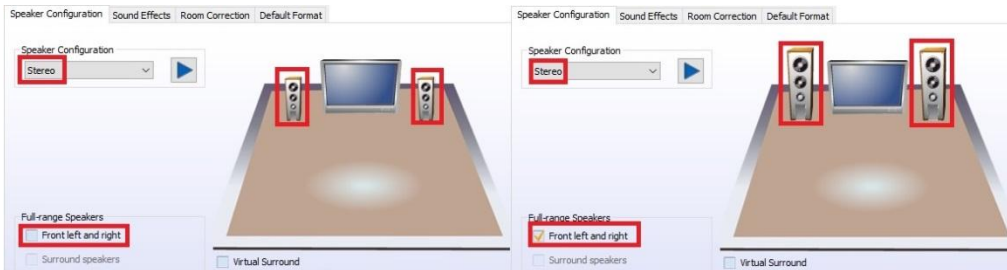
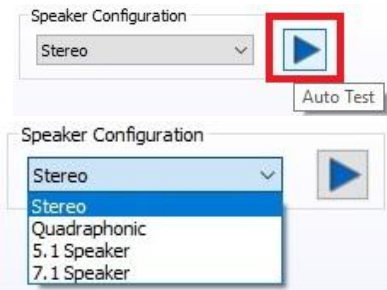


This section will focus on the “Speaker Configuration” and the “Room Correction” tabs. The other tabs, “Sound Effects” and “Default Format,” are identical in each section, and were previously covered on Pages 95 and 94, respectively.

The first option in “Speaker Configuration” is the pulldown menu for Stereo, Quadraphonic (4.0), 5.1 Speakers, and 7.1 Speakers; there is no support for 4.1 audio.

The “Audio Test” button will be present for all speaker configurations, and serves the same function in all speaker iterations.

Pressing the “Auto Test” button will play the same sound file out of each speaker that should be present, based on the configuration option you selected. As the sound test plays, an animation will highlight the speaker the sound should be coming from, this will help to ensure that the speakers are connected correctly and oriented correctly, as well.



In the lower left, there is a pair of checkboxes labeled under “Full-Range Speakers.” Full-range speakers are designed using drivers that can independently output audio across a wide frequency response of (20Hz-20,000Hz +/- 3dB) at the same volume level. When this setting is enabled, Windows will disable its software crossover settings and send the full frequency range to the speakers, whereupon the speakers will engage its own hardware crossover filters to appropriately direct audio to the individual drivers.

If your speakers are not full-range, they will not have necessary hardware components to play low frequencies, nor are they designed for that purpose. When the full-range option is unchecked, the Audio Manager will instead send the full signal out using crossover settings, available on 5.1/7.1 by selecting the Bass Management option. This sort of signal will send out the full audio frequency such that the majority of the frequency will go to the speakers, but direct the low frequencies to a subwoofer. This way, you’ll still get the same sound, but you must select the correct options.

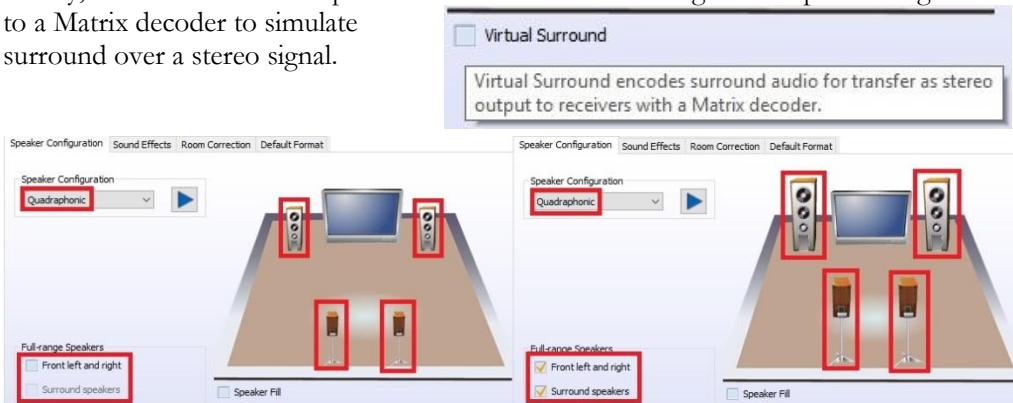
To determine if your speakers are full-range or not, you must look at the minimum frequency response of your speakers. The concern is not the high-end of the frequency response, but rather the low-end. As noted above, if your speakers are not rated for a minimum of 20Hz, then they are not full-range speakers. Here are some considerations:

- Assume your speakers are not full-range. Modern speaker design uses a subwoofer to handle the relatively small percentage of content you hear in an audio signal. Low frequency content, more commonly known as sub-bass, is greatly amplified by the subwoofer, which explains why the smallest percentage of your audio content can often be the loudest. The subwoofer allows the speakers to concentrate on the remaining 99%+ of the audible frequency bandwidth.
- Generally, if your speakers came with a subwoofer, they are not full-range speakers. As noted above, subwoofers are designed, in part, to allow speakers to stay clear of the low frequencies. When examining the specs of the speakers, make sure to look at the frequency response specifically of the speakers, and not just the specs of the speaker system. Sometimes, the most easily available specs may include the subwoofer, which can go as low as 18Hz +/-2 dB; the minimum frequency of the speakers, however, may be much higher.
- If you have a 2.0 stereo setup, look for the frequency response specs. If they do not have at least a 20Hz to 20kHz range, then they are not full-range speakers. You may try full-range, but you will lose any audio data below the minimum frequency of your speakers or may hear distortion at lower frequencies.
- Headphones tend to be full-range speakers, as they are designed to operate without a subwoofer. However, the quality of your headphones will determine whether you should configure them as full-range or not.
- If you use a receiver or your speaker system has its own controls for the type of speakers, do not use the full-range setting in the Creative panel without consulting the instructions of your receiver or speaker system, since it's possible that your receiver or speakers prefers full-range, so that the receiver or speaker system will utilize its own crossover settings once receiving the full audio range.
- Lastly, audio equipment quality will have the greatest effect on whether you should set full-range, or not. Very few speakers are properly designed for full-range audio, and if they are, then they will likely be very expensive.

Two last considerations: First, do not set Headphones to full-range if using the Headphone Surround option (may be listed as Virtual Surround), as Surround will not work properly in full-range mode. Second, do not enable full-range mode for 5.1 audio or the bass redirection will not work properly. The only exceptions to 5.1 and full-range is that you either 1) have a full or partial set of full-range speakers in your setup, or 2) you are using a receiver or speaker system that prefers to handle the low frequency crossover at the receiver or speaker system, rather than using the Audio Manager to configure the crossover settings for low frequencies.

When Full-range is enabled, the speaker icons are enlarged to represent the change.

Finally, Virtual Sound is an option created to send a stereo signal with positioning data to a Matrix decoder to simulate surround over a stereo signal.



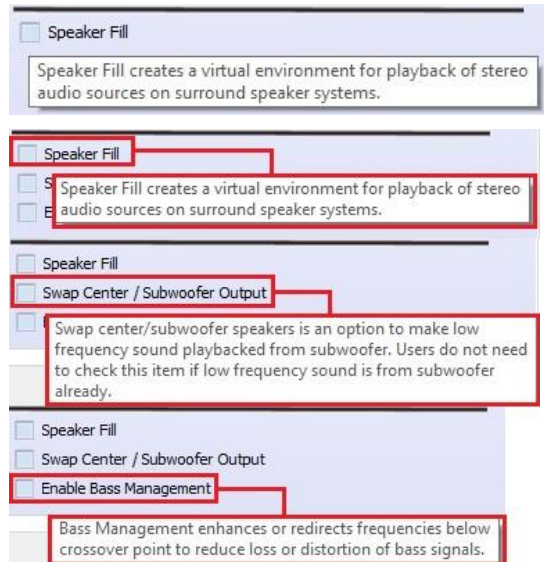
Quadraphonic and above will have similar options for Full Range: the checkboxes for “Front Left and Right” and “Surround Speakers,” which controls the satellites.

Under Quadraphonic, there is an option labeled “Speaker Fill.” This feature uses an algorithm to manipulate a stereo audio source to create a virtual surround effect using additional speakers.

5.1 and 7.1 add more options. “Speaker Fill” carries over from Quadraphonic, but also includes “Swap Center / Subwoofer Output” and “Enable Base Management.”

Speaker Fill is still a virtual surround sound emulation feature for stereo audio sources, but not a true surround.

Swap Center / Subwoofer output is an option because the Realtek controller shares the subwoofer port with the front (stereo) speakers on the rear panel audio. As the tooltip notes, if low frequencies are not playing on the subwoofer, you must enable this setting. Also, most surround speaker sets use both the front pair and subwoofer on the same channel and voice speaker on a separate channel; in some instances, this is



reversed such that the voice channel is joined with the front pair on one channel and the subwoofer has a dedicated connector, which can lead to voice channels and subwoofer receiving the wrong signal. The "Swap Center / Subwoofer Output" can resolve this type of issue. Please first confirm the subwoofer is installed correctly, however, by using the Component Legend on Page 15, and by consulting your speaker set's manual.

Enable Base Management (on the previous page) is a setting that attempts to keep audio data that may be lost or distorted near the frequency crossover point for the subwoofer and satellite speakers. On a system that does not use full-range speakers, this is a crucial setting for ensuring that your speaker system correctly plays low frequencies. The default frequency is set to 80Hz, but your system may need adjustment.

To properly set the crossover frequency, look at the specs for both your speakers and subwoofer. Some pre-assembled speaker systems may tell you what to set the crossover frequency to in your instruction manual. If not, then look for the minimum frequency response of your speakers (i.e. 75Hz, 80Hz, 175Hz, etc.), and the maximum frequency response of your subwoofer (i.e. 60Hz, 80Hz, 120Hz). Once you have that information, you can set the crossover frequency.

Ideally, you'll want to make sure that the crossover settings provide enough room to set the crossover frequency a little higher than your speakers' minimum frequency response, which will reduce distortion and provide a smoother transition to your subwoofer. A good rule of thumb is to set the crossover frequency about 20Hz higher than your minimum speaker frequency response. However, you may run into three different scenarios:

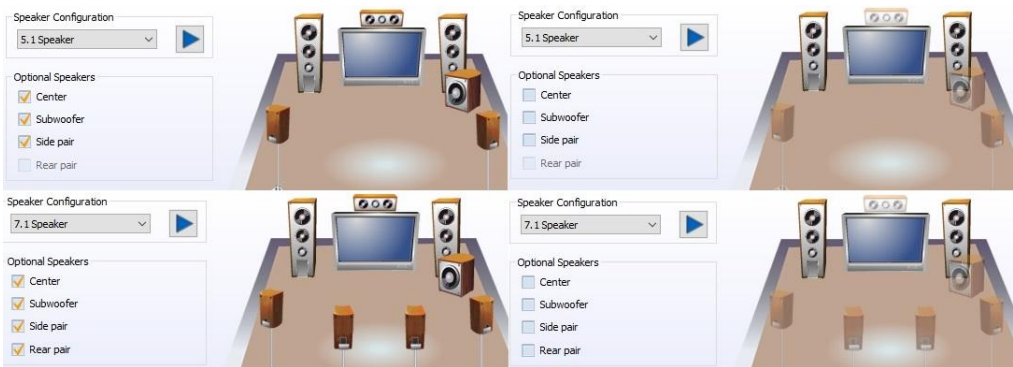
First, the frequency response of your speakers (e.g. 60Hz) and subwoofer (e.g. 100Hz) nicely overlap. This is ideal. Using the general rule above, you would set the crossover frequency to 80Hz and call it a day. You should still test the audio to ensure it is free of distortions, but this provides enough room to pass the low frequencies to the subwoofer and keep the higher frequencies to the speakers, without creating a conflict.

Second, the maximum frequency response of your subwoofers is exactly the same as the minimum frequency response of your speakers. In this case, you must set the crossover frequency exactly to where the subwoofer and speakers meet.

Third, you may have a situation where your speakers' minimum frequency response (e.g. 100Hz) is higher than your subwoofer's maximum frequency response (e.g. 80Hz). This should only happen if you purchased the subwoofer separately from the speakers. This setup cannot work properly, and you must replace either the speakers or subwoofer. Although you can adjust the setting to either the subwoofer's maximum frequency response or your speakers' minimum frequency response, you'll lose the audio data between those frequencies.

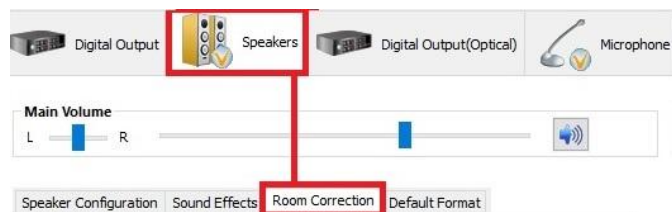
The Realtek HD Audio Manager, unfortunately, does not contain the ability to adjust the crossover frequency settings. Instead, you must adjust the crossover frequency via a registry edit in Windows. Due to the advanced nature of editing the Windows registry, we do not provide instructions in this manual. However, if you would like to adjust the crossover frequency settings, please see our FAQ on the EVGA website to walk you through how to adjust this setting: <http://www.evga.com/support/faq/?f=59663>.

The 5.1 and 7.1 configurations include the section “Optional Speakers.” This allows you to disable satellite speakers in pairs to bring any 5.1 or 7.1 system down to stereo. This is mainly used as a diagnostic tool for testing sound issues.

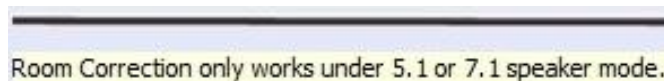


In the image above, speakers become transparent in the image when they are unchecked; this is to give you a visual reference of which speakers are enabled and disabled when testing for sound.

The last section under “Speakers” is “Room Correction.” This section allows you to virtually position the speakers using the software to ensure that the surround effects are positioned correctly based on physical distance.



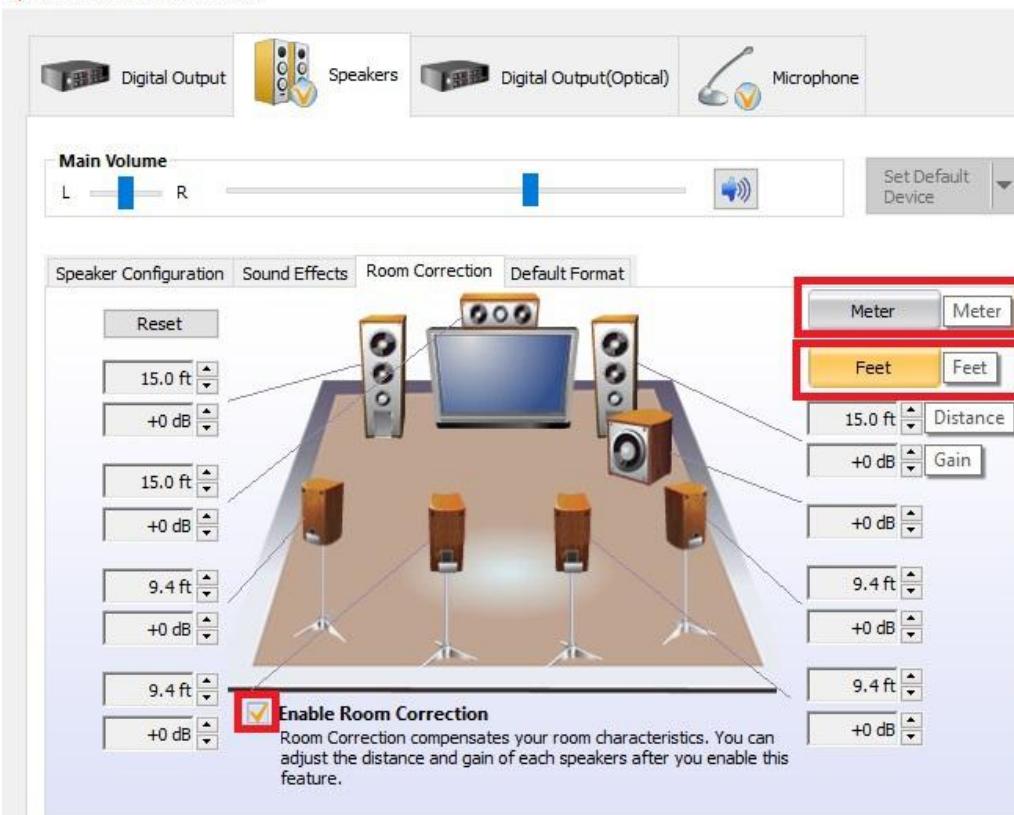
This is **ONLY** supported in 5.1 and 7.1 and you will receive the message to the right if you open the “Room Correction” tab in Quadraphonic or Stereo mode. If 5.1 or 7.1 is installed and setup in the “Speaker Configuration” page, you will see the full



Room Correction menu without an error message. All speakers will initially show semi-transparently. To edit this menu, check the box for “Enable Room Correction” at the bottom-center.

After you check the box to Enable Room Correction, you will need to select whether you want distances displayed in Feet or Meters. Once selected, the unit of measurement will be colored in light orange, and will be reflected in the measurements below for each speaker. From here, enter the measurements from the seating area to each speaker. Once the distances are entered, test the audio and adjust the gain value to your liking.

Realtek HD Audio Manager



The final Device section covers the microphone. This tab includes both a recording and a playback section.

Both features have similar balance options as the other sections, but differ slightly in the Volume slider function.

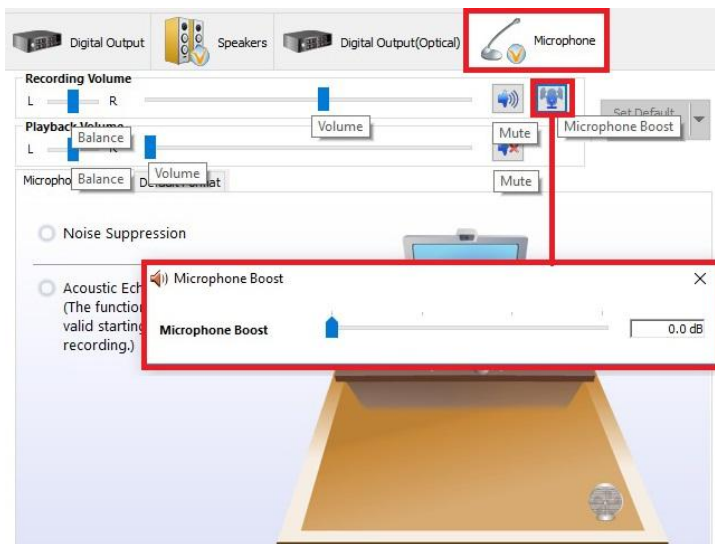
The Recording Volume slider pertains to audio recorded by your microphone.

Raising the volume allows the audio to be recorded at a higher volume; in other words, if the microphone is used to speak to another person, and the person has a hard time hearing you, raising the volume will make it easier to hear you. Conversely, if you are too loud, lowering the volume slider will produce a quieter audio. Muting this setting will mute all audio recorded by your microphone.

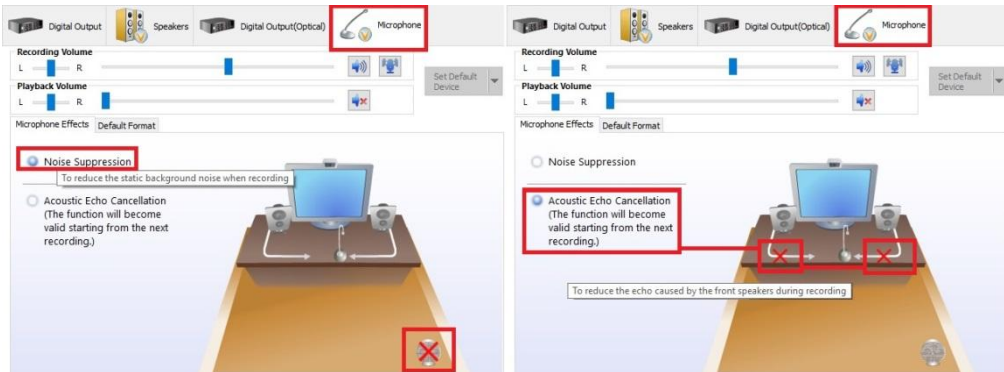
The Playback Volume pertains to a function that allows the Realtek controller to play back any audio the microphone picks up. This is a useful feature to assist with hearing your own speaking volume or audio content playing in the background. By default, this setting is muted. If you encounter an issue where you constantly hear yourself talk, and you're sure it's coming from the computer, check first to see if this setting is enabled.

The Microphone Boost button is next to the upper Mute button. The boost assists by increasing the gain of what your microphone picks up while recording. If your microphone is not consistently picking up your voice when speaking, try adjusting the boost higher in small increments, as a little boost can go a long way.

To increase the boost, click the "Microphone Boost" button. When the slider window pops up, adjust the slider bar to the right, then close the popup by clicking the "X" and retest. Whenever you test a different microphone, reset the Boost to 0, test again, and adjust as necessary. You should keep in mind, however, that some mics naturally record



louder than others, and too much gain can ruin a recording. Likewise, if you use your microphone for VOIP applications, too much boost can be painfully loud for whomever is on the other side.



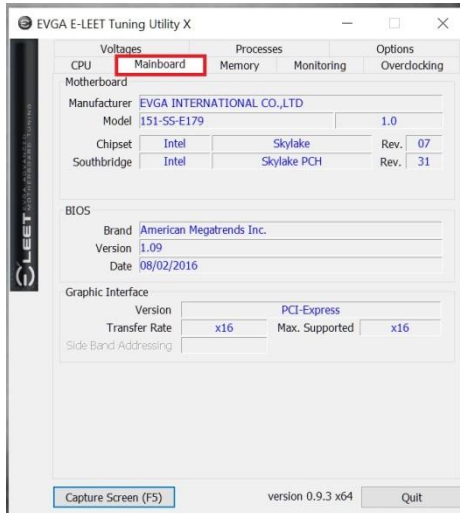
Under “Microphone Effects,” there are two options that may be enabled: “Noise Suppression” and “Acoustic Echo Cancellation.” “Noise Suppression” helps to remove background noises, such as fans, air conditioning, or anything else that causes a consistent ambient sound in the room.

When enabled, “Acoustic Echo Cancellation” removes echoes caused by room acoustics. For example, when you speak into your mic, your mic initially records your voice, but it may also pick up an echo caused by your voice bouncing off objects in your room. This creates an echo audible to whomever you’re speaking to, much like being on a phone call with someone on speaker phone and you hear your own voice coming back into your speaker. In these situations, this setting can prevent this from occurring.

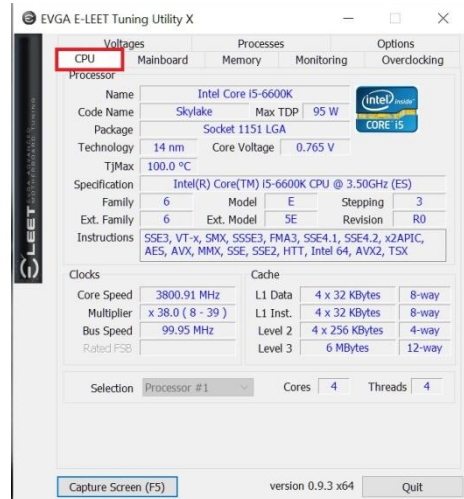
As with any speaker or microphone setting, your audio equipment will have a significant effect on audio quality and effectiveness of multiple settings. For example, some microphones already equip some degree of noise or echo cancellation and do not benefit further from Realtek’s options. Likewise, even for microphones that do not have built-in noise or echo cancellation, Realtek’s cancellation effects may create distortion or other audio problems. You will need to test your own equipment to determine the effectiveness and usefulness of the various settings outlined above in the Realtek HD Audio Manager guide.

Using the Eleet Software Suite

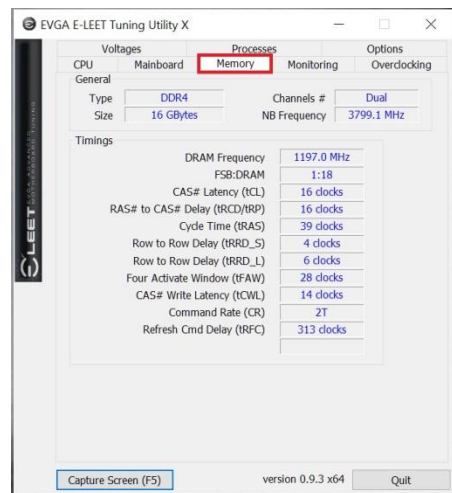
EVGA E-LEET is a monitoring and tuning software designed for EVGA motherboards, which is available on the driver DVD and the EVGA website at www.evga.com/E-LEET. After installation, E-LEET will launch directly to the CPU tab and show a general overview of CPU and motherboard information, including Socket information, CPU series, Core speed, core count, cache, etc.



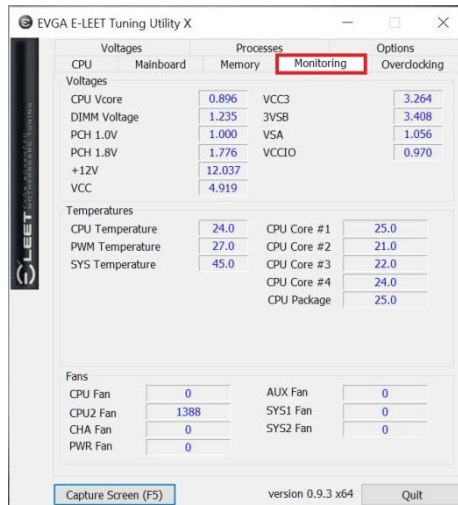
The Memory tab provides an overview of the speed and settings of your system memory. At the top, you can verify that the memory is in Dual-channel mode, the size and the NB frequency. Below, you'll find a list of timings for the RAM; not *ALL* of the timings are listed, but the most important and recognizable timings are listed on this tab. For the entire list, you will need to view/adjust those from within the BIOS.



The next tab is "Mainboard," which provides a bit more detailed information on the motherboard itself. Here, you can find the part number in the "Model" line, the CPU speed, the chipset, and even the date and revision of the BIOS.



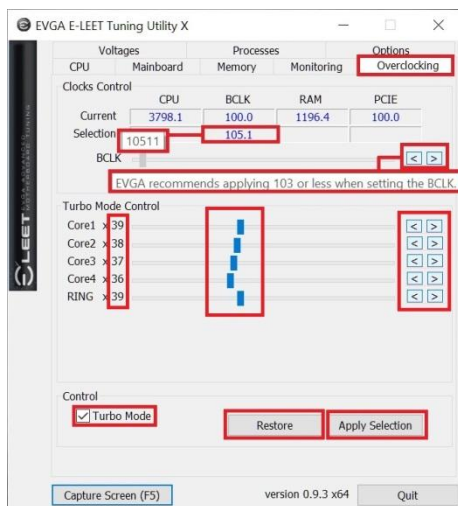
The next tab is “Monitoring,” which is an overview of temperatures and voltages in real-time. Please note that all readings on this page are pulled from motherboard sensors, and can change at any time. Temperatures and voltages are measured at fixed intervals, which can often make the readings appear to jump back and forth. Furthermore, voltages on modern motherboards are sometimes directly adaptive based on load; voltage readings *WILL* change based on usage, which is normal. Although E-LEET does offer functionality that will directly affect temperature and voltage readings, that functionality does not exist on this page. To adjust voltages within E-LEET, please see Page 110 for the Voltage tab information.



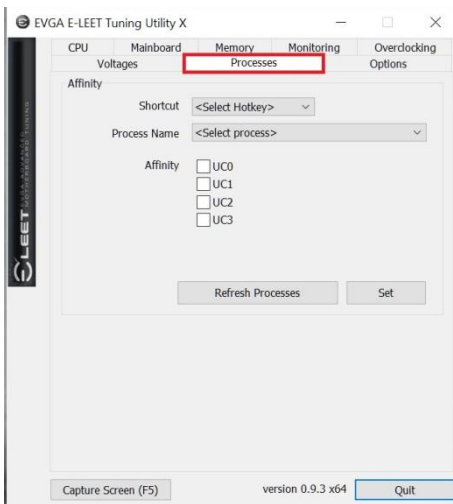
Below Voltages is Temperatures. This covers the CPU (socket), PWM, SYS, individual CPU cores, and the CPU package, which reports temperatures from the CPU Register. The bottom section is for Fans, which displays the RPM of all fans currently plugged in to the motherboard using the 3-pin or 4-pin fan header.

The next tab is “Overclocking,” which covers adjustments to the BCLK, individual Cores, and the RING.

The BCLK can be adjusted by either manually moving the slider, or clicking on the arrows to the right. The BCLK can be adjusted by hundredths of a MHz. For example, the slider will show 10511, whereas the monitor will show 105.1 (rounded). The Cores and the RING are adjusted in the same fashion, except they are adjusted by whole numbers, rather than fractions. At the bottom is a checkbox for “Turbo Mode,” which is required to adjust clock multipliers. The Restore and Apply Settings buttons are there to either revert to factory default, or make your changed settings live.



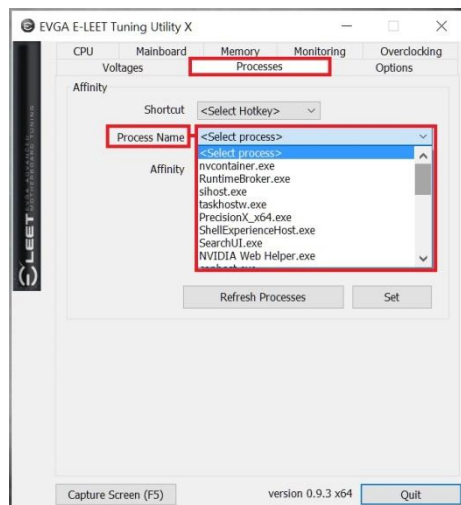
The Options tab is for managing your E-LEET profiles. You can save overclock profiles made in the previous section, as well as selecting an option to load a profile at boot. Use care, however, when setting a profile to load on startup; if the overclock is unstable, it may prevent your system from booting to the OS.



Next is the “Processes” tab, which is used to set Processor Affinity. Processor affinity is no longer used as heavily as it was in past hardware and Windows versions. However, this menu can still be used to bypass the inter-load distribution of the CPU and always set a certain CPU core or cores to run a specific process. The processes pulldown list is a

snapshot only of the processes in Task Manager when E-LEET launches. Click the “Refresh Processes” button to ensure the processes list is current before making affinity setting changes, or if the process you want is not showing.

To set affinity, click on the pulldown button next to “Process Name.” Select the Process you wish to set affinity for; the file name will appear in the context menu. Finally, select which core or cores you want to assign to this process and click “Set” at the bottom.

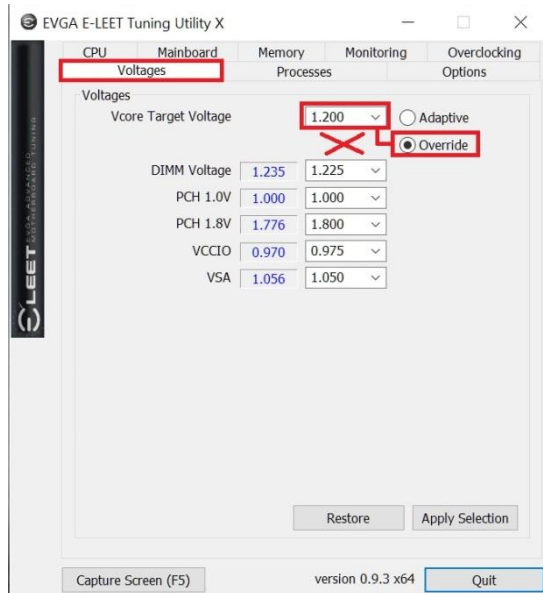
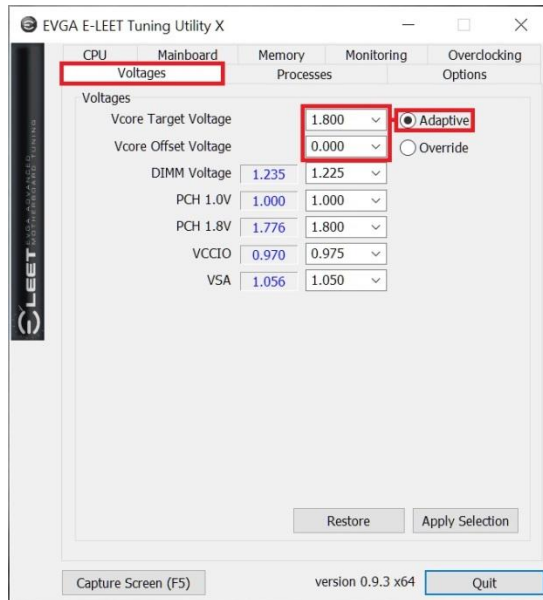


The final section is “Voltages,” which provides a level of voltage control similar to what is available in the BIOS. Using the right image, you’ll notice that there are options for multiple voltages, and two options for your CPU Vcore: Adaptive and Override voltages.

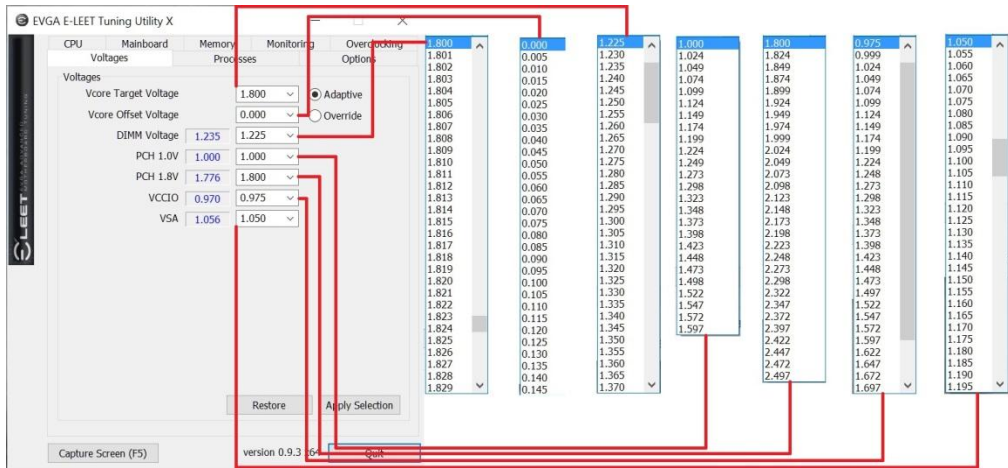
Generally speaking, Adaptive will allow you to tailor your CPU Vcore voltage profile to keep voltage usage and heat to a minimum, while Override is more of a brute-force method of setting your CPU Vcore voltage.

Adaptive gives you both Target Voltage and Offset Voltage as an option. When adjusting Adaptive, you start by setting your target voltage, which you will discover through stress-testing your CPU. The Offset voltage is then used to fine-tune additional voltage that may be required in load or stress situations.

Override just provides a static voltage; outside of extreme benching, this setting is typically not needed or ideal for the longevity of the CPU, since the VCore is meant to fluctuate based on load. Alternatively, this can be used in the early stages of overclocking to find your Target voltage, before switching back to Adaptive.



The non-CPU Vcore voltages do not utilize the Adaptive or Override voltage settings. Instead, these use a pulldown menu to select preset voltages, as shown in the image below. The voltages for these components are set by detection during POST, and E-LEET will open the pulldown to the currently detected voltage. Please be careful when adjusting voltages, as there are risks to running electronics out of spec. Although EVGA warranties overclocking, other components are manufactured by different brands (i.e. RAM and CPU), which may have different policies towards overclocking. When your changes are complete, click “Apply Selection” at the bottom, or return to defaults by clicking the “Restore” button.



Below is the voltage range list within E-LEET:

ELEET Voltage Values	Minimum Voltage	Maximum Voltage	Default Voltage
VCore Target Voltage:	0.800	1.520	1.200
VCore Offset Voltage:	-0.500	0.500	0.000
DIMM Voltage:	1.200	2.000	1.200
PCH 1.0V:	1.000	1.597	1.000
VCCIO:	0.950	1.796	0.950
VSA:	0.700	2.000	1.050

This is the E-LEET utility in its entirety; this should provide enough of an overview to utilize the E-LEET software suite.

Installing Drivers and Software

Note: It is important to remember that before installing the driver CD that is shipped in the kit, you must first load or install your operating system. The motherboard supports 32bit and 64bit versions of Windows 10, 8, and 7.

The kit comes with a CD that contains utilities, drivers, and additional software.

The CD that has been shipped with the EVGA Z270 Motherboard contains the following software and drivers:

- Chipset Drivers
- Audio Drivers
- RAID Drivers
- LAN Drivers
- USB 3.0 Drivers
- USB 3.1 Drivers
- ME Drivers
- WiFi + Bluetooth Drivers
- Serial IO Drivers
- EVGA E-LEET X
- User's Manual

Windows 10/8/7 Driver Installation

1. Insert the EVGA Z270 installation CD for the motherboard included in the kit.
2. The DVD will autorun. Install the drivers and utilities listed on the install screen. If the DVD does not run, go to My Computer and click on the DVD to open.

Warranty and Overclocking

EVGA's motherboard and graphics card components are designed for and intended for enthusiasts. To be perfectly clear, overclocking will **NOT VOID** your warranty. This means that you are free to do any type or level of overclocking you like, including traditional means, such as by using the BIOS/UEFI (for motherboards); software overclocking with EVGA utilities, such as Precision XOC or E-LEET; or even third-party software utilities. If the motherboard or card fails due to overclocking, you're covered.

Likewise, EVGA understands that enthusiasts are not always satisfied with the provided stock cooling options. Replacing heatsinks, fans, or thermal grease will **NOT VOID** your warranty. Want to install a waterblock on your new motherboard or graphics card? No problem. Planning on a long benching session with a DICE/LN2 pot? Good luck on the benching, but your warranty will still be intact after you've set new world records.

Of course, there are some limitations to our warranties. If an EVGA motherboard or graphics card sustains physical (i.e. damage to the PCB or component due to slippage with a hand tool) or liquid damage, the warranty is void. Similarly, permanent changes to components or the PCB will void your warranty, including the removal of pre-attached components soldered to the board, or the addition of components that are not removable without heat or solvents. In other words, you may use Precision XOC to raise the voltage on your graphics card while overclocking, but you may not solder on another power connector as an alternative.

If the product fails within the warranty period, you must return the product to its original configuration. This means ALL original heatsinks and fans must be reattached as they were when it was first shipped. Even if the product no longer works, it must be returned to its original state before sending it in. If you no longer have the original heatsinks you may be charged for the missing parts.

The EVGA warranty covers overclocking ONLY to EVGA products; EVGA is NOT responsible for damage caused to components manufactured by other companies. Before overclocking your system, check with the manufacturer of your other components to ensure that you will not void the warranty on those parts due to overclocking. Due to the uniqueness of every system, EVGA Customer Support cannot assist you with overclocking. For overclocking assistance, please visit our Community Forums at <http://forums.evga.com>

Troubleshooting

Replacing a BIOS chip

Replacing a BIOS chip is typically unnecessary. In most cases, this is only needed after one of the following:

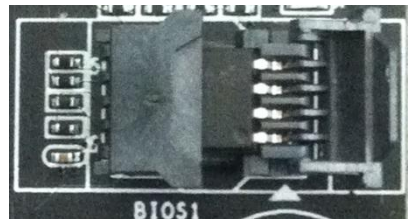
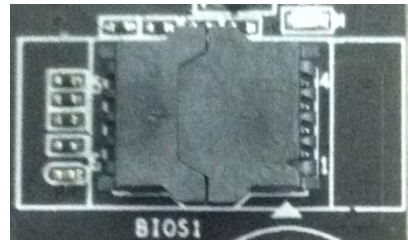
- Power failure during a BIOS update
- Failed overclock that does not recover after a hard CMOS reset
- Your motherboard was purchased just as a new line of CPUs were being released and you purchased the motherboard and one of the new CPUs at the same time (e.g. The Intel Broadwell CPUs launched approximately nine months after the Z97 motherboards launched). Chances are, if you purchased the board and CPU together in that timeframe, retail motherboards may not have the latest BIOS with compatibility added for that new CPU, and the board may need a BIOS update to be able to POST successfully.

FOR ANY AND ALL INSTANCES WHERE YOU THINK YOU MAY NEED A REPLACEMENT BIOS CHIP, PLEASE CALL CUSTOMER SERVICE IMMEDIATELY. DO NOT ATTEMPT TO REPLACE THE BIOS CHIP WITH ONE **NOT**** SUPPLIED BY EVGA, AS EVGA CANNOT OTHERWISE GUARANTEE COMPATIBILITY. CONTACT INFORMATION, HOURS, AND LOCATIONS FOR ALL EVGA CUSTOMER SUPPORT OFFICES CAN BE FOUND HERE:**

<http://www.evga.com/about/contactus/>

The steps for replacement below assume you have already contacted EVGA Customer Support and have received a pre-flashed replacement chip directly from EVGA.

1. Locate the housing for the chip on the motherboard. It should be located on the right side below the RAM, about halfway down the board. The chip will NOT be plainly visible, but under a set of gray plastic doors that keep the chip in place.
2. There is a circular mark on the bottom right that is used for alignment (Circled in RED). Please keep in mind that this chip ****IS DIRECTIONAL**** and inserting the replacement backwards will cause immediate failure of the motherboard and BIOS chip, including the potential for fire or smoke from the socket.
 - a. As a tip, the doors will only close correctly if the chip is inserted correctly. If the chip is in backwards, the door will not fully close without force, which will cause warping or damage to the door.

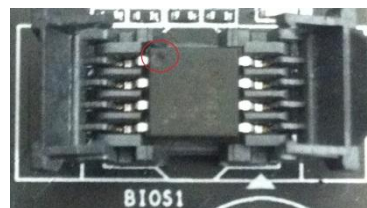


3. Remove the BIOS chip by lifting it straight up. Set it aside and insert the replacement chip. Once installed, close the left door first and the right door second, making sure both latch into place; you will feel a click when this happens. It is normal if the chip moves a little in the socket when closing the left door. Lastly, close the right door. Once both doors are closed, you've successfully replaced the BIOS chip.

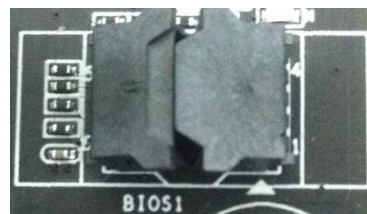


4. **NOTE: THE BELOW IMAGES ARE USED TO SHOW WHAT HAPPENS IF YOU ATTEMPT TO INSTALLED THE BIOS CHIP **INCORRECTLY**:**

- a. If the chip is in backwards, the pins will seat, but the top will overhang the socket slightly, making it impossible to seat the door properly (See picture to the right; the red-circled alignment mark is opposite of where it is supposed to be).



- b. When you push the left door, the chip will lift off the right side pins and the door will **NOT** fully close; even if you attempt to close the right door, it will not close completely. In the last picture, you can see the result of trying to close both doors with the chip installed backwards: neither will fully close. If forced, you will break the doors off.



SSD / HDD is not detected.

It is important to note that, as with *ALL* storage devices, if there is a connectivity issue, make sure it is enabled in BIOS. Likewise, if there is a device that shares bandwidth with your SSD or HDD (Page 22), make sure that the desired device is enabled in BIOS, or all other troubleshooting that comes after this section is moot.

If you've physically installed a drive that is not detected in Windows, by Windows setup, or within BIOS, please take the following steps. Component troubleshooting is primarily accomplished through process of elimination testing to deduce a faulty component or a bad connection.

Device is not receiving power:

For devices with external power; such as SATA, U.2, and SATA Express; make sure power is connected to the drive, and that the other side of the cable is attached to the correct port on your PSU. If you are using a mechanical drive (either a platter HDD or an optical drive) you should hear the motor spin up when you first power on the system. Similarly, if you put your hand on the device you should feel the drive spin up, warmth from the motor, and a light on the front from an optical drive. If you see, hear, and feel this, then the device is receiving power, and you may skip to the next section. If you do not see, hear, or feel this, first try the cable on a device that you know works; if the cable works, then the issue is the device in question.

However, if you replace the device and the issue persists, then it is either the PSU, one of its modular cables or the port the cable is plugged into. If you are using a modular cable, try a different cable in the same PSU port, and also test on a different port to isolate the source of the problem. In many cases, the PSU manufacturer may be able to replace the cable if it is bad.

Device has power, but does not show up in the BIOS:

If the device is getting power, then we should expect to see the drive in BIOS, unless you are using a third party controller, such as Marvel; for devices on third-party controllers, go to Page 80. If the drive does not show in the SATA Configuration screen in BIOS, make sure the SATA cable is firmly seated on both the drive side and the motherboard. As noted above, if you are using a device on a connector that shares its bandwidth, you will need to check and/or change the BIOS setting related to your device.

If you've already done this, test a different device using the same cable and SATA port to see if the issue persists. If the issue is not resolved, test a different SATA cable, or a different SATA port. Always be sure to test each step separately, otherwise, if several aspects are changed and drives are now detected, then you will not know what change actually fixed it. If other devices work on the ports and with the same cables, then the issue is the device in question. If testing shows that either one or more of the ports are bad with a different device, then the motherboard is likely the issue. If one or more of the cables test bad with a different device, then replacing the cable(s) should resolve the issue. These same steps can be used for SATA Express; you can only try a different cable or device with U.2, because there is only one U.2 port.

M.2 devices have a bit less to test due to their connection that provides data and power through a single socket. M.2 devices are installed at an angle, gently pushed down flush with the motherboard, then screwed into place. M.2 drives only fit one way, and cannot fit upside-down; however, you can have a bad connection if the card is not pushed all the way into the slot before bolting it down. Please refer to Page 29 for M.2 hardware installation, and Page 48 for setup.

Device has power, is seen in BIOS, but cannot be found in Windows:

Lastly, if the device was just added, other troubleshooting in this section has been done, the device has power and shows up in the BIOS, but is not seen in Windows, then it may be that the drive needs to be initialized, partitioned, and formatted in Windows. See Page 80 for instructions.

Have a question not covered above, or want some online resources?

If you have any issues or questions, you can find a lot of valuable help and information on our website, including contact information for our US Technical Support/Customer Service.

- You may find all of the motherboard drivers at <http://www.evga.com/support/download/>. Select the “Motherboard” tab, then select “Intel Z270” from the Family tab, then “111-KS-E272” from the part number pulldown. Next, select either “All” or the specific component that requires a driver, then select your operating system and click “Submit”
- You may find the list of officially supported CPUs and System RAM for your motherboard, including the minimum required BIOS revision for compatibility, at: <http://www.evga.com/support/motherboard/>. BIOS updates are cumulative, so they will always support products from the previous version, except when specified otherwise.
- For our Frequently Asked Questions (FAQ) database, go to: <http://www.evga.com/support/knowledgebase/>
- To visit our Community Forums, go to: <http://forums.evga.com/>
For our Community Forums section dedicated to EVGA motherboards, go to: <http://forums.evga.com/EVGA-Motherboards-f3.aspx>
- Just finished building or upgrading your system and want to show it off? Make a ModsRigs Profile here: <http://www.modsrigs.com/> and create a page dedicated entirely to YOUR system!
- Still building your rig? Make a build log here: <http://forums.evga.com/EVGA-MODS-RIGS-f33.aspx>
- Want to join the online EVGA Gaming Community? Sign up and play with like-minded gamers here: <http://www.evga.com/TEAMEVGA/>

EVGA Glossary of Terms

AC – Alternating Current

ACPI - Advanced Configuration and Power Interface

AHCI – Advanced Host Controller Interface

AFR – Alternate Frame Rendering

APIC - Advanced Programmable Interrupt Controller

BCLK – Base Clock (or operating frequency of base system bus)

BIOS - Basic Input Output System

CMOS - Complementary Metal-Oxide Semiconductor

CPU – Central Processing Unit

DC – Direct Current

DDR - Double Data Rate

DIMM - Dual In-line Memory Module

DMI – Direct Memory Interface

DP – Display Port

DRAM - Dynamic random access memory

DVI – Digital Video Interface

ELEET/ELEET X – EVGA motherboard monitoring and tuning software

FIVR – Fully Integrated Voltage Regulator

GHz – Gigahertz

GPIO (Thunderbolt) – General Purpose Input/Output

GPU – Graphics Processing Unit

GUI – Graphical User Interface

HDD - Hard Disk Drive

HDMI - High-Definition Multimedia Interface

HDR – High Dynamic Range Lighting

HPET - High Precision Event Timer

HT – Hyper-Threading

HSF - Heat Sink Fan
I/O - Input/Output
IEEE - Institute of Electrical and Electronics Engineers
IGP - Integrated Graphics Processors
IMC – Integrated memory controller
IOH – Input/Output Hub
IRQ - Interrupt Request
JBOD - Just a Bunch of Disks
JEDEC - Joint Electron Device Engineering Council
LAN - Local Area Network
LCD - Liquid Crystal Display
LGA – Land Grid Array
LN2 – Liquid Nitrogen Cooling
MAC - Media Access Control
MCP - Media and Communications Processor
Intel ME – Intel Management Engine
MHz – Megahertz
MMIO – Memory Mapped I/O
NB - Northbridge
NCQ - Native Command Queuing
NIC - Network Interface Card
NTFS - New Technology File System
NVMe – Non-Volatile Memory Express
OEM - Original Equipment Manufacturer
PATA - Parallel Advanced Technology Attachment
PCB - Printed Circuit Board
PCH – Platform Controller Hub
PCI - Peripheral Component Interconnect
PCI-E - Peripheral Component Interconnect Express

PLL – Phase Locked Loop

POST – Power on Self-Test

PWM – Pulse Width Modulation

QDR - Quad Data Rate

QOS – Quality of Service

QPI – Quick Path Interconnect

RAID - Redundant Array of Inexpensive Disks

RAM – Random Access Memory

ROM – Read Only Memory

RGB - Red Green Blue

SATA - Serial Advanced Technology Attachment

SAS – Serial Attached SCSI

SB - Southbridge

SCSI - Small Computer System Interface

SFR – Split Frame Rendering

SLI - Scalable Link Interface

SPD - Serial Presence Detect

S/PDIF - Sony/Philips Digital Interconnect Format

SPP - System Platform Processors

SSD – Solid State Drive

TCP/IP - Transmission Control Protocol/Internet Protocol

Thunderbolt – High-speed hot-swappable interface (similar function to USB)

U.2 – High-Speed storage interface also referred to as SFF-8639

UDP – User Datagram Protocol

UEFI – Unified Extensible Firmware Interface

USB - Universal Serial Bus

VDroop - Voltage Droop

VGA - Video Graphics Array

VREG – Voltage Regulator

Compliance Information

FCC Compliance Information

This device complies with FCC Rules Part 15. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation. This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the manufacturer's instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures: (1) Increase the separation between the equipment and signal source, or (2) connect the equipment to an outlet on a circuit different from that to which the signal source is connected. Consult the dealer or an experienced computer technician for help. The use of shielded cables for connection of peripheral devices to the PC systems is required to ensure compliance with FCC regulations. Changes or modifications to this unit not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

CE Compliance Information

Generic Radiation Interference Standard for Information Technology Equipment. (EN 55022: 2006, Class B), (EN 61000-3-2: 2006), (EN 61000-3-3: 1995 + A1: 2001 + A2: 2005). Warning: This is a Class B product. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measure. Generic Immunity Standard for Information Technology Equipment. (EN 55024: 1998 + A1: 2001 + A2: 2003).

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